

LPC2930 ARM9 flashless microcontroller with CAN, LIN, and USB Rev. 03 — 16 April 2010 Product data sheet

1. General description

The LPC2930 combine an ARM968E-S CPU core with two integrated TCM blocks operating at frequencies of up to 125 MHz, Full-speed USB 2.0 Host/OTG/Device controller, CAN and LIN, 56 kB SRAM, external memory interface, three 10-bit ADCs, and multiple serial and parallel interfaces in a single chip targeted at consumer, industrial, and communication markets. To optimize system power consumption, the LPC2930 has a very flexible Clock Generation Unit (CGU) that provides dynamic clock gating and scaling.

2. Features and benefits

- ARM968E-S processor running at frequencies of up to 125 MHz maximum.
- Multilayer AHB system bus at 125 MHz with four separate layers.
- On-chip memory:
 - Two Tightly Coupled Memories (TCM), 32 kB Instruction TCM (ITCM), 32 kB Data TCM (DTCM).
 - Two separate internal Static RAM (SRAM) instances; 32 kB SRAM and 16 kB SRAM.
 - ◆ 8 kB ETB SRAM, also usable for code execution and data.
- Dual-master, eight-channel GPDMA controller on the AHB multilayer matrix which can be used with the SPI interfaces and the UARTs, as well as for memory-to-memory transfers including the TCM memories.
- External Static Memory Controller (SMC) with eight memory banks; up to 32-bit data bus; up to 24-bit address bus.
- Serial interfaces:
 - USB 2.0 full-speed Host/OTG/Device controller with dedicated DMA controller and on-chip device PHY.
 - Two-channel CAN controller supporting FullCAN and extensive message filtering
 - Two LIN master controllers with full hardware support for LIN communication. The LIN interface can be configured as UART to provide two additional UART interfaces.
 - Two 550 UARTs with 16-byte Tx and Rx FIFO depths, DMA support, modem control, and RS-485/EIA-485 (9-bit) support.
 - Three full-duplex Q-SPIs with four slave-select lines; 16 bits wide; 8 locations deep; Tx FIFO and Rx FIFO.
 - Two I²C-bus interfaces.



- Other peripherals:
 - One 10-bit ADC with 5.0 V measurement range and eight input channels with conversion times as low as 2.44 μs per channel.
 - Two 10-bit ADCs, 8-channels each, with 3.3 V measurement range provide an additional 16 analog inputs with conversion times as low as 2.44 µs per channel. Each channel provides a compare function to minimize interrupts.
 - Multiple trigger-start option for all ADCs: timer, PWM, other ADC, and external signal input.
 - Four 32-bit timers each containing four capture-and-compare registers linked to I/Os.
 - Four six-channel PWMs (Pulse-Width Modulators) with capture and trap functionality.
 - Two dedicated 32-bit timers to schedule and synchronize PWM and ADC.
 - Quadrature encoder interface that can monitor one external quadrature encoder.
 - ◆ 32-bit watchdog with timer change protection, running on safe clock.
- Up to 152 general-purpose I/O pins with programmable pull-up, pull-down, or bus keeper.
- Vectored Interrupt Controller (VIC) with 16 priority levels.
- Up to 22 level-sensitive external interrupt pins, including USB, CAN and LIN wake-up features.
- Processor wake-up from power-down via external interrupt pins, CAN, or LIN activity.
- Configurable clock-out pin for driving external system clocks.
- Flexible Reset Generator Unit (RGU) able to control resets of individual modules.
- Flexible Clock-Generation Unit (CGU) able to control clock frequency of individual modules:
 - On-chip very low-power ring oscillator; fixed frequency of 0.4 MHz; always on to provide a Safe_Clock source for system monitoring.
 - On-chip crystal oscillator with a recommended operating range from 10 MHz to 25 MHz. PLL input range 10 MHz to 25 MHz.
 - On-chip PLL allows CPU operation up to a maximum CPU rate of 125 MHz.
 - Generation of up to 11 base clocks.
 - Seven fractional dividers.
- Second, dedicated CGU with its own PLL generates USB clocks and a configurable clock output.
- Highly configurable system Power Management Unit (PMU):
 - clock control of individual modules.
 - allows minimization of system operating power consumption in any configuration.
- Standard ARM test and debug interface with real-time in-circuit emulator.
- Boundary-scan test supported.
- ETM/ETB debug functions with 8 kB of dedicated SRAM also accessible for application code and data storage.
- Dual power supply:
 - CPU operating voltage: 1.8 V \pm 5 %.
 - I/O operating voltage: 2.7 V to 3.6 V; inputs tolerant up to 5.5 V.
- 208-pin LQFP package.
- -40 °C to +85 °C ambient operating temperature range.

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3. Ordering information

Table 1. Ordering i	nformation		
Type number	Package		
	Name	Description	Version
LPC2930FBD208	LQFP208	plastic low profile quad flat package; 208 leads; body 28 \times 28 \times 1.4 mm	SOT459-1

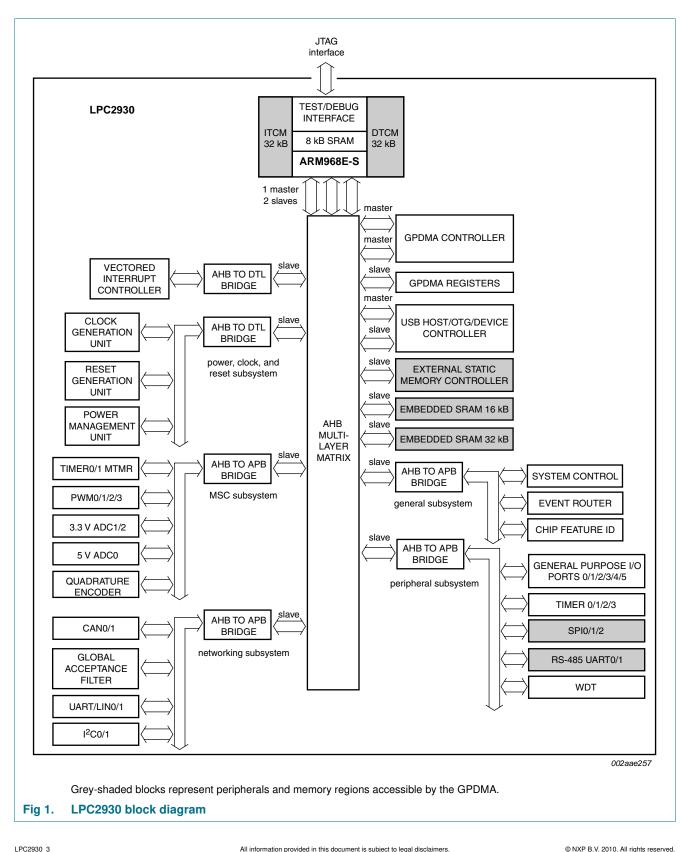
3.1 Ordering options

Table 2. Part options

Type number	Flash memory	SRAM	SMC	USB Host/ OTG/ Device	UART RS-485/ modem	LIN 2.0/ UART	CAN	Package
LPC2930FBD208	-	56 kB + 2 × 32 kB TCM	32-bit	yes	2	2	2	LQFP208

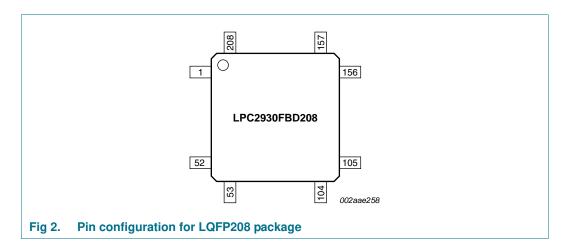
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Block diagram 4.



5. Pinning information

5.1 Pinning



5.2 Pin description

5.2.1 General description

The LPC2930 uses five ports: port 0 and port 1 with 32 pins, ports 2 with 28 pins each, port 3 with 16 pins, port 4 with 24 pins, and port 5 with 20 pins. The pin to which each function is assigned is controlled by the SFSP registers in the SCU. The functions combined on each port pin are shown in the pin description tables in this section.

5.2.2 LQFP208 pin assignment

Pin name	Pin	Description			
		Function 0 (default)	Function 1	Function 2	Function 3
TDO	1 <u>[1]</u>	IEEE 1149.1 test of	lata out		
P2[21]/SDI2/ PCAP2[1]/D19	2 <u>[1]</u>	GPIO 2, pin 21	SPI2 SDI	PWM2 CAP1	EXTBUS D19
P0[24]/TXD1/ TXDC1/SCS2[0]	3 <mark>[1]</mark>	GPIO 0, pin 24	UART1 TXD	CAN1 TXD	SPI2 SCS0
P0[25]/RXD1/ RXDC1/SDO2	4 <mark>[1]</mark>	GPIO 0, pin 25	UART1 RXD	CAN1 RXD	SPI2 SDO
P0[26]/TXD1/SDI2	5 <mark>[1]</mark>	GPIO 0, pin 26	-	UART1 TXD	SPI2 SDI
P0[27]/RXD1/SCK2	6 <mark>[1]</mark>	GPIO 0, pin 27	-	UART1 RXD	SPI2 SCK
P0[28]/CAP0[0]/ MAT0[0]	7 <u>[1]</u>	GPIO 0, pin 28	-	TIMER0 CAP0	TIMER0 MAT0
P0[29]/CAP0[1]/ MAT0[1]	8 <mark>[1]</mark>	GPIO 0, pin 29	-	TIMER0 CAP1	TIMER0 MAT1
V _{DD(IO)}	9	3.3 V power supply	y for I/O		
P2[22]/SCK2/ PCAP2[2]/D20	10 <mark>11</mark>	GPIO 2, pin 22	SPI2 SCK	PWM2 CAP2	EXTBUS D20
.PC2930_3		All information prov	vided in this document is subject to lega	I disclaimers.	© NXP B.V. 2010. All rights rese

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Pin name	Pin	Description						
		Function 0 (default)	Function 1	Function 2	Function 3			
P2[23]/SCS1[0]/ PCAP3[0]/D21	11世	GPIO 2, pin 23	SPI1 SCS0	PWM3 CAP0	EXTBUS D21			
P3[6]/SCS0[3]/ PMAT1[0]/TXDL1	12 <mark>[1]</mark>	GPIO 3, pin 6	SPI0 SCS3	PWM1 MAT0	LIN1/UART TXD			
P3[7]/SCS2[1]/ PMAT1[1]/RXDL1	13 <mark>[1]</mark>	GPIO 3, pin 7	SPI2 SCS1	PWM1 MAT1	LIN1/UART RXD			
P0[30]/CAP0[2]/ MAT0[2]	14 <mark>[1]</mark>	GPIO 0, pin 30	-	TIMER0 CAP2	TIMER0 MAT2			
P0[31]/CAP0[3]/ MAT0[3]	15 <mark>[1]</mark>	GPIO 0, pin 31	-	TIMER0 CAP3	TIMER0 MAT3			
P2[24]/SCS1[1]/ PCAP3[1]/D22	16 <mark>[1]</mark>	GPIO 2, pin 24	SPI1 SCS1	PWM3 CAP1	EXTBUS D22			
P2[25]/SCS1[2]/ PCAP3[2]/D23	17 <mark>[1]</mark>	GPIO 2, pin 25	SPI1 SCS2	PWM3 CAP2	EXTBUS D23			
V _{SS(IO)}	18	ground for I/O						
P5[19]/USB_D+1	19 <mark>[2]</mark>	GPIO 5, pin 19	USB_D+1	-	-			
P5[18]/USB_D-1	20 <mark>[2]</mark>	GPIO 5, pin 18	USB_D-1	-	-			
P5[17]/USB_D+2	21 <mark>2</mark>	GPIO 5, pin 17	USB_D+2	-	-			
P5[16]/USB_D-2	22 <mark>[2]</mark>	GPIO 5, pin 16	USB_D-2	-	-			
/ _{DD(IO)}	23	3.3 V power supply f	or I/O					
V _{DD(CORE)}	24	1.8 V power supply f	or digital core					
V _{SS(CORE)}	25	ground for core						
P1[31]/CAP0[1]/ MAT0[1]/EI5	26 <mark>[1]</mark>	GPIO 1, pin 31	TIMER0 CAP1	TIMER0 MAT1	EXTINT5			
V _{SS(IO)}	27	ground for I/O						
P4[0]/A8	28 <mark>[1]</mark>	GPIO 4, pin 0	EXTBUS A8	-	-			
P1[30]/CAP0[0]/ MAT0[0]/EI4	29 <mark>[1]</mark>	GPIO 1, pin 30	TIMER0 CAP0	TIMER0 MAT0	EXTINT4			
P5[0]/D8	30 <mark>[1]</mark>	GPIO 5, pin 0	EXTBUS D8	-	-			
P3[8]/SCS2[0]/ PMAT1[2]/ USB_OVRCR1	31 <mark>11</mark>	GPIO 3, pin 8	SPI2 SCS0	PWM1 MAT2	USB_OVRCR1			
P3[9]/SDO2/ PMAT1[3]/ USB_PPWR1	32 <mark>[1]</mark>	GPIO 3, pin 9	SPI2 SDO	PWM1 MAT3	USB_PPWR1			
P1[29]/CAP1[0]/ TRAP0/ PMAT3[5]	33 <mark>[1]</mark>	GPIO 1, pin 29	TIMER1 CAP0/ ADC0 EXTSTART	PWM TRAP0	PWM3 MAT5			
V _{DD(IO)}	34	3.3 V power supply f	or I/O					
P4[16]/CS6/U1OUT1	35 <mark>[1]</mark>	GPIO 4, pin 16	EXTBUS CS6	UART1 OUT1	-			
P1[28]/CAP1[1]/ TRAP1/PMAT3[4]	36 <mark>[1]</mark>	GPIO 1, pin 28	TIMER1 CAP1/ ADC1 EXTSTART	PWM TRAP1	PWM3 MAT4			
P2[26]/CAP0[2]/ MAT0[2]/EI6	37 <u>[1]</u>	GPIO 2, pin 26	TIMER0 CAP2	TIMER0 MAT2	EXTINT6			

Table 3. LQFP208 pin assignment ...continued

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Pin name	Pin	Description			
	FIII	Function 0	Function 1	Function 2	Function 3
		(default)		Function 2	Function 3
P4[8]/A22/DSR1	38	GPIO 4, pin 8	EXTBUS A22	UART1 DSR	-
V _{SS(IO)}	39	ground for I/O			
P2[27]/CAP0[3]/ MAT0[3]/EI7	40 <mark>[1]</mark>	GPIO 2, pin 27	TIMER0 CAP3	TIMER0 MAT3	EXTINT7
P5[8]/D20/U0OUT2	41 <mark>[1]</mark>	GPIO 5, pin 8	EXTBUS D20	UART0 OUT2	-
P1[27]/CAP1[2]/ TRAP2/PMAT3[3]	42 <u>[1]</u>	GPIO 1, pin 27	TIMER1 CAP2, ADC2 EXT START	PWM TRAP2	PWM3 MAT3
P1[26]/PMAT2[0]/ TRAP3/PMAT3[2]	43 <mark>[1]</mark>	GPIO 1, pin 26	PWM2 MAT0	PWM TRAP3	PWM3 MAT2
P4[20]/USB_VBUS2	44 <mark>[1]</mark>	GPIO4, pin 20	USB_VBUS2		
V _{DD(IO)}	45	3.3 V power supply for	or I/O		
P1[25]/PMAT1[0]/ USB_VBUS1/ PMAT3[1]	46 <mark>[1]</mark>	GPIO 1, pin 25	PWM1 MAT0	USB_VBUS1	PWM3 MAT1
V _{SS(CORE)}	47	ground for core			
V _{DD(CORE)}	48	1.8 V power supply for	or digital core		
P1[24]/PMAT0[0]/ USB_CONNECT1/ PMAT3[0]	49 <u>[1]</u>	GPIO 1, pin 24	PWM0 MAT0	USB_CONNECT1	PWM3 MAT0
P1[23]/RXD0/ USB_SSPND1/CS5	50 <u>[1]</u>	GPIO 1, pin 23	UART0 RXD	USB_SSPND1	EXTBUS CS5
P1[22]/TXD0/ USB_UP_LED1/CS4	51 <mark>11</mark>	GPIO 1, pin 22	UART0 TXD	USB_UP_LED1	EXTBUS CS4
TMS	52 <mark>[1]</mark>	IEEE 1149.1 test mo	de select, pulled up inter	mally	
ТСК	53 <mark>[1]</mark>	IEEE 1149.1 test cloo	ck		
P1[21]/CAP3[3]/ CAP1[3]/D7	54 <mark>[1]</mark>	GPIO 1, pin 21	TIMER3 CAP3	TIMER1 CAP3, MSCSS PAUSE	EXTBUS D7
P1[20]/CAP3[2]/ SCS0[1]/D6	55 <u>[1]</u>	GPIO 1, pin 20	TIMER3 CAP2	SPI0 SCS1	EXTBUS D6
P1[19]/CAP3[1]/ SCS0[2]/D5	56[<u>1]</u>	GPIO 1, pin 19	TIMER3 CAP1	SPI0 SCS2	EXTBUS D5
P1[18]/CAP3[0]/ SDO0/D4	57 <u>[1]</u>	GPIO 1, pin 18	TIMER3 CAP0	SPI0 SDO	EXTBUS D4
P1[17]/CAP2[3]/ SDI0/D3	58 <mark>[1]</mark>	GPIO 1, pin 17	TIMER2 CAP3	SPI0 SDI	EXTBUS D3
V _{SS(IO)}	59	ground for I/O			
P4[4]/A12	60 <mark>[1]</mark>	GPIO 4, pin 4	EXTBUS A12	-	-
P1[16]/CAP2[2]/ SCK0/D2	61 <mark>11</mark>	GPIO 1, pin 16	TIMER2 CAP2	SPI0 SCK	EXTBUS D2
P5[4]/D16	62 <mark>[1]</mark>	GPIO 5, pin 4	EXTBUS D16	-	-
P2[0]/MAT2[0]/ TRAP3/D8	63 <u>[1]</u>	GPIO 2, pin 0	TIMER2 MAT0	PWM TRAP3	EXTBUS D8
P4[12]/BLS0	64 <mark>[1]</mark>	GPIO 4, pin 12	EXTBUS BLS0	-	-

Table 3. LQFP208 pin assignment ...continued

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Pin name								
Finnanie	Pin	Description Function 0 Function 1 Function 2 Function 3						
		(default)	Function	Function 2	Function 5			
P2[1]/MAT2[1]/ TRAP2/D9	65 <mark>[1]</mark>	GPIO 2, pin 1	TIMER2 MAT1	PWM TRAP2	EXTBUS D9			
P5[12]/D24	66 <mark>[1]</mark>	GPIO 5, pin 12	EXTBUS D24	-	-			
V _{DD(IO)}	67	3.3 V power supply	for I/O					
P4[1]/A9	68 <mark>[1]</mark>	GPIO 4, pin 1	EXTBUS A9	-	-			
P3[10]/SDI2/ PMAT1[4]/ JSB_PWRD1	69 <u>[1]</u>	GPIO 3, pin 10	SPI2 SDI	PWM1 MAT4	USB_PWRD1			
V _{SS(CORE)}	70	ground for core						
V _{DD(CORE)}	71	1.8 V power supply	for digital core					
P5[1]/D9	72 <mark>11</mark>	GPIO 5, pin 1	EXTBUS D9	-	-			
P3[11]/SCK2/ PMAT1[5]/USB_LS1	73 <mark>[1]</mark>	GPIO 3, pin 11	SPI2 SCK	PWM1 MAT5	USB_LS1			
P4[17]/CS7/U1OUT2	74 <u>[1]</u>	GPIO 4, pin 17	EXTBUS CS7	UART1 OUT2	-			
P1[15]/CAP2[1]/ SCS0[0]/D1	75 <u>[1]</u>	GPIO 1, pin 15	TIMER2 CAP1	SPI0 SCS0	EXTBUS D1			
P4[9]/A23/DCD1	76 <mark>11</mark>	GPIO4, pin 9	EXTBUS A23	UART1 DCD	-			
V _{SS(IO)}	77	ground for I/O						
P5[9]/D21/DTR0	78 <mark>[1]</mark>	GPIO 5, pin 9	EXTBUS D21	UART0 DTR	-			
P1[14]/CAP2[0]/ SCS0[3]/D0	79 <mark>[1]</mark>	GPIO 1, pin 14	TIMER2 CAP0	SPI0 SCS3	EXTBUS D0			
P4[21]/ JSB_OVRCR2	80 <mark>[1]</mark>	GPIO 4, pin 21	USB_OVRCR2	-	-			
P1[13]/EI3/SCL1/WE	81 <mark>[1]</mark>	GPIO 1, pin 13	EXTINT3	I ² C1 SCL	EXTBUS WE			
P4[5]/A13	82 <mark>[1]</mark>	GPIO 4, pin 5	EXTBUS A13	-	-			
P1[12]/EI2/SDA1/OE	83 <mark>[1]</mark>	GPIO 1, pin 12	EXTINT2	I ² C1 SDA	EXTBUS OE			
P5[5]/D17	84 <mark>[1]</mark>	GPIO 5, pin 5	EXTBUS D17	-	-			
/ _{DD(IO)}	85							
P2[2]/MAT2[2]/ [RAP1/D10	86 <mark>[1]</mark>	GPIO 2, pin 2	TIMER2 MAT2	PWM TRAP1	EXTBUS D10			
P2[3]/MAT2[3]/ FRAP0/D11	87 <mark>[1]</mark>	GPIO 2, pin 3	TIMER2 MAT3	PWM TRAP0	EXTBUS D11			
P1[11] <u>/SC</u> K1/ SCL0/CS3	88 <mark>[1]</mark>	GPIO 1, pin 11	SPI1 SCK	I ² C0 SCL	EXTBUS CS3			
P1[10] <u>/SDI</u> 1/ SDA0/CS2	89 <mark>[1]</mark>	GPIO 1, pin 10	SPI1 SDI	I ² C0 SDA	EXTBUS CS2			
P3[12]/SCS1[0]/ EI4/USB_SSPND1	90 <mark>[1]</mark>	GPIO 3, pin 12	SPI1 SCS0	EXTINT4	USB_SSPND1			
/ _{SS(CORE)}	91	ground for digital co	ore					
VDD(CORE)	92	1.8 V power supply	for digital core					
P3[13]/SDO1/ EI5/IDX0	93 <mark>[1]</mark>	GPIO 3, pin 13	SPI1 SDO	EXTINT5	QEI0 IDX			

Table 3. LQFP208 pin assignment ...continued

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Elichi 2 P2[5]/MAT1[1]/ 96[J] GPIO 2, pin 5 TIMER1 MAT1 EXTINT1 EXTBUS D13 EXTBUS D01/ 96[J] GPIO 1, pin 9 SPI1 SDO LIN1 RXD/UART RXD EXTBUS CST RXDL1/CST 97 ground for 1/O P1[8]/SCS1[0]/ 96[J] GPIO 1, pin 8 SPI1 SCS0 LIN1 TXD/ UART TXD EXTBUS A7 P1[6]/SCS1[3]/ 99[J] GPIO 1, pin 7 SPI1 SCS3 UART1 RXD EXTBUS A7 RXD1/A7 P1[6]/SCS1[2]/ 100[J] GPIO 1, pin 6 SPI1 SCS2 UART1 TXD EXTBUS A6 P2[6]/MAT1[2]/ 101[J] GPIO 2, pin 6 TIMER1 MAT2 EXTINT2 EXTBUS A6 P2[6]/MAT1[2]/ 101[J] GPIO 1, pin 5 SPI1 SCS1 PWM3 MAT5 EXTBUS A5 P1[4]/SCS2[2]/ 102[J] GPIO 1, pin 6 SPI1 SCS1 PWM3 MAT5 EXTBUS A5 P1[4]/SCS2[2]/ 102[J] GPIO 1, pin 6 SPI1 SCS1 PWM3 MAT5 EXTBUS A4 P4[6]/SCS2[2]/ 103[J] GPIO 1, pin 6 SPI1 SCS1 PWM3 MAT4 EXTBUS A4 P4[6]/SCS2[2]/ 103[J] GPIO 1, pin 6 SPI1 SCS1 PWM3 MAT4 EXTBUS A4 P4[6]/SCS2[2]/ 103[J] GPIO 1, pin 6 SPI1 SCS1 PWM3 MAT4 EXTBUS A4 P4[6]/SCS2[2]/ 103[J] GPIO 1, pin 6 SPI1 SCS1 PWM3 MAT4 EXTBUS A4 P4[6]/SCS2[2]/ 103[J] GPIO 1, pin 6 SPI1 SCS1 PWM3 MAT4 EXTBUS A4 P4[6]/SCS2[2]/ 103[J] GPIO 1, pin 7 SPI1 SCS1 PWM3 MAT4 EXTBUS A4 P4[6]/SCS2[2]/ 103[J] GPIO 1, pin 6 SPI1 SCS2 PWM3 MAT4 EXTBUS A4 P4[6]/SCS2[2]/ 103[J] GPIO 1, pin 7 TIMER1 MAT3 EXTINT3 EXTBUS A4 P4[6]/SCS2[1]/ 103[J] asynchronous device reset; active LOW; pulled up internally P5[6]/SCS2[1] 109 1.8 V supply for oscillator VfD_0SC_PLL1 109 1.8 V supply for oscillator VfD_0SC_PLL1 109 1.8 V supply for socillator P4[6]/SCS2[1] 111[J] GPIO 2, pin 7 TIMER1 MAT3 EXTINT3 EXTBUS D15 (BOOT1)[J]/ P3[14]/SCK1/ 113[J] GPIO 3, pin 15 SP11 SCK EXTINT7 CANO RXD P4[6]/SCS2[1] P4[6	Image: Control of the second	Pin name	Pin	Description						
EidČi 2 ¹	Eidó12 ************************************				Function 1	Function 2	Function 3			
Ent/Dia Ent/Ent/Line Second S	Ent/Dia Ent/Ent/Pipe Second S		94 <mark>[1]</mark>	GPIO 2, pin 4	TIMER1 MAT0	EXTINT0	EXTBUS D12			
RXD[1/CST Provide of the text of tex of text of text of text of tex of text of tex of tex	RXDL1/CST 97 ground for I/O Yest(o) 97 ground for I/O P1[8]/SCS1[0/ 98LL GPIO 1, pin 8 SPI1 SCS0 LIN1 TXD/ UART TXD EXTBUS CSC P1[7]/SCS1[3]/ 99LL GPIO 1, pin 6 SPI1 SCS2 UART1 RXD EXTBUS A7 P1[6]/SCS1[2/ 100LL GPIO 1, pin 6 SPI1 SCS2 UART1 TXD EXTBUS A6 P1[6]/SCS1[2/ 100LL GPIO 1, pin 6 SPI1 SCS2 UART1 TXD EXTBUS A6 P1[6]/SCS1[1/ 102LL GPIO 1, pin 5 SPI1 SCS1 PWM3 MAT5 EXTBUS A5 P1[4]/SCS2[2/ 103LL GPIO 1, pin 4 SPI2 SCS2 PWM3 MAT4 EXTBUS A4 PAT3[4]/A4 104LL IEEE 1149.1 test reset NOT; active LOW; pulled up internally ExtBUS A4 PAT3[4]/A4 IDSLL asynchronous device reset; active LOW; pulled up internally Yes(csc) VSc(csc) 106 ground for oscillator (BOOT1)SL Yes(csc) Von_OSC 108LL crystal out for oscillator (BOOT1)SL (BOOT1)SL Yes(csc) 109		95 <u>[1]</u>	GPIO 2, pin 5	TIMER1 MAT1	EXTINT1	EXTBUS D13			
Content Content <t< td=""><td>Construction Sector Construct <thconstruct< th=""> <thconstruct< th=""> <thc< td=""><td></td><td>96<mark>[1]</mark></td><td>GPIO 1, pin 9</td><td>SPI1 SDO</td><td>LIN1 RXD/UART RXD</td><td>EXTBUS CS1</td></thc<></thconstruct<></thconstruct<></td></t<>	Construction Sector Construct Construct <thconstruct< th=""> <thconstruct< th=""> <thc< td=""><td></td><td>96<mark>[1]</mark></td><td>GPIO 1, pin 9</td><td>SPI1 SDO</td><td>LIN1 RXD/UART RXD</td><td>EXTBUS CS1</td></thc<></thconstruct<></thconstruct<>		96 <mark>[1]</mark>	GPIO 1, pin 9	SPI1 SDO	LIN1 RXD/UART RXD	EXTBUS CS1			
TXDL1/CS0 TXDL1/CS0 P1(7)SCS1[3]/ 99 ^[1] GPIO 1, pin 7 SPI1 SCS3 UART1 RXD EXTBUS A7 P1(7)SCS1[2]/ 100 ^[1] GPIO 1, pin 6 SPI1 SCS2 UART1 TXD EXTBUS A6 P2[6]/MAT1[2]/ 101 ^[1] GPIO 2, pin 6 TIMER1 MAT2 EXTINT2 EXTBUS D14 [B2[0]/MAT1[2]/ 102 ^[1] GPIO 1, pin 5 SPI1 SCS1 PWM3 MAT5 EXTBUS A5 P1[4]/SCS2[2]/ 103 ^[1] GPIO 1, pin 4 SPI2 SCS2 PWM3 MAT4 EXTBUS A4 PMAT3[4]/4 103 ^[1] GPIO 1, pin 4 SPI2 SCS2 PWM3 MAT4 EXTBUS A4 PMAT3[4]/4 103 ^[1] GPIO 1, pin 4 SPI2 SCS2 PWM3 MAT4 EXTBUS A5 P1[4]/SCS2[2)/ 103 ^[1] GPIO 1, pin 4 SPI2 SCS2 PWM3 MAT4 EXTBUS A4 WAT3[4]/4 103 ^[1] GPIO 1, pin 6 SPI2 SCS2 PWM3 MAT4 EXTBUS A5 WSigosC) 106 ground for oscillator SUT SUT SUT VDD[OSC_PLL] 109 1.8 V supply for oscillator <td< td=""><td>TXDL1/CS0 TXDL1/CS0 P1(7)SCS1[3]/ 99^[1] GPIO 1, pin 7 SPI1 SCS3 UART1 RXD EXTBUS A7 P1(7)SCS1[2]/ 100^[1] GPIO 1, pin 6 SPI1 SCS2 UART1 TXD EXTBUS A6 P2[6]/MAT1[2]/ 101^[1] GPIO 2, pin 6 TIMER1 MAT2 EXTINT2 EXTBUS D14 [B2[0]/MAT1[2]/ 102^[1] GPIO 1, pin 5 SPI1 SCS1 PWM3 MAT5 EXTBUS A5 P2[6]/MAT1[2]/ 102^[1] GPIO 1, pin 4 SPI2 SCS2 PWM3 MAT5 EXTBUS A5 P1[4]/SCS2[2)/ 103^[1] GPIO 1, pin 4 SPI2 SCS2 PWM3 MAT4 EXTBUS A5 P1[4]/SCS2[2)/ 103^[1] GPIO 1, pin 4 SPI2 SCS2 PWM3 MAT4 EXTBUS A5 P1[4]/SCS2[2)/ 103^[1] GPIO 1, pin 4 SPI2 SCS2 PWM3 MAT4 EXTBUS A5 P1[4]/SCS2[2)/ 103^[1] GPIO 1, pin 6 SPI1 SCS PWM3 MAT4 EXTBUS A5 PXs(opc) 106 ground for oscillator T T T SPI1 SCS EXTINT3 EXTBUS D1 VDD[OSCSC]<</td><td>V_{SS(IO)}</td><td>97</td><td>ground for I/O</td><td></td><td></td><td></td></td<>	TXDL1/CS0 TXDL1/CS0 P1(7)SCS1[3]/ 99 ^[1] GPIO 1, pin 7 SPI1 SCS3 UART1 RXD EXTBUS A7 P1(7)SCS1[2]/ 100 ^[1] GPIO 1, pin 6 SPI1 SCS2 UART1 TXD EXTBUS A6 P2[6]/MAT1[2]/ 101 ^[1] GPIO 2, pin 6 TIMER1 MAT2 EXTINT2 EXTBUS D14 [B2[0]/MAT1[2]/ 102 ^[1] GPIO 1, pin 5 SPI1 SCS1 PWM3 MAT5 EXTBUS A5 P2[6]/MAT1[2]/ 102 ^[1] GPIO 1, pin 4 SPI2 SCS2 PWM3 MAT5 EXTBUS A5 P1[4]/SCS2[2)/ 103 ^[1] GPIO 1, pin 4 SPI2 SCS2 PWM3 MAT4 EXTBUS A5 P1[4]/SCS2[2)/ 103 ^[1] GPIO 1, pin 4 SPI2 SCS2 PWM3 MAT4 EXTBUS A5 P1[4]/SCS2[2)/ 103 ^[1] GPIO 1, pin 4 SPI2 SCS2 PWM3 MAT4 EXTBUS A5 P1[4]/SCS2[2)/ 103 ^[1] GPIO 1, pin 6 SPI1 SCS PWM3 MAT4 EXTBUS A5 PXs(opc) 106 ground for oscillator T T T SPI1 SCS EXTINT3 EXTBUS D1 VDD[OSCSC]<	V _{SS(IO)}	97	ground for I/O						
RXD1/A7 THE P1(6)SCS1[2) 100L1 GPIO 1, pin 6 SPI1 SCS2 UART1 TXD EXTBUS A6 FXD1/A6 101L1 GPIO 2, pin 6 TIMER1 MAT2 EXTINT2 EXTBUS A16 P2(6)MAT1[2) 101L1 GPIO 2, pin 6 TIMER1 MAT2 EXTINT2 EXTBUS A16 P1(5)SCS1[1) 102L1 GPIO 1, pin 5 SPI1 SCS1 PWM3 MAT5 EXTBUS A5 PMAT3[5]/A5 103L1 GPIO 1, pin 4 SPI2 SCS2 PWM3 MAT4 EXTBUS A4 PMAT3[4]/A4 103L1 IEEE 1149.1 test reset NOT; active LOW; pulled up internally TEST 104L1 IEEE 1149.1 test reset NOT; active LOW; pulled up internally RSG 106 ground for oscillator crystal out for oscillator CMOT_OSC 107E1 crystal out for oscillator CMOTO_SC CMOT CMODOSC, PLL) 109 1.8 V supply for oscillator CMOTO_SC CAN0 TXD EXTBUS D15 (BOOT1)121 CAN0 TXD CMOTO_SC CAN0 TXD CAN0 TXD	RXD1/A7 Intervent P1(6)SCS1[2/ 100!11 GPIO 1, pin 6 SPI1 SCS2 UART1 TXD EXTBUS A6 FXD1/A6 TIMER1 MAT2 EXTINT2 EXTBUS D14 (BOOT0)21 EXTBUS D14 (BOOT0)21 P1(5)SCS1[1]/ 101!11 GPIO 2, pin 6 TIMER1 MAT2 EXTINT2 EXTBUS D14 (BOOT0)21 P1(5)SCS1[1]/ 102!11 GPIO 1, pin 5 SPI1 SCS1 PWM3 MAT5 EXTBUS A5 PMAT3[5]/A5 103!11 GPIO 1, pin 4 SPI2 SCS2 PWM3 MAT4 EXTBUS A4 PMAT3[4]/A4 103!11 GPIO 1, pin 4 SPI2 SCS2 PWM3 MAT4 EXTBUS A4 PMAT3[4]/A4 103!11 GPIO 1, pin 4 SPI2 SCS2 PWM3 MAT4 EXTBUS A4 PMAT3[4]/A4 103!11 GPIO 1, pin 4 SPI2 SCS2 PWM3 MAT4 EXTBUS A4 PMAT3[4]/A4 101 IEEE 1149.1 test reset NOT; active LOW; pulled up internally ////////////////////////////////////		98 <mark>[1]</mark>	GPIO 1, pin 8	SPI1 SCS0	LIN1 TXD/ UART TXD	EXTBUS CS0			
TXD1/A6 TIMER1 MAT2 EXTINT2 EXTBUS D14 (BOOT0) ³¹ P2[6]/MAT1[2]/ 101 ¹¹ GPIO 1, pin 5 SPI1 SCS1 PWM3 MAT5 EXTBUS A5 PMAT3[5]/A5 102 ¹¹ GPIO 1, pin 4 SPI2 SCS2 PWM3 MAT4 EXTBUS A4 PMAT3[4]/A4 104 ¹¹ IEEE 1149.1 test reset NOT; active LOW; pulled up internally EXTBUS A4 PMAT3[4]/A4 105 ¹¹ asynchronous device reset; active LOW; pulled up internally VS(osc) 106 ground for oscillator VS(oSC) 106 ground for oscillator VCUT_OSC 107 ⁴¹ crystal out for oscillator VID_OSC 107 ⁴¹ ground for PLL VS(PLL) 110 ground for PLL P2[7]/MAT1[3]/ 111 ¹¹ GPIO 2, pin 7 TIMER1 MAT3 EXTINT3 EXTBUS D15 GI1/4/SOL1/ 119 ground for PLL VS(PLL) 110 ground for PLL VS(PLL) 22[7/MAT1[3]/ 111 ¹¹ GPIO 3, pin 14 SPI1 SCK EXTINT3 EXTBUS D15 GI1/4/SOL1/ 113 ¹¹ GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0	TxD1/A6 T </td <td></td> <td>99<u>[1]</u></td> <td>GPIO 1, pin 7</td> <td>SPI1 SCS3</td> <td>UART1 RXD</td> <td>EXTBUS A7</td>		99 <u>[1]</u>	GPIO 1, pin 7	SPI1 SCS3	UART1 RXD	EXTBUS A7			
EI2/D14 (BOOT0)[3] P1[5]SCSS1[1]/ 102[1] GPIO 1, pin 5 SPI1 SCS1 PWM3 MAT5 EXTBUS A5 P1[4]/SCSS1[2]/ 103[1] GPIO 1, pin 4 SPI2 SCS2 PWM3 MAT4 EXTBUS A4 PTRST 104[1] IEEE 1149.1 test reset NOT; active LOW; pulled up internally EXTBUS A4 RTST 105[1] asynchronous device reset; active LOW; pulled up internally Volume VS(SOSC) 106 ground for oscillator Volume Volume KUN_OSC 108[4] crystal in for oscillator Volume Volume VD0(OSC_PLL) 109 1.8 V supply for oscillator and PLL Volume Volume V2[7]/MAT1[3]/ 111[1] GPIO 2, pin 7 TIMER1 MAT3 EXTINT3 EXTBUS D15 CB/015 111[1] GPIO 3, pin 14 SPI1 SDI EXTINT6 CAN0 TXD P3[15]/SCK1/ 113[1] GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD P3[15]/SCK1/ 113[1] GPIO 2, pin 8 CLK_OUT PWM0 MAT0 SPI0 SCS2 P3[15]/SCK1/ <	EI2/D14 (BOOT0)B1 P1[5]/SCS1[1]/ 102[1] GPIO 1, pin 5 SPI1 SCS1 PWM3 MAT5 EXTBUS A5 P1[4]/SCS2[2]/ 103[1] GPIO 1, pin 4 SPI2 SCS2 PWM3 MAT4 EXTBUS A5 P1[4]/SCS2[2]/ 103[1] GPIO 1, pin 4 SPI2 SCS2 PWM3 MAT4 EXTBUS A4 MAT3[4]/A4 IEEE 1149.1 test reset NOT; active LOW; pulled up internally EXTBUS A4 VS(SOSC) 106 ground for oscillator C KUT_OSC 107[4] crystal out for oscillator C VD(OSC PLL) 109 1.8 V supply for oscillator and PLL C VD(OSC PLL) 109 1.8 V supply for oscillator and PLL C VS(PLL) 110 ground for PLL C P2[7]/MAT1[3]/ 111[1] GPIO 2, pin 7 TIMER1 MAT3 EXTINT3 EXTBUS D15 ISI/D1/ 112[1] GPIO 3, pin 14 SPI1 SDI EXTINT6 CANO TXD P3[15]/SCK1/ 113[1] GPIO 2, pin 8 CLK_OUT PWM0 MAT0 SPI0 SCS1 P4[2]/SCCS2[2]/ 114 </td <td></td> <td>100[1]</td> <td>GPIO 1, pin 6</td> <td>SPI1 SCS2</td> <td>UART1 TXD</td> <td>EXTBUS A6</td>		100[1]	GPIO 1, pin 6	SPI1 SCS2	UART1 TXD	EXTBUS A6			
PMAT3[5]/A5 PMAT3[5]/A5 P1[4]/SCS2[2]/ 103[1] GPIO 1, pin 4 SPI2 SCS2 PWM3 MAT4 EXTBUS A4 PMAT3[4]/A4 104[1] IEEE 1149.1 test reset NOT; active LOW; pulled up internally EXTBUS A4 RST 105[1] asynchronous device reset; active LOW; pulled up internally V VS(OSC) 106 ground for oscillator V KOUT_OSC 107[4] crystal out for oscillator V VDD(OSC, PLL) 109 1.8 V supply for oscillator and PLL V VS(FUL) 110 ground for PLL V P2[7]/MAT1[3]/ 111[1] GPIO 2, pin 7 TIMER1 MAT3 EXTINT3 EXTBUS D15 (BOOT1)[2] P3[14]/SDI1/ 112[1] GPIO 3, pin 14 SPI1 SCK EXTINT6 CAN0 TXD P3[14]/SDCK1/ 113[1] GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD P3[6]/SCK1/ 113[1] GPIO 2, pin 8 CLK_OUT PWM0 MAT0 SPI0 SCS2 PMAT0[0]/SCS0[2] 116[1] GPIO 2, pin 8 CLK_OUT PWM0 MAT1 SPI0 SCS1 </td <td>PMAT3[5]/A5 PI[4]/SCS2[2]/ 103[1] GPIO 1, pin 4 SPI2 SCS2 PWM3 MAT4 EXTBUS A4 PMAT3[4]/A4 104[1] IEEE 1149.1 test reset NOT; active LOW; pulled up internally EXTBUS A4 RST 104[1] asynchronous device reset; active LOW; pulled up internally V VSGOSC) 106 ground for oscillator V XOUT_OSC 107^[4] crystal out for oscillator V XUD_OSC 108^[4] crystal in for oscillator V Vpgosc_PLL) 109 1.8 V supply for oscillator and PLL V Vss(PLL) 110 ground for PLL V P2[7]/MAT1[3]/ 111^[1] GPIO 2, pin 7 TIMER1 MAT3 EXTINT3 EXTBUS D15 (BOOT1)^[2] P3[14]/SDI1/ 112^[1] GPIO 3, pin 14 SPI1 SDI EXTINT6 CAN0 TXD P3[15]/SCK1/ 113^[1] GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD P3[6]/SCK1/ 113^[1] GPIO 2, pin 8 CLK_OUT PWM0 MAT0 SPI0 SCS2 VMDD(0) 114 3.3 V power supply for</td> <td></td> <td>101<mark>11</mark></td> <td>GPIO 2, pin 6</td> <td>TIMER1 MAT2</td> <td>EXTINT2</td> <td></td>	PMAT3[5]/A5 PI[4]/SCS2[2]/ 103[1] GPIO 1, pin 4 SPI2 SCS2 PWM3 MAT4 EXTBUS A4 PMAT3[4]/A4 104[1] IEEE 1149.1 test reset NOT; active LOW; pulled up internally EXTBUS A4 RST 104[1] asynchronous device reset; active LOW; pulled up internally V VSGOSC) 106 ground for oscillator V XOUT_OSC 107 ^[4] crystal out for oscillator V XUD_OSC 108 ^[4] crystal in for oscillator V Vpgosc_PLL) 109 1.8 V supply for oscillator and PLL V Vss(PLL) 110 ground for PLL V P2[7]/MAT1[3]/ 111 ^[1] GPIO 2, pin 7 TIMER1 MAT3 EXTINT3 EXTBUS D15 (BOOT1) ^[2] P3[14]/SDI1/ 112 ^[1] GPIO 3, pin 14 SPI1 SDI EXTINT6 CAN0 TXD P3[15]/SCK1/ 113 ^[1] GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD P3[6]/SCK1/ 113 ^[1] GPIO 2, pin 8 CLK_OUT PWM0 MAT0 SPI0 SCS2 VMDD(0) 114 3.3 V power supply for		101 <mark>11</mark>	GPIO 2, pin 6	TIMER1 MAT2	EXTINT2				
PMAT3[4]/A4 TRST 104[1] IEEE 1149.1 test reset NOT; active LOW; pulled up internally RST 105[1] asynchronous device reset; active LOW; pulled up internally VSG(OSC) 106 ground for oscillator KOUT_OSC 107[4] crystal out for oscillator KIN_OSC 108[4] crystal out for oscillator VDD(OSC_PLL) 109 1.8 V supply for oscillator and PLL Vss(PLL) 110 ground for PLL P2[7]/MAT1[3]/ 111[1] GPIO 2, pin 7 TIMER1 MAT3 EXTINT3 EXTBUS D15 (BOOT1)[3] P3[14]/SDI1/ 112[1] GPIO 3, pin 14 SPI1 SDI EXTINT6 CAN0 TXD P3[15]/SCK1/ 113[1] GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD P3[15]/SCK1/ 115[1] GPIO 2, pin 8 CLK_OUT PWM0 MAT0 SPI0 SCS2 P4MAT0[0/SCS0[2] 116[1] GPIO 2, pin 8 CLK_OUT PWM0 MAT1 SPI0 SCS1 P13[S/SCS2[1/ 116[1] GPIO 2, pin 9 USB_UP_LED1 PWM0 MAT3 EXTBUS A3 P13[3/SCS2[1/	PMAT3[4]/A4 TRST 104[1] IEEE 1149.1 test reset NOT; active LOW; pulled up internally RST 105[1] asynchronous device reset; active LOW; pulled up internally VSs(OSC) 106 ground for oscillator XCUT_OSC 107[4] crystal out for oscillator XIN_OSC 108[4] crystal in for oscillator VDp(OSC_PLL) 109 1.8 V supply for oscillator and PLL Vss(PLL) 110 ground for PLL P2[7]/MAT1[3]/ 111[1] GPIO 2, pin 7 TIMER1 MAT3 EXTINT3 EXTBUS D15 (BOOT1)[2] P3[14]/SDI1/ 112[1] GPIO 3, pin 14 SPI1 SDI EXTINT6 CAN0 RXD P3[15]/SCK1/ 113[1] GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD P4[0]/SCSS[2] 114 3.3 V power supply for I/O P28]/CLK_OUT/ 115[1] GPIO 2, pin 8 CLK_OUT PWIM0 MAT0 SPI0 SCS1 P2[3]/ 116[1] GPIO 2, pin 9 USB_UP_LED1 PWIM0 MAT1 SPI0 SCS1 P3[3]/SCS2[1]/ 1112[1] GPIO 1, pin 3 SPI2 SCS1		102 <mark>1]</mark>	GPIO 1, pin 5	SPI1 SCS1	PWM3 MAT5	EXTBUS A5			
RST 105L1 asynchronous device reset; active LOW; pulled up internally VSR(OSC) 106 ground for oscillator XOUT_OSC 107L9 crystal out for oscillator XIN_OSC 108L4 crystal out for oscillator VDD(OSC_PLL) 109 1.8 V supply for oscillator and PLL VSS(PLL) 110 ground for PLL P2[7]/MAT1[3]/ 111L1 GPIO 2, pin 7 TIMER1 MAT3 EXTINT3 EXTBUS D15 (BOOT1) ^[3] P3[14]/SDI1/ 112L1 GPIO 3, pin 14 SPI1 SDI EXTINT6 CAN0 TXD P3[15]/SCK1/ 113L1 GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD P3[15]/SCK1/ 113L1 GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD P3[15]/SCK1/ 113L1 GPIO 2, pin 8 CLK_OUT PWM0 MAT0 SPI0 SCS2 P40[0) 114 3.3 V power supply for I/O SPI0 SCS1 SPI0 SCS1 PMAT0[0]/SCS0[2] 116L1 GPIO 2, pin 9 USB_UP_LED1 PWM0 MAT1 SPI0 SCS1 P1[3]/SCS2[1]/ 117L1 GP	RST 105 ^[1] asynchronous device reset; active LOW; pulled up internally VSS(OSC) 106 ground for oscillator XOUT_OSC 107 ^[4] crystal out for oscillator XIN_OSC 108 ^[4] crystal out for oscillator VpD(OSC_PLL) 109 1.8 V supply for oscillator and PLL VSs(PLL) 109 1.8 V supply for oscillator and PLL VSs(PLL) 110 ground for PLL P2[7]/MAT1[3]/ 111 ¹¹ GPIO 2, pin 7 TIMER1 MAT3 EXTINT3 EXTBUS D15 (BOOT1) ^[3] P3[14]/SDI1/ 112 ^{[11} GPIO 3, pin 14 SPI1 SDI EXTINT6 CAN0 TXD P3[15]/SCK1/ 113 ^{[11} GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD P3[15]/SCK1/ 113 ^{[11} GPIO 2, pin 8 CLK_OUT PWM0 MAT0 SPI0 SCS2 PMAT0[0]/SCS0[2] 116 ^{[11} GPIO 2, pin 9 USB_UP_LED1 PWM0 MAT1 SPI0 SCS1 USB_UP_LED1/ 117 ^{[11} GPIO 1, pin 3 SPI2 SCS1 PWM3 MAT3 EXTBUS A3 P1[3]/SCS2[1]/ 117 ^{[11} GPIO 1, pin 2		103 <mark>[1]</mark>	GPIO 1, pin 4	SPI2 SCS2	PWM3 MAT4	EXTBUS A4			
Vasiosci (SOC) 106 ground for oscillator VS(OUT_OSC 107 ^[4] crystal out for oscillator VDD(OSC 108 ^[4] crystal in for oscillator VDD(OSC_PLL) 109 1.8 V supply for oscillator and PLL Vss(PLL) 109 1.8 V supply for oscillator and PLL P2(7)/MAT1[3]/ 111 ^[1] GPIO 2, pin 7 TIMER1 MAT3 EXTINT3 EXTBUS D15 (BOOT1) ^[3] 23[14]/SDI1/ 112 ^[1] GPIO 3, pin 14 SPI1 SDI EXTINT6 CAN0 TXD 23[15]/SCK1/ 113 ^[1] GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD 23[15]/SCK1/ 113 ^[1] GPIO 2, pin 8 CLK_OUT PWM0 MAT0 SPI0 SCS2 23[1/RXDC0 114 3.3 V power supply for I/O SPI0 SCS2 SPI0 SCS2 22[3]/ 116 ^[1] GPIO 2, pin 8 CLK_OUT PWM0 MAT0 SPI0 SCS2 22[3]/ 116 ^[1] GPIO 2, pin 9 USB_UP_LED1 PWM0 MAT1 SPI0 SCS1 23[3]/SCS2[1]/ 117 ^[1] GPIO 1, pin 3 SPI2 SCS1 PWM3 MAT3 EXTBUS A3 <td>Vasiosci KOUT_OSC 106 ground for oscillator Vasiosci KIN_OSC 107[4] crystal out for oscillator VbDiOSC_PLL) 109 1.8 V supply for oscillator and PLL Vasiosc_PLL) 109 1.8 V supply for oscillator and PLL Vasiosc_PLL) 109 1.8 V supply for oscillator and PLL Vasiosc_PLL) 110 ground for PLL P2(7)/MAT1[3]/ 111[1] GPIO 2, pin 7 TIMER1 MAT3 EXTINT3 EXTBUS D15 (BOOT1)^[3] S2[14]/SDI1/ 112[1] GPIO 3, pin 14 SPI1 SDI EXTINT6 CAN0 TXD EI6/TXDC0 113 GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD P3[15]/SCK1/ 113[1] GPIO 2, pin 8 CLK_OUT PVM0 MAT0 SPI0 SCS2 P4[0]/CLK_OUT/ 115[1] GPIO 2, pin 8 CLK_OUT PVM0 MAT0 SPI0 SCS2 P2[3]/SCS2[1]/ 116[1] GPIO 2, pin 9 USB_UP_LED1 PVM0 MAT1 SPI0 SCS1 P3[3]/SCS2[1]/ 117^[1] GPIO 1, pin 3 SPI2 SCS1 PVM3 MAT3 EXTBUS A3 P1[3]/SCS2[3</td> <td>TRST</td> <td>104<mark>11</mark></td> <td>IEEE 1149.1 test re</td> <td>set NOT; active LOW; p</td> <td>oulled up internally</td> <td></td>	Vasiosci KOUT_OSC 106 ground for oscillator Vasiosci KIN_OSC 107[4] crystal out for oscillator VbDiOSC_PLL) 109 1.8 V supply for oscillator and PLL Vasiosc_PLL) 109 1.8 V supply for oscillator and PLL Vasiosc_PLL) 109 1.8 V supply for oscillator and PLL Vasiosc_PLL) 110 ground for PLL P2(7)/MAT1[3]/ 111[1] GPIO 2, pin 7 TIMER1 MAT3 EXTINT3 EXTBUS D15 (BOOT1) ^[3] S2[14]/SDI1/ 112[1] GPIO 3, pin 14 SPI1 SDI EXTINT6 CAN0 TXD EI6/TXDC0 113 GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD P3[15]/SCK1/ 113[1] GPIO 2, pin 8 CLK_OUT PVM0 MAT0 SPI0 SCS2 P4[0]/CLK_OUT/ 115[1] GPIO 2, pin 8 CLK_OUT PVM0 MAT0 SPI0 SCS2 P2[3]/SCS2[1]/ 116[1] GPIO 2, pin 9 USB_UP_LED1 PVM0 MAT1 SPI0 SCS1 P3[3]/SCS2[1]/ 117 ^[1] GPIO 1, pin 3 SPI2 SCS1 PVM3 MAT3 EXTBUS A3 P1[3]/SCS2[3	TRST	104 <mark>11</mark>	IEEE 1149.1 test re	set NOT; active LOW; p	oulled up internally				
Control Crystal out for oscillator COUT_OSC 107[4] crystal in for oscillator VID_OSC_PLL) 109 1.8 V supply for oscillator and PLL /Ss(PLL) 110 ground for PLL ?2[7]/MAT1[3]/ 111[1] GPIO 2, pin 7 TIMER1 MAT3 EXTINT3 EXTBUS D15 (BOOT1)[3] ?3[14]/SD11/ 112[1] GPIO 3, pin 14 SPI1 SDI EXTINT6 CAN0 TXD ?3[15]/SCK1/ 113[1] GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD ?2[3]/SJ/SCK2[0] 114 3.3 V power supply for I/O SPI0 SCS2 SPI0 SCS2 ?2[8]/CLK_OUT/ 115[1] GPIO 2, pin 8 CLK_OUT PWM0 MAT0 SPI0 SCS2 ?2[9]/ 116[1] GPIO 2, pin 9 USB_UP_LED1 PWM0 MAT1 SPI0 SCS1 ?2[9]/	Control Crystal out for oscillator KOUT_OSC 107 ^[4] crystal in for oscillator ViDiOSC_PLL) 109 1.8 V supply for oscillator and PLL /Ss(PLL) 110 ground for PLL 22[7]/MAT1[3]/ 111 ^[1] GPIO 2, pin 7 TIMER1 MAT3 EXTINT3 EXTBUS D15 (BOOT1) ^[3] P3[14]/SD11/ 112 ^[1] GPIO 3, pin 14 SPI1 SDI EXTINT6 CAN0 TXD P3[15]/SCK1/ 113 ^[1] GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD P3[15]/SCK1/ 113 ^[1] GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD P2[8]/CLK_OUT/ 115 ^[1] GPIO 2, pin 8 CLK_OUT PWM0 MAT0 SPI0 SCS2 P2[8]/ 116 ^[1] GPIO 2, pin 9 USB_UP_LED1 PWM0 MAT1 SPI0 SCS1 P2[9]/ 116 ^[1] GPIO 1, pin 3 SPI2 SCS1 PWM3 MAT3 EXTBUS A3 P1[3]/SCS2[1]/ 117 ^[1] GPIO 1, pin 2 SPI2 SCS3 PWM3 MAT2 EXTBUS A2 P1[2]/SCS2[3]/ 118 ^[1] GPIO 1, pin 1 EXTINT1	RST	105 <mark>11</mark>	asynchronous devic	ce reset; active LOW; p	ulled up internally				
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KIN_OSC 108 ^[4] crystal in for oscillator VDD(OSC_PLL) 109 1.8 V supply for oscillator and PLL VSS(PLL) 110 ground for PLL P2[7]/MAT1[3]/ 111 ^[1] GPIO 2, pin 7 TIMER1 MAT3 EXTINT3 EXTBUS D15 (BOOT1) ^[3] P3[14]/SDI1/ 112 ^[1] GPIO 3, pin 14 SPI1 SDI EXTINT6 CAN0 TXD P3[15]/SCK1/ 113 ^[1] GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD P3[15]/SCK1/ 115 ^[1] GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD P3[15]/SCK1/ 115 ^[1] GPIO 2, pin 8 CLK_OUT PWM0 MAT0 SPI0 SCS2 P2[8]/CLK_OUT/ 115 ^[1] GPIO 2, pin 8 CLK_OUT PWM0 MAT0 SPI0 SCS2 P2[9]/ 116 ^[1] GPIO 2, pin 9 USB_UP_LED1 PWM0 MAT1 SPI0 SCS1 P2[9]/_ 116 ^[1] GPIO 1, pin 3 SPI2 SCS1 PWM3 MAT3 EXTBUS A3 P2[1]/SCS2[1]/ 117 ^[1] GPIO 1, pin 2 SPI2 SCS3 PWM3 MAT2 EXTBUS A3 P1[1]/E11/ GPIO 1, pin 1 EXTINT1 PWM3 MAT1 EXTBUS A1 <td>KIN_OSC 108^[4] crystal in for oscillator VDD(OSC_PLL) 109 1.8 V supply for oscillator and PLL VS(PLL) 110 ground for PLL P2[7]/MAT1[3]/ 111^[1] GPIO 2, pin 7 TIMER1 MAT3 EXTINT3 EXTBUS D15 (BOOT1)^[3] P3[14]/SDI1/ 112^[1] GPIO 3, pin 14 SPI1 SDI EXTINT6 CAN0 TXD P3[15]/SCK1/ 113^[1] GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD P3[15]/SCK1/ 113^[1] GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD P3[15]/SCK1/ 115^[1] GPIO 2, pin 8 CLK_OUT PWM0 MAT0 SPI0 SCS2 P2[8]/CLK_OUT/ 115^[1] GPIO 2, pin 8 CLK_OUT PWM0 MAT1 SPI0 SCS2 P2[9]/ 116^[1] GPIO 2, pin 9 USB_UP_LED1 PWM0 MAT1 SPI0 SCS1 P2[9]/ 116^[1] GPIO 1, pin 3 SPI2 SCS1 PWM3 MAT3 EXTBUS A3 P3[13/SCS2[1]/ 117^[1] GPIO 1, pin 2 SPI2 SCS3 PWM3 MAT2 EXTBUS A2 P4[2]/SCS2</td> <td>. ,</td> <td>107<mark>4</mark></td> <td>crystal out for oscilla</td> <td>ator</td> <td></td> <td></td>	KIN_OSC 108 ^[4] crystal in for oscillator VDD(OSC_PLL) 109 1.8 V supply for oscillator and PLL VS(PLL) 110 ground for PLL P2[7]/MAT1[3]/ 111 ^[1] GPIO 2, pin 7 TIMER1 MAT3 EXTINT3 EXTBUS D15 (BOOT1) ^[3] P3[14]/SDI1/ 112 ^[1] GPIO 3, pin 14 SPI1 SDI EXTINT6 CAN0 TXD P3[15]/SCK1/ 113 ^[1] GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD P3[15]/SCK1/ 113 ^[1] GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD P3[15]/SCK1/ 115 ^[1] GPIO 2, pin 8 CLK_OUT PWM0 MAT0 SPI0 SCS2 P2[8]/CLK_OUT/ 115 ^[1] GPIO 2, pin 8 CLK_OUT PWM0 MAT1 SPI0 SCS2 P2[9]/ 116 ^[1] GPIO 2, pin 9 USB_UP_LED1 PWM0 MAT1 SPI0 SCS1 P2[9]/ 116 ^[1] GPIO 1, pin 3 SPI2 SCS1 PWM3 MAT3 EXTBUS A3 P3[13/SCS2[1]/ 117 ^[1] GPIO 1, pin 2 SPI2 SCS3 PWM3 MAT2 EXTBUS A2 P4[2]/SCS2	. ,	107 <mark>4</mark>	crystal out for oscilla	ator					
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Notice Notice VSS(PLL) 110 ground for PLL P2[7]/MAT1[3]/ 111 ^[11] GPIO 2, pin 7 TIMER1 MAT3 EXTINT3 EXTBUS D15 (BOOT1) ^[31] P3[14]/SD11/ 112 ^[11] GPIO 3, pin 14 SPI1 SDI EXTINT6 CAN0 TXD P3[14]/SD11/ 113 ^[11] GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD P3[15]/SCK1/ 113 ^[11] GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD P3[15]/SCK1/ 113 ^[11] GPIO 2, pin 8 CLK_OUT PWM0 MAT0 SPI0 SCS2 P2[8]/CLK_OUT/ 115 ^[11] GPIO 2, pin 8 CLK_OUT PWM0 MAT0 SPI0 SCS2 P2[9]/ 116 ^[11] GPIO 2, pin 9 USB_UP_LED1 PWM0 MAT1 SPI0 SCS1 P2[9]/ 116 ^[11] GPIO 2, pin 9 USB_UP_LED1 PWM0 MAT1 SPI0 SCS1 P2[9]/ 116 ^[11] GPIO 1, pin 3 SPI2 SCS1 PWM3 MAT3 EXTBUS A3 P1[2]/SCS2[1]/ 117 ^[11] GPIO 1, pin 2 SPI2 SCS3 PWM3 MAT2 EXTBUS A2 <	Notice Notice<		109	1.8 V supply for osc	cillator and PLL					
P2[7]/MAT1[3]/ 111[1] GPIO 2, pin 7 TIMER1 MAT3 EXTINT3 EXTBUS D15 (BOOT1)[3] P2[7]/MAT1[3]/ 111[1] GPIO 2, pin 7 TIMER1 MAT3 EXTINT3 EXTBUS D15 (BOOT1)[3] P3[14]/SDI1/ 112[1] GPIO 3, pin 14 SPI1 SDI EXTINT6 CAN0 TXD P3[15]/SCK1/ 113[1] GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD P3[15]/SCK1/ 113[1] GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD P3[15]/SCK1/ 113[1] GPIO 2, pin 8 CLK_OUT PWM0 MAT0 SPI0 SCS2 P2[9]/ 116[1] GPIO 2, pin 9 USB_UP_LED1 PWM0 MAT1 SPI0 SCS1 P2[9]/ 116[1] GPIO 2, pin 9 USB_UP_LED1 PWM0 MAT1 SPI0 SCS1 P2[9]/ 116[1] GPIO 2, pin 9 USB_UP_LED1 PWM0 MAT1 SPI0 SCS1 P1[3]/SCS2[1]/ 117[1] GPIO 1, pin 3 SPI2 SCS1 PWM3 MAT3 EXTBUS A3 P1[2]/SCS2[3]/ 118 ^[1] GPIO 1, pin 2 SPI2 SCS3 PWM3 MAT2 EXTBUS A2 P1[1]/E11/ 19 ^[1] GPIO 1, pin 1 EXTINT1	Description Description <thdescription< th=""> <thdescription< th=""></thdescription<></thdescription<>									
P3[14]/SDI1/ EI6/TXDC0 112[1] GPIO 3, pin 14 SPI1 SDI EXTINT6 CAN0 TXD P3[15]/SCK1/ EI7/RXDC0 113[1] GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD P3[15]/SCK1/ EI7/RXDC0 114 3.3 V power supply for I/O C C VDD(IO) 114 3.3 V power supply for I/O P2[8]/CLK_OUT/ PMAT0[0]/SCS0[2] 115[1] GPIO 2, pin 8 CLK_OUT PWM0 MAT0 SPI0 SCS2 P2[9]/ JSB_UP_LED1/ PMAT0[1]/SCS0[1] 116[1] GPIO 2, pin 9 USB_UP_LED1 PWM0 MAT1 SPI0 SCS1 P1[3]/SCS2[1]/ PMAT3[3]/A3 117 ^[1] GPIO 1, pin 3 SPI2 SCS1 PWM3 MAT3 EXTBUS A3 P1[2]/SCS2[3]/ PMAT3[2]/A2 118 ^[1] GPIO 1, pin 2 SPI2 SCS3 PWM3 MAT2 EXTBUS A2 P1[1]/EI1/ 119 ^[1] GPIO 1, pin 1 EXTINT1 PWM3 MAT1 EXTBUS A1	P3[14]/SDI1/ EI6/TXDC0 112[1] GPIO 3, pin 14 SPI1 SDI EXTINT6 CAN0 TXD P3[15]/SCK1/ EI7/RXDC0 113[1] GPIO 3, pin 15 SPI1 SCK EXTINT7 CAN0 RXD P3[15]/SCK1/ EI7/RXDC0 114 3.3 V power supply for I/O EXTINT7 CAN0 RXD P2[8]/CLK_OUT/ PMAT0[0]/SCS0[2] 114 GPIO 2, pin 8 CLK_OUT PWM0 MAT0 SPI0 SCS2 P2[9]/ JSB_UP_LED1/ PMAT0[1]/SCS0[1] 116[1] GPIO 2, pin 9 USB_UP_LED1 PWM0 MAT1 SPI0 SCS1 P2[3]/SCS2[1]/ PMAT3[3]/A3 117[1] GPIO 1, pin 3 SPI2 SCS1 PWM3 MAT3 EXTBUS A3 P2[2]/SCS2[3]/ PMAT3[2]/A2 118[1] GPIO 1, pin 2 SPI2 SCS3 PWM3 MAT2 EXTBUS A2 P1[1]/EI1/ 119[1] GPIO 1, pin 1 EXTINT1 PWM3 MAT1 EXTBUS A1	P2[7]/MAT1[3]/		-	TIMER1 MAT3	EXTINT3				
EIT/RXDC0 114 3.3 V power supply for I/O P2[8]/CLK_OUT/ 115 ^[11] GPIO 2, pin 8 CLK_OUT PWM0 MAT0 SPI0 SCS2 P2[9]/ 116 ^[11] GPIO 2, pin 9 USB_UP_LED1 PWM0 MAT1 SPI0 SCS1 P2[9]/ 116 ^[11] GPIO 2, pin 9 USB_UP_LED1 PWM0 MAT1 SPI0 SCS1 P2[9]/ 116 ^[11] GPIO 1, pin 3 SPI2 SCS1 PWM0 MAT1 SPI0 SCS1 P1[3]/SCS2[1]/ 117 ^[11] GPIO 1, pin 3 SPI2 SCS1 PWM3 MAT3 EXTBUS A3 P1[2]/SCS2[3]/ 118 ^[11] GPIO 1, pin 2 SPI2 SCS3 PWM3 MAT2 EXTBUS A2 P1[1]/E11/ 119 ^[11] GPIO 1, pin 1 EXTINT1 PWM3 MAT1 EXTBUS A1	EIT/RXDC0 114 3.3 V power supply for I/O P2[8]/CLK_OUT/ 115 ^[11] GPIO 2, pin 8 CLK_OUT PWM0 MAT0 SPI0 SCS2 P2[9]/ 116 ^[11] GPIO 2, pin 9 USB_UP_LED1 PWM0 MAT1 SPI0 SCS1 P2[9]/ 116 ^[11] GPIO 2, pin 9 USB_UP_LED1 PWM0 MAT1 SPI0 SCS1 P2[9]/ 116 ^[11] GPIO 1, pin 3 SPI2 SCS1 PWM3 MAT3 EXTBUS A3 P1[3]/SCS2[1]/ 117 ^[11] GPIO 1, pin 2 SPI2 SCS3 PWM3 MAT2 EXTBUS A3 P1[2]/SCS2[3]/ 118 ^[11] GPIO 1, pin 1 EXTINT1 PWM3 MAT1 EXTBUS A1	P3[14]/SDI1/	112 <mark>11</mark>	GPIO 3, pin 14	SPI1 SDI	EXTINT6	. ,			
P2[8]/CLK_OUT/ PMAT0[0]/SCS0[2]115[1] GPIO 2, pin 8GPIO 2, pin 8CLK_OUTPWM0 MAT0SPI0 SCS2P2[9]/ JSB_UP_LED1/ PMAT0[1]/SCS0[1]116[1] GPIO 2, pin 9GPIO 2, pin 9USB_UP_LED1PWM0 MAT1SPI0 SCS1P1[3]/SCS2[1]/ PMAT3[3]/A3117[1] GPIO 1, pin 3GPIO 1, pin 3SPI2 SCS1PWM3 MAT3EXTBUS A3P1[2]/SCS2[3]/ PMAT3[2]/A2118[1] GPIO 1, pin 1GPIO 1, pin 1EXTINT1PWM3 MAT1EXTBUS A1	P2[8]/CLK_OUT/ PMAT0[0]/SCS0[2]115[1]GPIO 2, pin 8CLK_OUTPWM0 MAT0SPI0 SCS2P2[9]/ USB_UP_LED1/ PMAT0[1]/SCS0[1]116[1]GPIO 2, pin 9USB_UP_LED1PWM0 MAT1SPI0 SCS1P1[3]/SCS2[1]/ PMAT3[3]/A3117[1]GPIO 1, pin 3SPI2 SCS1PWM3 MAT3EXTBUS A3P1[2]/SCS2[3]/ PMAT3[2]/A2118[1]GPIO 1, pin 2SPI2 SCS3PWM3 MAT2EXTBUS A2P1[1]/EI1/119[1]GPIO 1, pin 1EXTINT1PWM3 MAT1EXTBUS A1		113 <mark>11</mark>	GPIO 3, pin 15	SPI1 SCK	EXTINT7	CAN0 RXD			
P2[8]/CLK_OUT/ PMAT0[0]/SCS0[2]115[1] GPIO 2, pin 8GPIO 2, pin 8CLK_OUTPWM0 MAT0SPI0 SCS2P2[9]/ JSB_UP_LED1/ PMAT0[1]/SCS0[1]116[1] GPIO 2, pin 9GPIO 2, pin 9USB_UP_LED1PWM0 MAT1SPI0 SCS1P1[3]/SCS2[1]/ PMAT3[3]/A3117[1] GPIO 1, pin 3GPIO 1, pin 3SPI2 SCS1PWM3 MAT3EXTBUS A3P1[2]/SCS2[3]/ PMAT3[2]/A2118[1] GPIO 1, pin 1GPIO 1, pin 1SPI2 SCS3PWM3 MAT2EXTBUS A2P1[1]/EI1/119[1] GPIO 1, pin 1GPIO 1, pin 1EXTINT1PWM3 MAT1EXTBUS A1	P2[8]/CLK_OUT/ PMAT0[0]/SCS0[2]115[1]GPIO 2, pin 8CLK_OUTPWM0 MAT0SPI0 SCS2P2[9]/ JSB_UP_LED1/ PMAT0[1]/SCS0[1]116[1]GPIO 2, pin 9USB_UP_LED1PWM0 MAT1SPI0 SCS1P1[3]/SCS2[1]/ PMAT3[3]/A3117[1]GPIO 1, pin 3SPI2 SCS1PWM3 MAT3EXTBUS A3P1[2]/SCS2[3]/ PMAT3[2]/A2118[1]GPIO 1, pin 2SPI2 SCS3PWM3 MAT2EXTBUS A2P1[1]/E11/119[1]GPIO 1, pin 1EXTINT1PWM3 MAT1EXTBUS A1	V _{DD(IO)}	114	3.3 V power supply	for I/O					
P2[9]/ 116[1] GPIO 2, pin 9 USB_UP_LED1 PWM0 MAT1 SPI0 SCS1 JSB_UP_LED1/ PMAT0[1]/SCS0[1] 117[1] GPIO 1, pin 3 SPI2 SCS1 PWM3 MAT3 EXTBUS A3 P1[3]/SCS2[1]/ 117[1] GPIO 1, pin 3 SPI2 SCS1 PWM3 MAT3 EXTBUS A3 P1[2]/SCS2[3]/ 118[1] GPIO 1, pin 2 SPI2 SCS3 PWM3 MAT2 EXTBUS A2 P1[1]/E11/ 119[1] GPIO 1, pin 1 EXTINT1 PWM3 MAT1 EXTBUS A1	P2[9]/ 116 ^[1] GPIO 2, pin 9 USB_UP_LED1 PWM0 MAT1 SPI0 SCS1 JSB_UP_LED1/ PMAT0[1]/SCS0[1] 117 ^[1] GPIO 1, pin 3 SPI2 SCS1 PWM3 MAT3 EXTBUS A3 P1[3]/SCS2[1]/ 117 ^[1] GPIO 1, pin 3 SPI2 SCS1 PWM3 MAT3 EXTBUS A3 P1[2]/SCS2[3]/ 118 ^[1] GPIO 1, pin 2 SPI2 SCS3 PWM3 MAT2 EXTBUS A2 P1[1]/E11/ 119 ^[1] GPIO 1, pin 1 EXTINT1 PWM3 MAT1 EXTBUS A1	P2[8]/CLK_OUT/				PWM0 MAT0	SPI0 SCS2			
PMAT3[3]/A3 P1[2]/SCS2[3]/ 118 ^[1] GPIO 1, pin 2 SPI2 SCS3 PWM3 MAT2 EXTBUS A2 PMAT3[2]/A2 P1[1]/E11/ 119 ^[1] GPIO 1, pin 1 EXTINT1 PWM3 MAT1 EXTBUS A1	PMAT3[3]/A3 P1[2]/SCS2[3]/ 118 ^[1] GPIO 1, pin 2 SPI2 SCS3 PWM3 MAT2 EXTBUS A2 PMAT3[2]/A2 P1[1]/E11/ 119 ^[1] GPIO 1, pin 1 EXTINT1 PWM3 MAT1 EXTBUS A1	P2[9]/ USB_UP_LED1/	116 ^[1]	GPIO 2, pin 9	USB_UP_LED1	PWM0 MAT1	SPI0 SCS1			
PMAT3[2]/A2 P1[1]/E11/ 119 ^[1] GPIO 1, pin 1 EXTINT1 PWM3 MAT1 EXTBUS A1	PMAT3[2]/A2 PMAT3[2]/A2 P1[1]/E11/ 119 ^[1] GPIO 1, pin 1 EXTINT1 PWM3 MAT1 EXTBUS A1		117 <mark>11</mark>	GPIO 1, pin 3	SPI2 SCS1	PWM3 MAT3	EXTBUS A3			
••			118 <mark>11</mark>	GPIO 1, pin 2	SPI2 SCS3	PWM3 MAT2	EXTBUS A2			
			119 <mark>11</mark>	GPIO 1, pin 1	EXTINT1	PWM3 MAT1	EXTBUS A1			

Table 3. LQFP208 pin assignment ... continued

ARM9 microcontroller with CAN, LIN, and USB

Pin name	Pin	Description						
		Function 0	Function 1	Function 2	Function 3			
、 <i>,</i>	400	(default)						
V _{SS(CORE)}	120	ground for digital cor						
V _{DD(CORE)}	121	1.8 V power supply f	-					
P1[0]/EI0/ PMAT3[0]/A0	122 <mark>11</mark>	GPIO 1, pin 0	EXTINT0	PWM3 MAT0	EXTBUS A0			
P2[10]/USB_INT1 PMAT0[2]/SCS0[0]	123 <mark>[1]</mark>	GPIO 2, pin 10	USB_INT1	PWM0 MAT2	SPI0 SCS0			
P2[11]/ USB_RST1/ PMAT0[3]/SCK0	124 <mark>11</mark>	GPIO 2, pin 11	USB_RST1	PWM0 MAT3	SPI0 SCK			
P0[0]/PHB0/ TXDC0/D24	125 <mark>[1]</mark>	GPIO 0, pin 0	QEI0 PHB	CAN0 TXD	EXTBUS D24			
V _{SS(IO)}	126	ground for I/O						
P4[13]/BLS1	127 <mark>11</mark>	GPIO 4, pin 13	EXTBUS BLS1	-	-			
P0[1]/PHA0/ RXDC0/D25	128 <mark>11</mark>	GPIO 0, pin 1	QEI 0 PHA	CAN0 RXD	EXTBUS D25			
P5[13]/D25	129 <mark>[1]</mark>	GPIO 5, pin 13	EXTBUS D25	-	-			
P0[2]/CLK_OUT/ PMAT0[0]/D26	130 <mark>11</mark>	GPIO 0, pin 2	CLK_OUT	PWM0 MAT0	EXTBUS D26			
P4[2]/A10	131 <mark>11</mark>	GPIO 4, pin 2	EXTBUS A10	-	-			
V _{DD(IO)}	132	3.3 V power supply f	or I/O					
P5[2]/D10	133 <mark>[1]</mark>	GPIO 5, pin 2	EXTBUS D10	-	-			
P0[3]/ USB_UP_LED1/ PMAT0[1]/D27	134 <u>[1]</u>	GPIO 0, pin 3	USB_UP_LED1	PWM0 MAT1	EXTBUS D27			
P4[18]/ USB_UP_LED2	135 <mark>11</mark>	GPIO 4, pin 18	USB_UP_LED2	-	-			
P3[0]/IN0[6 <u>]/</u> PMAT2[0]/CS6	136 <mark>[1]</mark>	GPIO 3, pin 0	ADC0 IN6	PWM2 MAT0	EXTBUS CS6			
P4[10]/OE/CTS1	137 <mark>11</mark>	GPIO 4, pin 10	EXTBUS OE	UART1 CTS	-			
P3[1]/IN0[7/ PMAT2[1]/CS7	138 <mark>11</mark>	GPIO 3, pin 1	ADC0 IN7	PWM2 MAT1	EXTBUS CS7			
P5[10]/D22/DSR0	139 <mark>[1]</mark>	GPIO 5, pin 10	EXTBUS D22	UART0 DSR	-			
P2[12]/IN0[4] PMAT0[4]/SDI0	140 <mark>11</mark>	GPIO 2, pin 12	ADC0 IN4	PWM0 MAT4	SPI0 SDI			
V _{DD(CORE)}	141	1.8 V power supply f	or digital core					
V _{SS(CORE)}	142	ground for digital cor	e					
P4[22]/USB_PPWR2	143 <mark>11</mark>	GPIO 4, pin 22	USB_PPWR2	-	-			
V _{SS(IO)}	144	ground for I/O						
P2[13]/IN0[5] PMAT0[5]/SDO0	145 <mark>11</mark>	GPIO 2, pin 13	ADC0 IN5	PWM0 MAT5	SPI0 SDO			
P4[6]/A20/RI1	146 <mark>11</mark>	GPIO 4, pin 6	EXTBUS A20	UART1 RI	-			
P0[4]/IN0[0]/ PMAT0[2]/D28	147 <mark>11</mark>	GPIO 0, pin 4	ADC0 IN0	PWM0 MAT2	EXTBUS D28			

Table 3. LQFP208 pin assignment ...continued

LPC2930_3

ARM9 microcontroller with CAN, LIN, and USB

P5[6]/D18/RI0 1 P4[14]/BLS2 1 P0[5]/IN0[1]/ 1 PMAT0[3]/D29 1 P5[14]/ USB_SSPND1/RTS0 VDD(IO) 1 P0[6]/IN0[2]/ 1 PMAT0[4]/D30 1 P0[7]/IN0[3]/ 1 PMAT0[5]/D31 1 VDDA(ADC3V3) 1 VDDA(ADC5V0) 1 VREFP 1 VREFN 1	Pin 148 ^[1] 149 ^[1] 150 ^[1] 151 ^[1] 152 153 ^[1] 154 ^[1] 155 156 ^[1] 157	DescriptionFunction 0 (default)GPIO 5, pin 6GPIO 4, pin 14GPIO 0, pin 5GPIO 5, pin 143.3 V power supply for GPIO 0, pin 6GPIO 0, pin 73.3 V power supply for Description 14	Function 1EXTBUS D18EXTBUS BLS2ADC0 IN1USB_SSPND1or I/OADC0 IN2ADC0 IN3	Function 2 UART0 RI - PWM0 MAT3 UART0 RS PWM0 MAT4	Function 3 EXTBUS D29 - EXTBUS D30
P4[14]/BLS2 P0[5]/IN0[1]/ PMAT0[3]/D29 P5[14]/ USB_SSPND1/RTS0 V _{DD(IO)} P0[6]/IN0[2]/ PMAT0[4]/D30 P0[7]/IN0[3]/ PMAT0[5]/D31 V _{DDA(ADC3V3)} JTAGSEL V _{DDA(ADC5V0)} VREFP VREFN P0[8]/IN1[0]/TXDL0/	149 ^[1] 150 ^[1] 151 ^[1] 152 153 ^[1] 154 ^[1] 155 156 ^[1]	(default)GPIO 5, pin 6GPIO 4, pin 14GPIO 0, pin 5GPIO 5, pin 143.3 V power supply for GPIO 0, pin 6GPIO 0, pin 73.3 V power supply for Supply for	EXTBUS D18 EXTBUS BLS2 ADC0 IN1 USB_SSPND1 or I/O ADC0 IN2	UARTO RI - PWM0 MAT3 UARTO RS PWM0 MAT4	- - EXTBUS D29 -
P4[14]/BLS2 P0[5]/IN0[1]/ PMAT0[3]/D29 P5[14]/ USB_SSPND1/RTS0 VDD(IO) P0[6]/IN0[2]/ PMAT0[4]/D30 P0[7]/IN0[3]/ PMAT0[5]/D31 VDDA(ADC3V3) JTAGSEL VDDA(ADC5V0) VREFP VREFN P0[8]/IN1[0]/TXDL0/	149 ^[1] 150 ^[1] 151 ^[1] 152 153 ^[1] 154 ^[1] 155 156 ^[1]	GPIO 4, pin 14 GPIO 0, pin 5 GPIO 5, pin 14 3.3 V power supply for GPIO 0, pin 6 GPIO 0, pin 7 3.3 V power supply for	EXTBUS BLS2 ADC0 IN1 USB_SSPND1 or I/O ADC0 IN2	- PWM0 MAT3 UART0 RS PWM0 MAT4	-
P0[5]/IN0[1]/ PMAT0[3]/D29 P5[14]/ USB_SSPND1/RTS0 VDD(IO) P0[6]/IN0[2]/ PMAT0[4]/D30 P0[7]/IN0[3]/ PMAT0[5]/D31 VDDA(ADC3V3) JTAGSEL VDDA(ADC5V0) VREFP VREFN P0[8]/IN1[0]/TXDL0/	150 ^[1] 151 ^[1] 152 153 ^[1] 154 ^[1] 155 156 ^[1]	GPIO 0, pin 5 GPIO 5, pin 14 3.3 V power supply for GPIO 0, pin 6 GPIO 0, pin 7 3.3 V power supply for	ADC0 IN1 USB_SSPND1 or I/O ADC0 IN2	UART0 RS PWM0 MAT4	-
PMAT0[3]/D29 P5[14]/ USB_SSPND1/RTS0 V _{DD(IO)} P0[6]/IN0[2]/ PMAT0[4]/D30 P0[7]/IN0[3]/ PMAT0[5]/D31 V _{DDA(ADC3V3)} JTAGSEL V _{DDA(ADC5V0)} VREFP VREFN P0[8]/IN1[0]/TXDL0/	151[1] 152 153[1] 154[1] 155 156[1]	GPIO 5, pin 14 3.3 V power supply fo GPIO 0, pin 6 GPIO 0, pin 7 3.3 V power supply fo	USB_SSPND1 or I/O ADC0 IN2	UART0 RS PWM0 MAT4	-
USB_SSPND1/RTS0 V _{DD(IO)} · P0[6]/IN0[2]/ PMAT0[4]/D30 P0[7]/IN0[3]/ PMAT0[5]/D31 V _{DDA(ADC3V3)} · JTAGSEL · V _{DDA(ADC5V0)} · VREFP · VREFN · P0[8]/IN1[0]/TXDL0/ ·	152 153 ^[1] 154 ^[1] 155 156 ^[1]	3.3 V power supply fo GPIO 0, pin 6 GPIO 0, pin 7 3.3 V power supply fo	or I/O ADC0 IN2	PWM0 MAT4	- EXTBUS D30
P0[6]/IN0[2]/ PMAT0[4]/D30 P0[7]/IN0[3]/ PMAT0[5]/D31 VDDA(ADC3V3) JTAGSEL VDDA(ADC5V0) VREFP VREFN P0[8]/IN1[0]/TXDL0/	153 ^[1] 154 ^[1] 155 156 ^[1]	GPIO 0, pin 6 GPIO 0, pin 7 3.3 V power supply fo	ADC0 IN2		EXTBUS D30
PMAT0[4]/D30 P0[7]/IN0[3]/ PMAT0[5]/D31 VDDA(ADC3V3) JTAGSEL VDDA(ADC5V0) VREFP VREFN P0[8]/IN1[0]/TXDL0/	154 ^[1] 155 156 ^[1]	GPIO 0, pin 7 3.3 V power supply fo			EXTBUS D30
PMAT0[5]/D31 V _{DDA(ADC3V3)} JTAGSEL V _{DDA(ADC5V0)} VREFP VREFN P0[8]/IN1[0]/TXDL0/	155 156 <mark>[1]</mark>	3.3 V power supply for	ADC0 IN3		
JTAGSEL · · · · · · · · · · · · · · · · · · ·	156 <mark>[1]</mark>			PWM0 MAT5	EXTBUS D31
V _{DDA(ADC5V0)} · · · · · · · · · · · · · · · · · · ·		TID	or ADC		
VREFP · · · · · · · · · · · · · · · · · · ·	157	TAP controller select boundary scan; pulled		ts the ARM debug mode;	HIGH-level selects
VREFN		5 V supply voltage for	r ADC0 and 5 V referer	nce for ADC0.	
P0[8]/IN1[0]/TXDL0/	158 <mark>4</mark>	HIGH reference for A	DC		
	159 <mark>4]</mark>	LOW reference for Al	DC		
	1605	GPIO 0, pin 8	ADC1 IN0	LIN0 TXD/ UART TXD	EXTBUS A20
P0[9]/IN1[1]/ RXDL0/A21	1615	GPIO 0, pin 9	ADC1 IN1	LIN0 RXD/ UART TXD	EXTBUS A21
P0[10]/IN1[2]/ PMAT1[0]/A8	162 <mark>5</mark>	GPIO 0, pin 10	ADC1 IN2	PWM1 MAT0	EXTBUS A8
P0[11]/IN1[3]/ PMAT1[1]/A9	163 <mark>5</mark>	GPIO 0, pin 11	ADC1 IN3	PWM1 MAT1	EXTBUS A9
P2[14]/SDA1/ PCAP0[0]/BLS0	164 <mark>11</mark>	GPIO 2, pin 14	I ² C1 SDA	PWM0 CAP0	EXTBUS BLS0
P2[15]/SCL1/ PCAP0[1]/BLS1	165 <mark>11</mark>	GPIO 2, pin 15	I ² C1 SCL	PWM0 CAP1	EXTBUS BLS1
P3[2]/MAT3[0]/ PMAT2[2]/ USB_SDA1	166[1]	GPIO 3, pin 2	TIMER3 MAT0	PWM2 MAT2	USB_SDA1
V _{DD(CORE)}	167	1.8 V power supply for	or digital core		
V _{SS(CORE)}	168	ground for digital core	9		
V _{SS(IO)}	169	ground for I/O			
P4[3]/A11	170 <mark>11</mark>	GPIO 4, pin 3	EXTBUS A11	-	-
P3[3]/MAT3[1]/ PMAT2[3]/ USB_SCL1	171	GPIO 3, pin 3	TIMER3 MAT1	PWM2 MAT3	USB_SCL1
P5[3]/D11	172 <mark>[1]</mark>	GPIO 5, pin 3	EXTBUS D11	-	-
P0[12]/IN1[4]/ PMAT1[2]/A10	173 <mark>5</mark>	GPIO 0, pin 12	ADC1 IN4	PWM1 MAT2	EXTBUS A10
P4[19]/ USB_CONNECT2	174[1]	GPIO 4, pin 19	USB_CONNECT2	-	-
LPC2930_3					
Product data sheet		An information provided	in this document is subject to legal discla	imers.	© NXP B.V. 2010. All rights reserv

Table 3. LQFP208 pin assignment ... continued

ARM9 microcontroller with CAN, LIN, and USB

PMAT1[3]/A11 VD0(0) 176 3.3 V power supply fr I/O VD0(0) 176 3.3 V power supply for I/O P P0[14]/WE(CTS0 177/Ll GPIO 4, pin 11 EXTBUS WE UART0 CTS - P0[14]/IN1[6]/ 178 ^E GPIO 5, pin 11 EXTBUS D23 UART0 DCD - P0[15]/N17D/ 180 ^E GPIO 0, pin 15 ADC1 IN7 PWM1 MAT5 EXTBUS A13 P4[23)/ USB_PWRD2 181 ^{Ll} GPIO 4, pin 23 USB_PWRD2 - - USB_PWRD2 182 ^{Ell} GPIO 0, pin 16 ADC2 IN0 UART0 TXD EXTBUS A22 P0[16]IN2[0/ 182 ^{Ell} GPIO 1, pin 7 EXTBUS A21 UART0 OUT1 - VD0/c22 182 ^{Ell} GPIO 2, pin 7 EXTBUS D19 UART0 OUT1 - VD0/U0/11 186 ^{Ell} GPIO 1, pin 15 EXTBUS B153 - - P0[17]/N2[1/ 186 ^{Ell} GPIO 2, pin 16 UART1 UART0 OUT1 - VD0/CORE) 189 1.8 V power supply for J/O - -	Pin name	Pin Description					
PMAT1[3]A11 VD000 176 3.3 V power supply for I/O VD0100 176 3.3 V power supply for I/O P4[11]WE/CTS0 177/L1 GPIO 4, pin 11 EXTBUS WE UART0 CTS - P0[14]/IN1[6]/ 178[2] GPIO 0, pin 14 ADC1 IN6 PWM1 MAT4 EXTBUS A12 PMAT1[3]/A13 180[2] GPIO 0, pin 15 ADC1 IN7 PWM1 MAT5 EXTBUS A13 P4[23]///US1 180[2] GPIO 0, pin 16 ADC1 IN7 PWM1 MAT5 EXTBUS A13 P4[23]//US8 181[1] GPIO 4, pin 23 US8_PWRD2 - - US8_PWRD2 184 ground for I/O EXTBUS A21 UART0 TXD EXTBUS A22 VD0/10/120 184 ground for I/O EXTBUS A21 UART0 OUT1 - P6[7/1019/ 1851 GPIO 5, pin 7 EXTBUS D19 UART0 OUT1 - P0[15]//121/1 1861 GPIO 0, pin 17 ADC2 IN1 UART0 RXD EXTBUS A23 P1[15//121/1 1861 GPIO 5, pin 15 USB_UP_LED1 UART1 RTS -				Function 1	Function 2	Function 3	
P4(11)/WE/CTS0 177LI GPIO 4, pin 11 EXTBUS WE UART0 CTS - PMAT1[4]/A12 178E GPIO 0, pin 14 ADC1 IN6 PWM1 MAT4 EXTBUS A12 PMAT1[4]/A12 178E GPIO 5, pin 11 EXTBUS D23 UART0 DCD - P0[15]/IN1[7]/ 180E GPIO 0, pin 15 ADC1 IN7 PWM1 MAT5 EXTBUS A13 P4[23)/ 181LI GPIO 4, pin 23 USB_PWRD2 - - P0[15]/IN2[0]/ 182E GPIO 0, pin 16 ADC2 IN0 UART0 TXD EXTBUS A22 P4[7]/A21/DTR1 183LI GPIO 4, pin 7 EXTBUS A21 UART0 OUT1 - P4[7]/A21/DTR1 183LI GPIO 5, pin 7 EXTBUS A21 UART0 OUT1 - P4[15/BLS3 187LI GPIO 4, pin 15 EXTBUS B19 UART0 OUT1 - P0[17]/IN2[1/ 186E GPIO 5, pin 7 EXTBUS BLS3 - - P4[15/BLS3 187LI GPIO 5, pin 15 USB_UP_LED1 UART1 RTS - P1[15/UN2[1/ 186E GPIO 5, pin		175 <mark>5</mark>	GPIO 0, pin 13	ADC1 IN5	PWM1 MAT3	EXTBUS A11	
P0[14]/IN1[6]/ 178 ^[5] GPIO 0, pin 14 ADC1 IN6 PWM1 MAT4 EXTBUS A12 PS[11]/D23/DCD0 179 ^[11] GPIO 5, pin 11 EXTBUS D23 UART0 DCD - PS[11]/D23/DCD0 179 ^[11] GPIO 0, pin 15 ADC1 IN7 PWM1 MAT5 EXTBUS A13 PMAT1[5]/A13 181 ^[11] GPIO 4, pin 23 USB_PWRD2 - - P0[15]/N17// 180 ^[12] GPIO 4, pin 7 EXTBUS A21 UART0 TXD EXTBUS A22 P0[16]IN2[0)/ 182 ^[13] GPIO 4, pin 7 EXTBUS A21 UART1 DTR - P4[7]/A21/DTR1 183 ^[11] GPIO 5, pin 7 EXTBUS A21 UART0 TXD EXTBUS A22 P4[7]/A21/DTR1 188 ^[11] GPIO 5, pin 7 EXTBUS D19 UART0 OUT1 - P0[17]/IN2[1]/ 186 ^[11] GPIO 5, pin 15 USB_UP_LED1 UART0 RXD EXTBUS A23 PV0[17]/N2[1]/ 186 ^[11] GPIO 5, pin 15 USB_UP_LED1 UART1 RTS - VDS_0ORE) 189 1.8 V power supply for digital core YSigcorep - -	V _{DD(IO)}	176	3.3 V power supply	y for I/O			
PMAT1[4]/Å12 PMAT1[4]/Å12 PS[11]/D23/DCD0 179[Ll GPIO 5, pin 11 EXTBUS D23 UART0 DCD - PO[15]/IN1[7]/ 180[Ll GPIO 0, pin 15 ADC1 IN7 PWM1 MAT5 EXTBUS A13 PMAT1[5]/A13 181[Ll GPIO 0, pin 16 ADC1 IN7 PWMD2 - - USB_PWRD2 182[Ll GPIO 0, pin 16 ADC2 IN0 UART0 TXD EXTBUS A22 P4[7]/A21/DTR1 183[Ll GPIO 4, pin 7 EXTBUS A21 UART0 OUT1 - VSsio) 184 ground for I/O FE[7/D19/ 185[Ll GPIO 5, pin 7 EXTBUS A21 UART0 OUT1 - V00/UT1 186[Ll GPIO 5, pin 17 ADC2 IN1 UART0 OUT1 - EXTBUS A23 P4[15]/BLS3 187[Ll GPIO 4, pin 15 EXTBUS BLS3 - - - P5[15]/ UBS UP_LED1/ 188[Ll GPIO 2, pin 15 USB_UP_LED1 UART1 RTS - - P2[16]/TRXD1/ 191[Ll GPIO 2, pin 15 USB_UP_LED1 UART1 RTS -	P4[11]/WE/CTS0	177 <mark>[1]</mark>	GPIO 4, pin 11	EXTBUS WE	UART0 CTS	-	
P0[15]/IN1[7]/ 180E GPIO 0, pin 15 ADC1 IN7 PWM1 MAT5 EXTBUS A13 P4[23]/ 181L1 GPIO 4, pin 23 USB_PWRD2 - - P0[16]IN2[0]/ 182E GPIO 0, pin 16 ADC2 IN0 UART0 TXD EXTBUS A22 P0[16]IN2[0]/ 182E GPIO 0, pin 16 ADC2 IN0 UART1 DTR - P4[7]/A21/DTR1 183L1 GPIO 5, pin 7 EXTBUS A21 UART0 OUT1 - P0[17]/019/ 184 ground for I/O - - - - P0[17]/N2[1]/ 186E GPIO 0, pin 17 ADC2 IN1 UART0 OUT1 - - P0[17]/N2[1]/ 186E GPIO 5, pin 15 EXTBUS BLS3 - - - P1[15]/ 188L1 GPIO 5, pin 15 USB_UP_LED1 UART1 RTS - - VDD(CORE) 189 1.8 V power supply for digital core - - - P2[16]//URXD1/ 191L1 GPIO 2, pin 16 UART1 TXD PWM0 CAP2 EXTBUS BLS PCAP0[2]/BL		178 <mark>5</mark>	GPIO 0, pin 14	ADC1 IN6	PWM1 MAT4	EXTBUS A12	
PMATI [5]/Å13 PMI23 USB_PWRD2 181U GPIO 4, pin 23 USB_PWRD2 - - D0[16]IN2[0// VDSB_PWRD2 182 ¹⁵ GPIO 0, pin 16 ADC2 IN0 UART0 TXD EXTBUS A22 P4[7]/A21/DTR1 183 ¹¹ GPIO 4, pin 7 EXTBUS A21 UART1 DTR - P4[7]/A21/DTR1 183 ¹¹ GPIO 5, pin 7 EXTBUS A21 UART0 OUT1 - P4[7]/A21/DTR1 185 ¹¹ GPIO 5, pin 7 EXTBUS A21 UART0 OUT1 - P4[7]/N2[1]/ 185 ¹¹ GPIO 5, pin 7 EXTBUS D19 UART0 OUT1 - UOOUT1 186 ¹¹ GPIO 6, pin 17 ADC2 IN1 UART0 RXD EXTBUS A23 P4[15/BLS3 187 ¹¹ GPIO 5, pin 15 USB_UP_LED1 UART1 RXD EXTBUS A23 P4[15/BLS3 188 ¹¹ GPIO 2, pin 16 UART1 TXD PWM0 CAP2 EXTBUS BLS P170/P10/BLS3 190 ground for digital core P2[17/RXD1/ 191 ¹¹ GPIO 2, pin 16 UART1 TXD PWM1 CAP0 EXTBUS A15 P2[17/RXD1/ 191 ¹¹	P5[11]/D23/DCD0	179 <mark>11</mark>	GPIO 5, pin 11	EXTBUS D23	UART0 DCD	-	
USB_PWRD2 Image: Constraint of the constrain		1805	GPIO 0, pin 15	ADC1 IN7	PWM1 MAT5	EXTBUS A13	
TXD0/A22 P4[7]/A21/DTR1 183U GPIO 4, pin 7 EXTBUS A21 UART1 DTR - P4[7]/A21/DTR1 183U GPIO 4, pin 7 EXTBUS A21 UART0 OUT1 - P5[7]/D19/ 185U GPIO 5, pin 7 EXTBUS D19 UART0 OUT1 - P0[17]/IN2[11/ 186E GPIO 0, pin 17 ADC2 IN1 UART0 RXD EXTBUS A23 P4[15]/BLS3 187U GPIO 4, pin 15 EXTBUS BLS3 - - P5[15]/ US8_UP_LED1/ 188U GPIO 5, pin 15 US8_UP_LED1 UART1 RTS - VD0(CORE) 189 1.8 V power supply for digital core - - - VS8(CORE) 190 ground for digital core - - EXTBUS BLS P2[17]/RXD1/ 191U GPIO 2, pin 16 UART1 TXD PWM0 CAP2 EXTBUS BLS P2[17/RXD1/ 192U GPIO 2, pin 17 UART1 RXD PWM1 CAP0 EXTBUS A14 PO(18)/IN2[2]/ 194E GPIO 2, pin 17 UART1 RXD PWM1 CAP0 EXTBUS A14 PO(19)/IN2[3]/ 193 3.3 V power supply for I/O EXTBUS A14 PMAT2[1/A15		181 <mark>11</mark>	GPIO 4, pin 23	USB_PWRD2	-	-	
VSR(0) 184 ground for I/O P5[7]/D19/ U0OUT1 185 ^[11] GPIO 5, pin 7 EXTBUS D19 UART0 OUT1 - P0[17]/IN2[1]/ 186 ^[21] GPIO 0, pin 17 ADC2 IN1 UART0 RXD EXTBUS A23 RXD0/A23 187 ^[11] GPIO 4, pin 15 EXTBUS BLS3 - - P2[15]/ELS3 187 ^[11] GPIO 5, pin 15 USB_UP_LED1 UART1 RTS - USB_UP_LED1/ 188 ^[11] GPIO 5, pin 15 USB_UP_LED1 UART1 RTS - VSICORE) 190 ground for digital core P2[16]/TXD1/ 191 ^{11]} GPIO 2, pin 16 UART1 TXD PWM0 CAP2 EXTBUS BLS P2[17]/RXD1/ 191 ^{11]} GPIO 2, pin 17 UART1 RXD PWM1 CAP0 EXTBUS BLS P2[16]/TXRXD1/ 192 ¹¹ GPIO 2, pin 17 UART1 RXD PWM1 CAP0 EXTBUS BLS P2[16]/RXD1/ 191 ¹¹ GPIO 2, pin 17 UART1 RXD PWM1 CAP0 EXTBUS A14 PCAP0[2]/BLS2 193 3.3 V power supply for I/O EXTBUS A14 PMAT2[0]/A14 EXTBUS A14		182 <mark>5</mark>	GPIO 0, pin 16	ADC2 IN0	UART0 TXD	EXTBUS A22	
BST/P Display Display <thdisplay< th=""> <thdisplay< th=""> <thdis< td=""><td>P4[7]/A21/DTR1</td><td>183<mark>[1]</mark></td><td>GPIO 4, pin 7</td><td>EXTBUS A21</td><td>UART1 DTR</td><td>-</td></thdis<></thdisplay<></thdisplay<>	P4[7]/A21/DTR1	183 <mark>[1]</mark>	GPIO 4, pin 7	EXTBUS A21	UART1 DTR	-	
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PCAP1[2]/D17 P0[20]/IN2[4]/ 200 ^[5] GPIO 0, pin 20 ADC2 IN4 PWM2 MAT2 EXTBUS A16		198 <mark>[1]</mark>	GPIO 2, pin 18	SPI2 SCS1	PWM1 CAP1	EXTBUS D16	
		199 <mark>11</mark>	GPIO 2, pin 19	SPI2 SCS0	PWM1 CAP2	EXTBUS D17	
		2005	GPIO 0, pin 20	ADC2 IN4	PWM2 MAT2	EXTBUS A16	

Table 3. LQFP208 pin assignment ... continued

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Pin name	Pin	Description			
		Function 0 (default)	Function 1	Function 2	Function 3
P0[21]/IN2[5]/ PMAT2[3]/A17	2015	GPIO 0, pin 21	ADC2 IN5	PWM2 MAT3	EXTBUS A17
P0[22]/IN2[6]/ PMAT2[4]/A18	202 <u>[5]</u>	GPIO 0, pin 22	ADC2 IN6	PWM2 MAT4	EXTBUS A18
V _{SS(IO)}	203				
P0[23]/IN2[7]/ PMAT2[5]/A19	2045	GPIO 0, pin 23	ADC2 IN7	PWM2 MAT5	EXTBUS A19
P2[20]/ PCAP2[0]/D18	205 ^[1]	GPIO 2, pin 20	SPI2 SDO	PWM2 CAP0	EXTBUS D18
V _{DD(CORE)}	206	1.8 V power supply	/ for digital core		
V _{SS(CORE)}	207	ground for digital c	ore		
TDI	208 <mark>1]</mark>	IEEE 1149.1 data i	n, pulled up internally		

Table 3. LQFP208 pin assignment ...continued

Bidirectional pad; analog port; plain input; 3-state output; slew rate control; 5 V tolerant; TTL with hysteresis; programmable pull-up / pull-down / repeater.

[2] USB pad.

[3] For LPC2930 only, these are the boot control pins for configuring the external memory bus width. Use a weak pull-up/pull-down resistor (≈1 kΩ to 10 kΩ) to set level. See <u>Table 11</u>.

[4] Analog pad; Analog input/output.

[5] Analog I/O pad.

6. Functional description

6.1 Architectural overview

The LPC2930 consists of:

- An ARM968E-S processor with real-time emulation support.
- An AMBA multilayer Advanced High-performance Bus (AHB) for interfacing to the on-chip memory controllers.
- Two DTL buses (an universal NXP interface) for interfacing to the interrupt controller and the Power, Clock and Reset Control cluster (also called subsystem).
- Three ARM Peripheral Buses (APB a compatible super set of ARM's AMBA advanced peripheral bus) for connection to on-chip peripherals clustered in subsystems.
- One ARM Peripheral Bus for event router and system control.

The LPC2930 configures the ARM968E-S processor in little-endian byte order. All peripherals run at their own clock frequency to optimize the total system power consumption. The AHB-to-APB bridge used in the subsystems contains a write-ahead buffer one transaction deep. This implies that when the ARM968E-S issues a buffered write action to a register located on the APB side of the bridge, it continues even though the actual write may not yet have taken place. Completion of a second write to the same subsystem will not be executed until the first write is finished.

6.2 ARM968E-S processor

The ARM968E-S is a general purpose 32-bit RISC processor, which offers high performance and very low power consumption. The ARM architecture is based on Reduced Instruction Set Computer (RISC) principles, and the instruction set and related decode mechanism are much simpler than those of microprogrammed Complex Instruction Set Computers (CISC). This simplicity results in a high instruction throughput and impressive real-time interrupt response from a small and cost-effective controller core.

Amongst the most compelling features of the ARM968E-S are:

- Separate directly connected instruction and data Tightly Coupled Memory (TCM) interfaces.
- Write buffers for the AHB and TCM buses.
- Enhanced 16 × 32 multiplier capable of single-cycle MAC operations and 16-bit fixedpoint DSP instructions to accelerate signal-processing algorithms and applications.

Pipeline techniques are employed so that all parts of the processing and memory systems can operate continuously. The ARM968E-S is based on the ARMv5TE five-stage pipeline architecture. Typically, in a three-stage pipeline architecture, while one instruction is being executed its successor is being decoded and a third instruction is being fetched from memory. In the five-stage pipeline additional stages are added for memory access and write-back cycles.

The ARM968E-S processor also employs a unique architectural strategy known as THUMB, which makes it ideally suited to high-volume applications with memory restrictions or to applications where code density is an issue.

The key idea behind THUMB is that of a super-reduced instruction set. Essentially, the ARM968E-S processor has two instruction sets:

- Standard 32-bit ARMv5TE set
- 16-bit THUMB set

The THUMB set's 16-bit instruction length allows it to approach twice the density of standard ARM code while retaining most of the ARM's performance advantage over a traditional 16-bit controller using 16-bit registers. This is possible because THUMB code operates on the same 32-bit register set as ARM code.

THUMB code can provide up to 65 % of the code size of ARM, and 160 % of the performance of an equivalent ARM controller connected to a 16-bit memory system.

The ARM968E-S processor is described in detail in the ARM968E-S data sheet Ref. 2.

6.3 On-chip static RAM

In addition to the two 32 kB TCMs the LPC2930 includes two static RAM memories: one of 32 kB and one of 16 kB. Both may be used for code and/or data storage.

In addition, 8 kB SRAM for the ETB can be used as static memory for code and data storage. However, DMA access to this memory region is not supported.

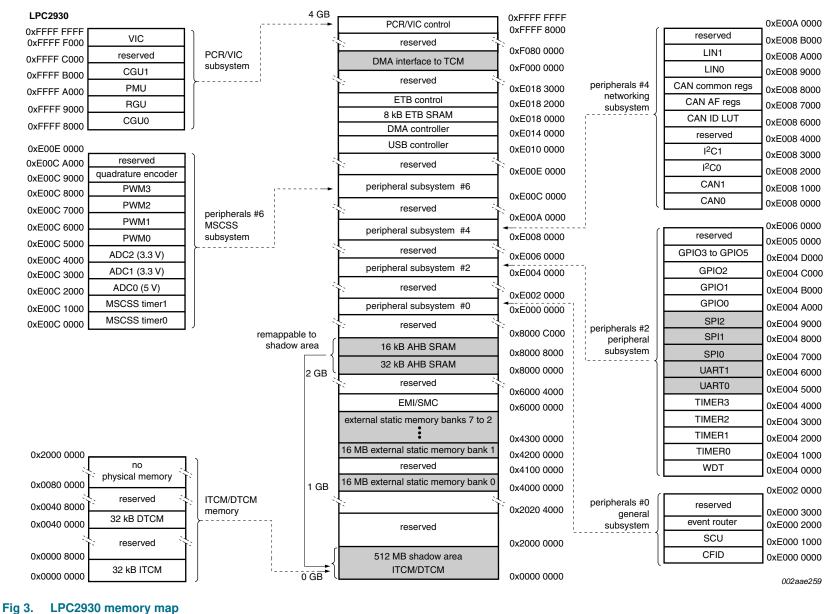
6.4 Memory map

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6.5 Reset, debug, test, and power description

6.5.1 Reset and power-up behavior

The LPC2930 contains external reset input and internal power-up reset circuits. This ensures that a reset is extended internally until the oscillators have reached a stable state. See <u>Section 8</u> for trip levels of the internal power-up reset circuit¹. See <u>Section 9</u> for characteristics of the several start-up and initialization times. <u>Table 4</u> shows the reset pin.

Table 4.	Reset pin	
Symbol	Direction	Description
RST	IN	external reset input, active LOW; pulled up internally

At activation of the RST pin, the JTAGSEL pin is sensed as logic LOW. If this is the case the LPC2930 is assumed to be connected to debug hardware, and internal circuits re-program the source for the BASE_SYS_CLK to be the crystal oscillator instead of the Low-Power Ring Oscillator (LP_OSC). This is required because the clock rate when running at LP_OSC speed is too low for the external debugging environment.

6.5.2 Reset strategy

The LPC2930 contains a central module, the Reset Generator Unit (RGU) in the Power, Clock and Reset Subsystem (PCRSS), which controls all internal reset signals towards the peripheral modules. The RGU provides individual reset control as well as the monitoring functions needed for tracing a reset back to source.

6.5.3 IEEE 1149.1 interface pins (JTAG boundary-scan test)

The LPC2930 contains boundary-scan test logic according to IEEE 1149.1, also referred to in this document as Joint Test Action Group (JTAG). The boundary-scan test pins can be used to connect a debugger probe for the embedded ARM processor. Pin JTAGSEL selects between boundary-scan mode and debug mode. <u>Table 5</u> shows the boundary-scan test pins.

Symbol	Description
JTAGSEL	TAP controller select input. LOW level selects ARM debug mode and HIGH level selects boundary scan; pulled up internally
TRST	test reset input; pulled up internally (active LOW)
TMS	test mode select input; pulled up internally
TDI	test data input, pulled up internally
TDO	test data output
ТСК	test clock input

Table 5. IEEE 1149.1 boundary-scan test and debug interface

6.5.3.1 ETM/ETB

The ETM provides real-time trace capability for deeply embedded processor cores. It outputs information about processor execution to a trace buffer. A software debugger allows configuration of the ETM using a JTAG interface and displays the trace information that has been captured in a format that a user can easily understand. The ETB stores trace data produced by the ETM.

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^{1.} Only for 1.8 V power sources

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The ETM/ETB module has the following features:

- Closely tracks the instructions that the ARM core is executing.
- On-chip trace data storage (ETB).
- All registers are programmed through JTAG interface.
- Does not consume power when trace is not being used.
- THUMB/Java instruction set support.

6.5.4 Power supply pins

Table 6 shows the power supply pins.

Table 6. P	ower supply pins
Symbol	Description
V _{DD(CORE)}	digital core supply 1.8 V
V _{SS(CORE)}	digital core ground (digital core, ADC0/1/2)
V _{DD(IO)}	I/O pins supply 3.3 V
V _{SS(IO)}	I/O pins ground
V _{DD(OSC_PLL)}	oscillator and PLL supply
V _{SS(OSC)}	oscillator ground
V _{SS(PLL)}	PLL ground
V _{DDA(ADC3V3)}	ADC1 and ADC2 3.3 V supply
V _{DDA(ADC5V0)}	ADC0 5.0 V supply

6.6 Clocking strategy

6.6.1 Clock architecture

The LPC2930 contains several different internal clock areas. Peripherals like timers, SPI, UART, CAN and LIN have their own individual clock sources called base clocks. All base clocks are generated by the Clock Generator Unit (CGU0). They may be unrelated in frequency and phase and can have different clock sources within the CGU.

The system clock for the CPU and AHB Bus infrastructure has its own base clock. This means most peripherals are clocked independently from the system clock. See Figure 4 for an overview of the clock areas within the device.

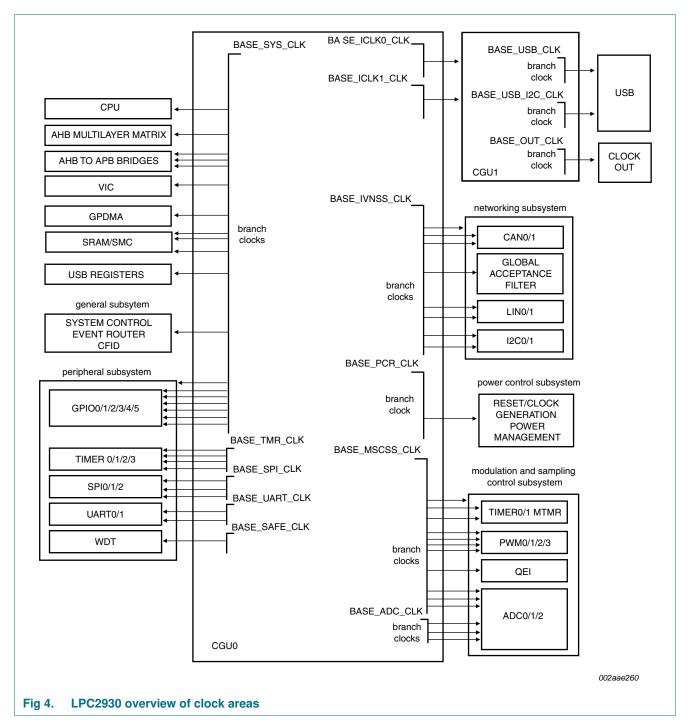
Within each clock area there may be multiple branch clocks, which offers very flexible control for power-management purposes. All branch clocks are outputs of the Power Management Unit (PMU) and can be controlled independently. Branch clocks derived from the same base clock are synchronous in frequency and phase. See <u>Section 6.14</u> for more details of clock and power control within the device.

Two of the base clocks generated by the CGU0 are used as input into a second, dedicated CGU (CGU1). The CGU1 uses its own PLL and fractional dividers to generate two base clocks for the USB controller and one base clock for an independent clock output.

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6.6.2 Base clock and branch clock relationship

Table 7 contains an overview of all the base blocks in the LPC2930 and their derived branch clocks. A short description is given of the hardware parts that are clocked with the individual branch clocks. In relevant cases more detailed information can be found in the specific subsystem description. Some branch clocks have special protection since they clock vital system parts of the device and should not be switched off. See Section 6.14.5 for more details of how to control the individual branch clocks.

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Base clock	Branch clock name	Parts of the device clocked by this branch clock	Remar
BASE_SAFE_CLK	CLK_SAFE	watchdog timer	[1]
BASE_SYS_CLK	CLK_SYS_CPU	ARM968E-S and TCMs	
	CLK_SYS_SYS	AHB bus infrastructure	
	CLK_SYS_PCRSS	AHB side of bridge in PCRSS	
	CLK_SYS_FMC	boot ROM	[2]
	CLK_SYS_RAM0	embedded SRAM Controller 0 (32 kB)	
	CLK_SYS_RAM1	embedded SRAM Controller 1 (16 kB)	
	CLK_SYS_SMC	external Static-Memory Controller	
	CLK_SYS_GESS	general subsystem	
	CLK_SYS_VIC	Vectored Interrupt Controller (VIC)	
	CLK_SYS_PESS	peripheral Subsystem	[3] [5]
	CLK_SYS_GPIO0	GPIO bank 0	
	CLK_SYS_GPIO1	GPIO bank 1	
	CLK_SYS_GPIO2	GPIO bank 2	
	CLK_SYS_GPIO3	GPIO bank 3	
	CLK_SYS_GPIO4	GPIO bank 4	
	CLK_SYS_GPIO5	GPIO bank 5	
	CLK_SYS_IVNSS_A	AHB side of bridge of IVNSS	
	CLK_SYS_MSCSS_A	AHB side of bridge of MSCSS	
	CLK_SYS_DMA	GPDMA	
	CLK_SYS_USB	USB registers	
BASE_PCR_CLK	CLK_PCR_SLOW	PCRSS, CGU, RGU and PMU logic clock	[1], [4]
BASE_IVNSS_CLK	CLK_IVNSS_APB	APB side of the IVNSS	
	CLK_IVNSS_CANCA	CAN controller Acceptance Filter	
	CLK_IVNSS_CANC0	CAN channel 0	
	CLK_IVNSS_CANC1	CAN channel 1	
	CLK_IVNSS_I2C0	l ² C0	
	CLK_IVNSS_I2C1	l ² C1	
	CLK IVNSS LINO	LIN channel 0	

Table 7. CGU0 base clock and branch clock overview

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Base clock	Branch clock name	Parts of the device clocked by this branch clock	Remark
BASE_MSCSS_CLK	CLK_MSCSS_APB	APB side of the MSCSS	
	CLK_MSCSS_MTMR0	timer 0 in the MSCSS	
	CLK_MSCSS_MTMR1	timer 1 in the MSCSS	
	CLK_MSCSS_PWM0	PWM 0	
	CLK_MSCSS_PWM1	PWM 1	
	CLK_MSCSS_PWM2	PWM 2	
	CLK_MSCSS_PWM3	PWM 3	
	CLK_MSCSS_ADC0_APB	APB side of ADC 0	
	CLK_MSCSS_ADC1_APB	APB side of ADC 1	
	CLK_MSCSS_ADC2_APB	APB side of ADC 2	
	CLK_MSCSS_QEI	quadrature encoder	
BASE_UART_CLK	CLK_UART0	UART 0 interface clock	
	CLK_UART1	UART 1 interface clock	
BASE_ICLK0_CLK	-	CGU1 input clock	
BASE_SPI_CLK	CLK_SPI0	SPI 0 interface clock	
	CLK_SPI1	SPI 1 interface clock	
	CLK_SPI2	SPI 2 interface clock	
BASE_TMR_CLK	CLK_TMR0	timer 0 clock for counter part	
	CLK_TMR1	timer 1 clock for counter part	
	CLK_TMR2	timer 2 clock for counter part	
	CLK_TMR3	timer 3 clock for counter part	
BASE_ADC_CLK	CLK_ADC0	control of ADC 0, capture sample result	
	CLK_ADC1	control of ADC 1, capture sample result	
	CLK_ADC2	control of ADC 2, capture sample result	
-	reserved		
BASE_ICLK1_CLK	-	CGU1 input clock	

 Table 7.
 CGU0 base clock and branch clock overview ...continued

[1] This clock is always on (cannot be switched off for system safety reasons)

[2] The boot ROM clock can be turned off to conserve power once the boot process has completed.

[3] In the peripheral subsystem parts of the Timers, watchdog timer, SPI and UART have their own clock source. See <u>Section 6.11</u> for details.

[4] In the Power Clock and Reset Control subsystem parts of the CGU, RGU, and PMU have their own clock source. See <u>Section 6.14</u> for details.

[5] The clock should remain activated when system wake-up on timer or UART is required.

Base clock	Branch clock name	Parts of the device clocked by this branch clock
BASE_OUT_CLK	CLK_OUT_CLK	CLK_OUT pin
BASE_USB_CLK	CLK_USB_CLK	USB clock
BASE_USB_I2C_CLK	CLK_USB_I2C_CLK	USB OTG I ² C clock

Table 8. CGU1 base clock and branch clock overview

6.7 External Static Memory Controller (SMC)

The LPC2930 contains an external Static Memory Controller (SMC) which provides an interface for external (off-chip) memory devices.

Key features are:

- Supports static memory-mapped devices including RAM, ROM, flash, burst ROM and external I/O devices
- Asynchronous page-mode read operation in non-clocked memory subsystems
- · Asynchronous burst-mode read access to burst-mode ROM devices
- Independent configuration for up to eight banks, each up to 16 MB
- Programmable bus-turnaround (idle) cycles (one to 16)
- Programmable read and write wait states (up to 32), for static RAM devices
- · Programmable initial and subsequent burst-read wait state for burst-ROM devices
- Programmable write protection
- Programmable burst-mode operation
- Programmable external data width: 8 bits, 16 bits or 32 bits
- Programmable read-byte lane enable control

6.7.1 Description

The SMC simultaneously supports up to eight independently configurable memory banks. Each memory bank can be 8 bits, 16 bits or 32 bits wide and is capable of supporting SRAM, ROM, burst-ROM memory, or external I/O devices.

A separate chip select output is available for each bank. The chip select lines are configurable to be active HIGH or LOW. Memory-bank selection is controlled by memory addressing. <u>Table 9</u> shows how the 32-bit system address is mapped to the external bus memory base addresses, chip selects, and bank internal addresses.

Table 9.	External	memory-banl	address	bit	description	
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32-bit system address bit field	Symbol	Description
31 to 29	BA[2:0]	external static-memory base address (three most significant bits); the base address can be found in the memory map; see <u>Ref. 1</u> . This field contains '010' when addressing an external memory bank.
28 to 26	CS[2:0]	chip select address space for eight memory banks; see Ref. 1.
25 and 24	-	always '00'; other values are 'mirrors' of the 16 MB bank address.
23 to 0	A[23:0]	16 MB memory banks address space

Table 10.	External static-memory controller banks
CS[2:0]	Bank
000	bank 0
001	bank 1
010	bank 2
011	bank 3
100	bank 4
101	bank 5
110	bank 6
111	bank 7

 Table 10.
 External static-memory controller banks

6.7.2 Boot process

The flashless LPC2930 uses pins P2[7]/D15 and P2[6]/D14 to configure the external memory bus during the boot process. These pins are sampled during POR. See <u>Table 11</u> for possible memory configurations and <u>Table 41</u> for connecting the LPC2930 to external memory during booting.

Table 11. Boot control pins P2[7]/D15 and P2[6]/D14

P2[7]/D15 (BOOT1)	P2[6]/D14 (BOOT0)	Description
0	0	boot from 8-bit external memory on $\overline{\text{CS7}}$
0	1	reserved
1	0	boot from 32-bit external memory on $\overline{\text{CS7}}$
1	1	boot from 16-bit external memory on $\overline{CS7}$

The start-up code residing in the external memory must be linked to execute from address location $0x5C00\ 0000\ (\overline{CS7})$ if the TCM is enabled. If TCM is **not** enabled, executing from address $0x0000\ 0000$ is also possible.

Remark: During the boot process all address lines A23 to A0 are configured as digital output. Do not drive any of the address lines as input even if they are not used.

6.7.3 Pin description

The external static-memory controller module in the LPC2930 has the following pins, which are combined with other functions on the port pins of the LPC2930. <u>Table 12</u> shows the external memory controller pins.

Table 12.	External	memory	controller	pins
-----------	-----------------	--------	------------	------

	•		
Symbol	Pin names	Direction	Description
EXTBUS CSx	CSx	OUT	memory-bank x select, x runs from 0 to 7
EXTBUS BLSy	BLSy	OUT	byte-lane select input y, y runs from 0 to 3
EXTBUS WE	WE	OUT	write enable (active LOW)
EXTBUS OE	OE	OUT	output enable (active LOW)
EXTBUS A[23:0]	A[23:0]	OUT	address bus
EXTBUS D[31:0]	D[31:0]	IN/OUT	data bus

6.7.4 Clock description

The External Static-Memory Controller is clocked by CLK_SYS_SMC, see Section 6.6.2.

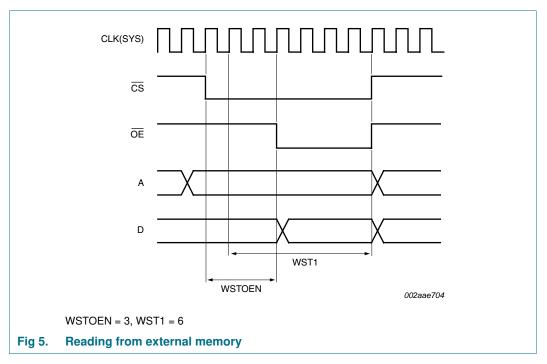
All information provided in this document is subject to legal disclaimers.

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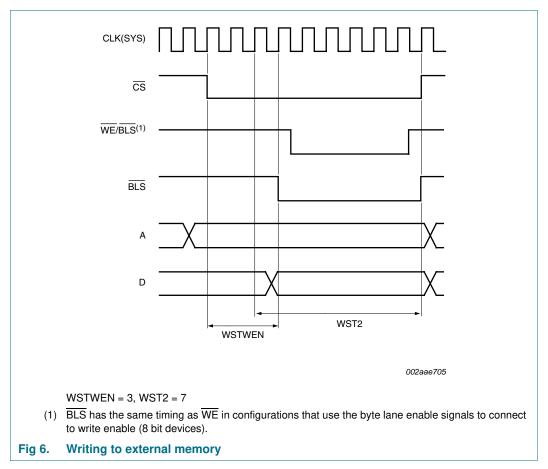
6.7.5 External memory timing diagrams

A timing diagram for reading from external memory is shown in <u>Figure 5</u>. The relationship between the wait-state settings is indicated with arrows.



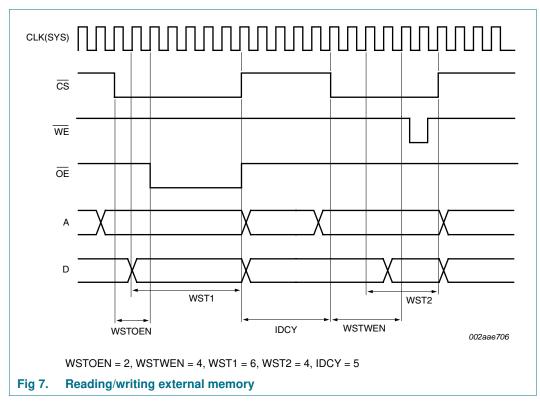
A timing diagram for writing to external memory is shown In <u>Figure 6</u>. The relationship between wait-state settings is indicated with arrows.

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Usage of the idle/turn-around time (IDCY) is demonstrated In Figure 7. Extra wait states are added between a read and a write cycle in the same external memory device.

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Address pins on the device are shared with other functions. When connecting external memories, check that the I/O pin is programmed for the correct function. Control of these settings is handled by the SCU.

6.8 General Purpose DMA (GPDMA) controller

The GPDMA controller allows peripheral-to memory, memory-to-peripheral, peripheral-to-peripheral, and memory-to-memory transactions. Each DMA stream provides unidirectional serial DMA transfers for a single source and destination. For example, a bidirectional port requires one stream for transmit and one for receives. The source and destination areas can each be either a memory region or a peripheral, and can be accessed through the same AHB master or one area by each master.

The GPDMA controls eight DMA channels with hardware prioritization. The DMA controller interfaces to the system via two AHB bus masters, each with a full 32-bit data bus width. DMA operations may be set up for 8-bit, 16-bit, and 32-bit data widths, and can be either big-endian or little-endian. Incrementing or non-incrementing addressing for source and destination are supported, as well as programmable DMA burst size. Scatter or gather DMA is supported through the use of linked lists. This means that the source and destination areas do not have to occupy contiguous areas of memory.

6.8.1 DMA support for peripherals

The GPDMA supports the following peripherals: SPI0/1/2 and UART0/1. The GPDMA can access both embedded SRAM blocks (16 kB and 32 kB), both TCMs and external static memory.

6.8.2 Clock description

The DMA controller is clocked by CLK_SYS_DMA derived from BASE_SYS_CLK, see <u>Section 6.6.2</u>.

6.9 USB interface

The Universal Serial Bus (USB) is a 4-wire bus that supports communication between a host and one or more (up to 127) peripherals. The bus supports hot plugging and dynamic configuration of the devices. All transactions are initiated by the Host controller.

The LPC2930 USB interface includes a device and OTG controller with on-chip PHY for device. The OTG switching protocol is supported through the use of an external controller. Details on typical USB interfacing solutions can be found in <u>Section 10.2</u>.

6.9.1 USB device controller

The device controller enables 12 Mbit/s data exchange with a USB Host controller. It consists of a register interface, serial interface engine, endpoint buffer memory, and a DMA controller. The serial interface engine decodes the USB data stream and writes data to the appropriate endpoint buffer. The status of a completed USB transfer or error condition is indicated via status registers. An interrupt is also generated if enabled. When enabled, the DMA controller transfers data between the endpoint buffer and the on-chip SRAM.

The USB device controller has the following features:

- Fully compliant with USB 2.0 specification (full speed).
- Supports 32 physical (16 logical) endpoints with a 2 kB endpoint buffer RAM.
- Supports Control, Bulk, Interrupt and Isochronous endpoints.
- Scalable realization of endpoints at run time.
- Endpoint Maximum packet size selection (up to USB maximum specification) by software at run time.
- Supports SoftConnect and GoodLink features.
- While USB is in the Suspend mode, the LPC2930 can enter the Power-down mode and wake up on USB activity.
- Supports DMA transfers with the on-chip SRAM blocks on all non-control endpoints.
- Allows dynamic switching between CPU-controlled slave and DMA modes.
- Double buffer implementation for Bulk and Isochronous endpoints.

6.9.2 USB OTG controller

USB OTG (On-The-Go) is a supplement to the USB 2.0 specification that augments the capability of existing mobile devices and USB peripherals by adding host functionality for connection to USB peripherals.

The OTG Controller integrates the device controller, and a master-only I²C interface to implement OTG dual-role device functionality. The dedicated I²C interface controls an external OTG transceiver.

The USB OTG controller has the following features:

- Fully compliant with On-The-Go supplement to the USB 2.0 Specification, Revision 1.0a.
- Hardware support for Host Negotiation Protocol (HNP).
- Includes a programmable timer required for HNP and Session Request Protocol (SRP).
- Supports any OTG transceiver compliant with the OTG Transceiver Specification (CEA-2011), Rev. 1.0.

6.9.3 USB host controller

The host controller enables full- and low-speed data exchange with USB devices attached to the bus. It consists of register interface, serial interface engine and DMA controller. The register interface complies with the *OHCI specification*.

6.9.3.1 Features

- OHCI compliant.
- Two downstream ports.
- Supports per-port power switching.

6.9.4 Pin description

Table 13. USB OTG port pins

Pin name	Direction	Description	Interfacing
Port 1			
USB_VBUS1	I	V _{BUS} status input. When this function is not enabled via its corresponding PINSEL register, it is driven HIGH internally.	-
USB_D+1	I/O	positive differential data	-
USB_D-1	I/O	negative differential data	-
USB_CONNECT1	0	SoftConnect control signal	-
USB_UP_LED1	0	GoodLink LED control signal	-
USB_SCL1	I/O	I ² C serial clock	External OTG transceiver
USB_SDA1	I/O	I ² C serial data	External OTG transceiver
USB_LS1	0	low-speed status (applies to host functionality only)	External OTG transceiver
USB_RST1	0	USB reset status	External OTG transceiver
USB_INT1	0	USB transceiver interrupt	External OTG transceiver
USB_SSPND1	0	bus suspend status	External OTG transceiver
USB_PWRD1	I	port power status	USB host
USB_PPWR1	0	port power enable	USB host
USB_OVRCR1	I	over-current status	USB host
Port 2			
USB_VBUS2	I	V _{BUS} status input. When this function is not enabled via its corresponding PINSEL register, it is driven HIGH internally.	-
USB_D+2	I/O	positive differential data	-
USB_D-2	I/O	negative differential data	-

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Table 13. USB OTG port pins				
Pin name	Direction	Description	Interfacing	
USB_CONNECT2	0	SoftConnect control signal	-	
USB_UP_LED2	0	GoodLink LED control signal	-	
USB_PWRD2	I	port power status	USB host	
USB_PPWR2	0	port power enable	USB host	
USB_OVRCR2	I	over-current status	USB host	

6.9.5 Clock description

Access to the USB registers is clocked by the CLK_SYS_USB, derived from BASE_SYS_CLK, see <u>Section 6.6.2</u>. The CGU1 provides two independent base clocks to the USB block, BASE_USB_CLK and BASE_USB_I2C_CLK (see <u>Section 6.14.3</u>).

6.10 General subsystem

6.10.1 General subsystem clock description

The general subsystem is clocked by CLK_SYS_GESS, see Section 6.6.2.

6.10.2 Chip and feature identification

The Chip/Feature ID (CFID) module contains registers which show and control the functionality of the chip. It contains an ID to identify the silicon and also registers containing information about the features enabled or disabled on the chip.

The key features are:

- Identification of product
- · Identification of features enabled

The CFID has no external pins.

6.10.3 System Control Unit (SCU)

The system control unit contains system-related functions. The key feature is configuration of the I/O port-pins multiplexer. It defines the function of each I/O pin of the LPC2930. The I/O pin configuration should be consistent with peripheral function usage.

The SCU has no external pins.

6.10.4 Event router

The event router provides bus-controlled routing of input events to the vectored interrupt controller for use as interrupt or wake-up signals.

Key features:

- Up to 22 level-sensitive external interrupt pins, including the receive pins of SPI, CAN, LIN, and UART, as well as the I²C-bus SCL pins plus three internal event sources.
- Input events can be used as interrupt source either directly or latched (edge-detected).
- Direct events disappear when the event becomes inactive.
- Latched events remain active until they are explicitly cleared.

- Programmable input level and edge polarity.
- Event detection maskable.
- Event detection is fully asynchronous, so no clock is required.

The event router allows the event source to be defined, its polarity and activation type to be selected and the interrupt to be masked or enabled. The event router can be used to start a clock on an external event.

The vectored interrupt-controller inputs are active HIGH.

6.10.4.1 Pin description

The event router module in the LPC2930 is connected to the pins listed below. The pins are combined with other functions on the port pins of the LPC2930. <u>Table 14</u> shows the pins connected to the event router.

	Direction	Description	Default polarity
EXTINT[7:0]	I	external interrupt inputs 7 to 0	1
CAN0 RXD	I	CAN0 receive data input wake-up	0
CAN1 RXD	I	CAN1 receive data input wake-up	0
I ² C0 SCL	I	I ² C0 SCL clock input	0
I ² C1 SCL	I	I ² C1 SCL clock input	0
LIN0 RXD	I	LIN0 receive data input wake-up	0
LIN1 RXD	I	LIN1 receive data input wake-up	0
SPI0 SDI	I	SPI0 receive data input	0
SPI1 SDI	I	SPI1 receive data input	0
SPI2 SDI	I	SPI2 receive data input	0
UART0 RXD	I	UART0 receive data input	0
UART1 RXD	I	UART1 receive data input	0
USB_SCL1	I	USB I ² C serial clock	0
-	na	CAN interrupt (internal)	1
-	na	VIC FIQ (internal)	1
-	na	VIC IRQ (internal)	1

Table 14. Event-router pin connections

6.11 Peripheral subsystem

6.11.1 Peripheral subsystem clock description

The peripheral subsystem is clocked by a number of different clocks:

- CLK_SYS_PESS
- CLK_UART0/1
- CLK_SPI0/1/2
- CLK_TMR0/1/2/3
- CLK_SAFE see Section 6.6.2

6.11.2 Watchdog timer

The purpose of the watchdog timer is to reset the ARM9 processor within a reasonable amount of time if the processor enters an error state. The watchdog generates a system reset if the user program fails to trigger it correctly within a predetermined amount of time.

Key features:

- Internal chip reset if not periodically triggered.
- Timer counter register runs on always-on safe clock.
- Optional interrupt generation on watchdog time-out.
- Debug mode with disabling of reset.
- Watchdog control register change-protected with key.
- Programmable 32-bit watchdog timer period with programmable 32-bit prescaler.

6.11.2.1 Functional description

The watchdog timer consists of a 32-bit counter with a 32-bit prescaler.

The watchdog should be programmed with a time-out value and then periodically restarted. When the watchdog times out, it generates a reset through the RGU.

To generate watchdog interrupts in watchdog debug mode the interrupt has to be enabled via the interrupt enable register. A watchdog-overflow interrupt can be cleared by writing to the clear-interrupt register.

Another way to prevent resets during debug mode is via the Pause feature of the watchdog timer. The watchdog is stalled when the ARM9 is in debug mode and the PAUSE_ENABLE bit in the watchdog timer control register is set.

The Watchdog Reset output is fed to the Reset Generator Unit (RGU). The RGU contains a reset source register to identify the reset source when the device has gone through a reset. See <u>Section 6.14.4</u>.

6.11.2.2 Clock description

The watchdog timer is clocked by two different clocks; CLK_SYS_PESS and CLK_SAFE, see <u>Section 6.6.2</u>. The register interface towards the system bus is clocked by CLK_SYS_PESS. The timer and prescale counters are clocked by CLK_SAFE which is always on.

6.11.3 Timer

The LPC2930 contains six identical timers: four in the peripheral subsystem and two in the Modulation and Sampling Control SubSystem (MSCSS) located at different peripheral base addresses. This section describes the four timers in the peripheral subsystem. Each timer has four capture inputs and/or match outputs. Connection to device pins depends on the configuration programmed into the port function-select registers. The two timers located in the MSCSS have no external capture or match pins, but the memory map is identical, see <u>Section 6.13.6</u>. One of these timers has an external input for a pause function.

The key features are:

• 32-bit timer/counter with programmable 32-bit prescaler

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- Up to four 32-bit capture channels per timer. These take a snapshot of the timer value when an external signal connected to the TIMERx CAPn input changes state. A capture event may also optionally generate an interrupt.
- Four 32-bit match registers per timer that allow:
 - Continuous operation with optional interrupt generation on match.
 - Stop timer on match with optional interrupt generation.
 - Reset timer on match with optional interrupt generation.
- Up to four external outputs per timer corresponding to match registers, with the following capabilities:
 - Set LOW on match.
 - Set HIGH on match.
 - Toggle on match.
 - Do nothing on match.
- Pause input pin (MSCSS timers only).

The timers are designed to count cycles of the clock and optionally generate interrupts or perform other actions at specified timer values, based on four match registers. They also include capture inputs to trap the timer value when an input signal changes state, optionally generating an interrupt. The core function of the timers consists of a 32 bit prescale counter triggering the 32 bit timer counter. Both counters run on clock CLK_TMRx (x runs from 0 to 3) and all time references are related to the period of this clock. Note that each timer has its individual clock source within the Peripheral SubSystem. In the Modulation and Sampling SubSystem each timer also has its own individual clock source. See section <u>Section 6.14.5</u> for information on generation of these clocks.

6.11.3.1 Pin description

The four timers in the peripheral subsystem of the LPC2930 have the pins described below. The two timers in the modulation and sampling subsystem have no external pins except for the pause pin on MSCSS timer 1. See <u>Section 6.13.6</u> for a description of these timers and their associated pins. The timer pins are combined with other functions on the port pins of the LPC2930, see <u>Section 6.10.3</u>. <u>Table 15</u> shows the timer pins (x runs from 0 to 3).

Symbol	Pin name	Direction	Description
TIMERx CAP[0]	CAPx[0]	IN	TIMER x capture input 0
TIMERx CAP[1]	CAPx[1]	IN	TIMER x capture input 1
TIMERx CAP[2]	CAPx[2]	IN	TIMER x capture input 2
TIMERx CAP[3]	CAPx[3]	IN	TIMER x capture input 3
TIMERx MAT[0]	MATx[0]	OUT	TIMER x match output 0
TIMERx MAT[1]	MATx[1]	OUT	TIMER x match output 1
TIMERx MAT[2]	MATx[2]	OUT	TIMER x match output 2
TIMERx MAT[3]	MATx[3]	OUT	TIMER x match output 3

Table 15. Timer pins

6.11.3.2 Clock description

The timer modules are clocked by two different clocks; CLK_SYS_PESS and CLK_TMRx (x = 0 to 3), see <u>Section 6.6.2</u>. Note that each timer has its own CLK_TMRx branch clock for power management. The frequency of all these clocks is identical as they are derived from the same base clock BASE_CLK_TMR. The register interface towards the system bus is clocked by CLK_SYS_PESS . The timer and prescale counters are clocked by CLK_TMRx .

6.11.4 UARTs

The LPC2930 contains two identical UARTs located at different peripheral base addresses. The key features are:

- 16-byte receive and transmit FIFOs.
- · Register locations conform to 550 industry standard.
- Receiver FIFO trigger points at 1 byte, 4 bytes, 8 bytes and 14 bytes.
- Built-in baud rate generator.
- Support for RS-485/9-bit mode allows both software address detection and automatic address detection using 9-bit mode.
- Both UARTs equipped with standard modem interface signals. This module also provides full support for hardware flow control (auto-CTS/RTS).

The UART is commonly used to implement a serial interface such as RS232. The LPC2930 contains two industry-standard 550 UARTs with 16-byte transmit and receive FIFOs, but they can also be put into 450 mode without FIFOs.

Remark: The LIN controller can be configured to provide two additional standard UART interfaces (see Section 6.12.2).

6.11.4.1 Pin description

The UART pins are combined with other functions on the port pins of the LPC2930. <u>Table 16</u> shows the UART pins (x runs from 0 to 1).

Symbol	Pin name	Direction	Description	
UARTx TXD	TXDx	OUT	UART channel x transmit data output	
UARTx RXD	RXDx	IN	UART channel x receive data input	
UARTx CTS	CTSx	IN	UART channel x Clear To Send (modem)	
UARTx DCD	DCDx	IN	UART channel x Data Carrier Detect (modem)	
UARTx DSR	DSRx	IN	UART channel x Data Set Ready (modem)	
UARTx DTR	DTRx	OUT	UART channel x Data Terminal Ready (modem)	
UARTx RI	RIx	IN	UART Ring Indicator (modem)	
UARTx RTS	RTSx	OUT	UART Request To Send (modem)	
UARTx OUT1	UxOUT1	OUT	UART channel x user designated output 1	
UARTx OUT2	UxOUT2	OUT	UART channel x user designated output 2	
0012	0.0012			

Table 16. UART pins

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6.11.4.2 Clock description

The UART modules are clocked by two different clocks; CLK_SYS_PESS and CLK_UARTx (x = 0 to 1), see Section 6.6.2. Note that each UART has its own CLK_UARTx branch clock for power management. The frequency of all CLK_UARTx clocks is identical since they are derived from the same base clock BASE_CLK_UART. The register interface towards the system bus is clocked by CLK_SYS_PESS. The baud generator is clocked by the CLK_UARTx.

6.11.5 Serial peripheral interface (SPI)

The LPC2930 contains three Serial Peripheral Interface modules (SPIs) to allow synchronous serial communication with slave or master peripherals.

The key features are:

- Master or slave operation.
- Each SPI supports up to four slaves in sequential multi-slave operation.
- Supports timer-triggered operation.
- Programmable clock bit rate and prescale based on SPI source clock (BASE_SPI_CLK), independent of system clock.
- Separate transmit and receive FIFO memory buffers; 16 bits wide, 32 locations deep.
- Programmable choice of interface operation: Motorola SPI or Texas Instruments Synchronous Serial Interfaces.
- Programmable data-frame size from 4 to 16 bits.
- Independent masking of transmit FIFO, receive FIFO and receive overrun interrupts.
- Serial clock-rate master mode: fserial_clk \leq f_{clk(SPI)}/2.
- Serial clock-rate slave mode: fserial_clk = f_{clk(SPI)}/4.
- Internal loopback test mode.

The SPI module can operate in:

- Master mode:
 - Normal transmission mode
 - Sequential slave mode
- Slave mode

6.11.5.1 Functional description

The SPI module is a master or slave interface for synchronous serial communication with peripheral devices that have either Motorola SPI or Texas Instruments Synchronous Serial Interfaces.

The SPI module performs serial-to-parallel conversion on data received from a peripheral device. The transmit and receive paths are buffered with FIFO memories (16 bits wide \times 32 words deep). Serial data is transmitted on pins SDOx and received on pins SDIx.

The SPI module includes a programmable bit-rate clock divider and prescaler to generate the SPI serial clock from the input clock CLK_SPIx.

The SPI module's operating mode, frame format, and word size are programmed through the SLVn_SETTINGS registers.

A single combined interrupt request SPI_INTREQ output is asserted if any of the interrupts are asserted and unmasked.

Depending on the operating mode selected, the SPI SCS outputs operate as an active-HIGH frame synchronization output for Texas Instruments synchronous serial frame format or an active-LOW chip select for SPI.

Each data frame is between four and 16 bits long, depending on the size of words programmed, and is transmitted starting with the MSB.

6.11.5.2 Pin description

The SPI pins are combined with other functions on the port pins of the LPC2930, see <u>Section 6.10.3</u>. <u>Table 17</u> shows the SPI pins (x runs from 0 to 2; y runs from 0 to 3).

	i i pino		
Symbol	Pin name	Direction	Description
SPIx SCSy	SCSx[y]	IN/OUT	SPIx chip select ^{[1][2]}
SPIx SCK	SCKx	IN/OUT	SPIx clock ^[1]
SPIx SDI	SDIx	IN	SPIx data input
SPIx SDO	SDOx	OUT	SPIx data output

Table 17. SPI pins

[1] Direction of SPIx SCS and SPIx SCK pins depends on master or slave mode. These pins are output in master mode, input in slave mode.

[2] In slave mode there is only one chip select input pin, SPIx SCS0. The other chip selects have no function in slave mode.

6.11.5.3 Clock description

The SPI modules are clocked by two different clocks; CLK_SYS_PESS and CLK_SPIx (x = 0, 1, 2), see <u>Section 6.6.2</u>. Note that each SPI has its own CLK_SPIx branch clock for power management. The frequency of all clocks CLK_SPIx is identical as they are derived from the same base clock BASE_CLK_SPI. The register interface towards the system bus is clocked by CLK_SYS_PESS . The serial-clock rate divisor is clocked by CLK_SPIx .

The SPI clock frequency can be controlled by the CGU. In master mode the SPI clock frequency (CLK_SPIx) must be set to at least twice the SPI serial clock rate on the interface. In slave mode CLK_SPIx must be set to four times the SPI serial clock rate on the interface.

6.11.6 General-purpose I/O

The LPC2930 contains six general-purpose I/O ports located at different peripheral base addresses. In the 208-pin package all six ports are available. All I/O pins are bidirectional, and the direction can be programmed individually. The I/O pad behavior depends on the configuration programmed in the port function-select registers.

The key features are:

- General-purpose parallel inputs and outputs.
- Direction control of individual bits.
- Synchronized input sampling for stable input-data values.

• All I/O defaults to input at reset to avoid any possible bus conflicts.

6.11.6.1 Functional description

The general-purpose I/O provides individual control over each bidirectional port pin. There are two registers to control I/O direction and output level. The inputs are synchronized to achieve stable read-levels.

To generate an open-drain output, set the bit in the output register to the desired value. Use the direction register to control the signal. When set to output, the output driver actively drives the value on the output: when set to input the signal floats and can be pulled up internally or externally.

6.11.6.2 Pin description

The six GPIO ports in the LPC2930 have the pins listed below. The GPIO pins are combined with other functions on the port pins of the LPC2930. <u>Table 18</u> shows the GPIO pins.

Table 10. GFIO	pins		
Symbol	Pin name	Direction	Description
GPIO0 pin[31:0]	P0[31:0]	IN/OUT	GPIO port x pins 31 to 0
GPIO1 pin[31:0]	P1[31:0]	IN/OUT	GPIO port x pins 31 to 0
GPIO2 pin[27:0]	P2[27:0]	IN/OUT	GPIO port x pins 27 to 0
GPIO3 pin[15:0]	P3[15:0]	IN/OUT	GPIO port x pins 15 to 0
GPIO4 pin[24:0]	P4[24:0]	IN/OUT	GPIO port x pins 24 to 0
GPIO5 pin[19:0]	P5[19:0]	IN/OUT	GPIO port x pins 19 to 0

Table 18. GPIO pins

6.11.6.3 Clock description

The GPIO modules are clocked by several clocks, all of which are derived from BASE_SYS_CLK; CLK_SYS_PESS and CLK_SYS_GPIOx (x = 0, 1, 2, 3, 4, 5), see <u>Section 6.6.2</u>. Note that each GPIO has its own CLK_SYS_GPIOx branch clock for power management. The frequency of all clocks CLK_SYS_GPIOx is identical to CLK_SYS_PESS since they are derived from the same base clock BASE_SYS_CLK.

6.12 Networking subsystem

6.12.1 CAN gateway

Controller Area Network (CAN) is the definition of a high-performance communication protocol for serial data communication. The two CAN controllers in the LPC2930 provide a full implementation of the CAN protocol according to the *CAN specification version 2.0B*. The gateway concept is fully scalable with the number of CAN controllers, and always operates together with a separate powerful and flexible hardware acceptance filter.

The key features are:

- Supports 11-bit as well as 29-bit identifiers.
- Double receive buffer and triple transmit buffer.
- Programmable error-warning limit and error counters with read/write access.
- Arbitration-lost capture and error-code capture with detailed bit position.
- Single-shot transmission (i.e. no re-transmission).

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- Listen-only mode (no acknowledge; no active error flags).
- Reception of 'own' messages (self-reception request).
- FullCAN mode for message reception.

6.12.1.1 Global acceptance filter

The global acceptance filter provides look-up of received identifiers - called acceptance filtering in CAN terminology - for all the CAN controllers. It includes a CAN ID look-up table memory, in which software maintains one to five sections of identifiers. The CAN ID look-up table memory is 2 kB large (512 words, each of 32 bits). It can contain up to 1024 standard frame identifiers or 512 extended frame identifiers or a mixture of both types. It is also possible to define identifier groups for standard and extended message formats.

6.12.1.2 Pin description

The two CAN controllers in the LPC2930 have the pins listed below. The CAN pins are combined with other functions on the port pins of the LPC2930. <u>Table 19</u> shows the CAN pins (x runs from 0 to 1).

Table 19. CAN pins

Symbol	Pin name	Direction	Description
CANx TXD	TXDC0/1	OUT	CAN channel x transmit data output
CANx RXD	RXDC0/1	IN	CAN channel x receive data input

6.12.2 LIN

The LPC2930 contain two LIN 2.0 master controllers. These can be used as dedicated LIN 2.0 master controllers with additional support for sync break generation and with hardware implementation of the LIN protocol according to spec 2.0.

Remark: Both LIN channels can be also configured as UART channels.

The key features are:

- · Complete LIN 2.0 message handling and transfer
- One interrupt per LIN message
- Slave response time-out detection
- Programmable sync-break length
- · Automatic sync-field and sync-break generation
- Programmable inter-byte space
- · Hardware or software parity generation
- · Automatic checksum generation
- Fault confinement
- Fractional baud rate generator

6.12.2.1 Pin description

The two LIN 2.0 master controllers in the LPC2930 have the pins listed below. The LIN pins are combined with other functions on the port pins of the LPC2930. <u>Table 20</u> shows the LIN pins. For more information see Ref. 1 subsection 3.43, LIN master controller.

Table 20. LIN controller pins

Symbol	Pin name	Direction	Description
LIN0/1 TXD	TXDL0/1	OUT	LIN channel 0/1 transmit data output
LIN0/1 RXD	RXDL0/1	IN	LIN channel 0/1 receive data input

6.12.3 I²C-bus serial I/O controllers

The LPC2930 each contain two I²C-bus controllers.

The I²C-bus is bidirectional for inter-IC control using only two wires: a serial clock line (SCL) and a serial data line (SDA). Each device is recognized by a unique address and can operate as either a receiver-only device (e.g., an LCD driver) or as a transmitter with the capability to both receive and send information (such as memory). Transmitters and/or receivers can operate in either master or slave mode, depending on whether the chip has to initiate a data transfer or is only addressed. The I²C is a multi-master bus, and it can be controlled by more than one bus master connected to it.

The main features if the I²C-bus interfaces are:

- I²C0 and I²C1 use standard I/O pins with bit rates of up to 400 kbit/s (Fast I²C-bus) and do not support powering off of individual devices connected to the same bus lines.
- Easy to configure as master, slave, or master/slave.
- Programmable clocks allow versatile rate control.
- Bidirectional data transfer between masters and slaves.
- Multi-master bus (no central master).
- Arbitration between simultaneously transmitting masters without corruption of serial data on the bus.
- Serial clock synchronization allows devices with different bit rates to communicate via one serial bus.
- Serial clock synchronization can be used as a handshake mechanism to suspend and resume serial transfer.
- The I²C-bus can be used for test and diagnostic purposes.
- All I²C-bus controllers support multiple address recognition and a bus monitor mode.

6.12.3.1 Pin description

Table 21. I²C-bus pins^[1]

Symbol	Pin name	Direction	Description
I2C SCL0/1	SCL0/1	I/O	I ² C clock input/output
I2C SDA0/1	SDA0/1	I/O	I ² C data input/output

[1] Note that the pins are not I²C-bus compliant open-drain pins.

6.13 Modulation and Sampling Control SubSystem (MSCSS)

The Modulation and Sampling Control Subsystem (MSCSS) in the LPC2930 includes four Pulse-Width Modulators (PWMs), three 10-bit successive approximation Analog-to-Digital Converters (ADCs) and two timers.

The key features of the MSCSS are:

- Two 10-bit, 400 ksamples/s, 8-channel ADCs with 3.3 V inputs and various triggerstart options
- One 10-bit, 400 ksamples/s, 8-channel ADC with 5 V inputs (5 V measurement range) and various trigger-start options
- Four 6-channel PWMs (Pulse-Width Modulators) with capture and trap functionality
- · Two dedicated timers to schedule and synchronize the PWMs and ADCs
- Quadrature encoder interface

6.13.1 Functional description

The MSCSS contains Pulse-Width Modulators (PWMs), Analog-to-Digital Converters (ADCs) and timers.

Figure 8 provides an overview of the MSCSS. An AHB-to-APB bus bridge takes care of communication with the AHB system bus. Two internal timers are dedicated to this subsystem. MSCSS timer 0 can be used to generate start pulses for the ADCs and the first PWM. The second timer (MSCSS timer 1) is used to generate 'carrier' signals for the PWMs. These carrier patterns can be used, for example, in applications requiring current control. Several other trigger possibilities are provided for the ADCs (external, cascaded or following a PWM). The capture inputs of both timers can also be used to capture the start pulse of the ADCs.

The PWMs can be used to generate waveforms in which the frequency, duty cycle and rising and falling edges can be controlled very precisely. Capture inputs are provided to measure event phases compared to the main counter. Depending on the applications, these inputs can be connected to digital sensor motor outputs or digital external signals. Interrupt signals are generated on several events to closely interact with the CPU.

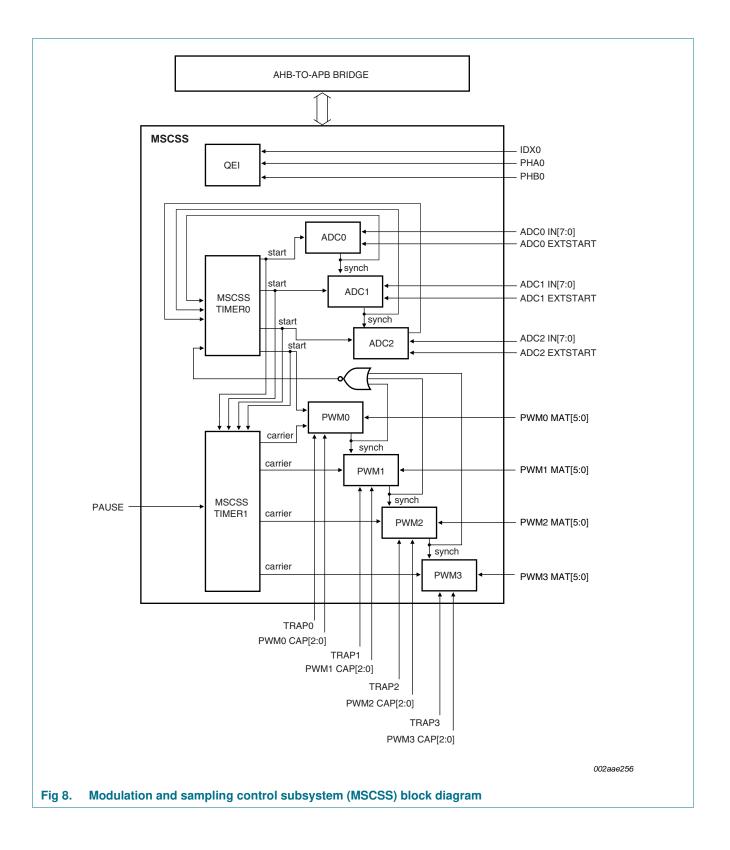
The ADCs can be used for any application needing accurate digitized data from analog sources. To support applications like motor control, a mechanism to synchronize several PWMs and ADCs is available (sync_in and sync_out).

Note that the PWMs run on the PWM clock and the ADCs on the ADC clock, see <u>Section 6.14.2</u>.

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6.13.2 Pin description

The pins of the LPC2930 MSCSS associated with the three ADC modules are described in <u>Section 6.13.4.2</u>. Pins connected to the four PWM modules are described in <u>Section 6.13.5.4</u>, pins directly connected to the MSCSS timer 1 module are described in <u>Section 6.13.6.1</u>, and pins connected to the quadrature encoder interface are described in <u>Section 6.13.7.1</u>.

6.13.3 Clock description

The MSCSS is clocked from a number of different sources:

- CLK_SYS_MSCSS_A clocks the AHB side of the AHB-to-APB bus bridge.
- CLK_MSCSS_APB clocks the subsystem APB bus.
- CLK_MSCSS_MTMR0/1 clocks the timers.
- CLK_MSCSS_PWM0:3 clocks the PWMs.

Each ADC has two clock areas; a APB part clocked by CLK_MSCSS_ADCx_APB (x = 0, 1, or 2) and a control part for the analog section clocked by CLK_ADCx = 0, 1, or 2), see Section 6.6.2.

All clocks are derived from the BASE_MSCSS_CLK, except for CLK_SYS_MSCSS_A which is derived form BASE_SYS_CLK, and the CLK_ADCx clocks which are derived from BASE_CLK_ADC. If specific PWM or ADC modules are not used their corresponding clocks can be switched off.

6.13.4 Analog-to-digital converter

The MSCSS in the LPC2930 includes three 10-bit successive-approximation analog-to-digital converters.

The key features of the ADC interface module are:

- ADC0: Eight analog inputs; time-multiplexed; measurement range up to 5.0 V.
- ADC1 and ADC2: Eight analog inputs; time-multiplexed; measurement range up to 3.3 V.
- External reference-level inputs.
- 400 ksamples per second at 10-bit resolution up to 1500 ksamples per second at 2-bit resolution.
- Programmable resolution from 2-bit to 10-bit.
- Single analog-to-digital conversion scan mode and continuous analog-to-digital conversion scan mode.
- Optional conversion on transition on external start input, timer capture/match signal, PWM_sync or 'previous' ADC.
- Converted digital values are stored in a register for each channel.
- Optional compare condition to generate a 'less than' or an 'equal to or greater than' compare-value indication for each channel.
- Power-down mode.

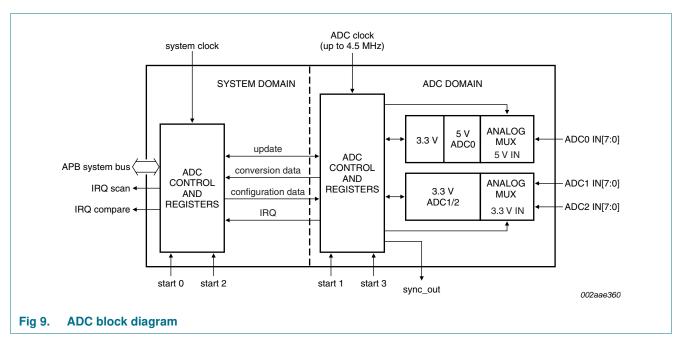
6.13.4.1 Functional description

The ADC block diagram, Figure 9, shows the basic architecture of each ADC. The ADC functionality is divided into two major parts; one part running on the MSCSS Subsystem clock, the other on the ADC clock. This split into two clock domains affects the behavior from a system-level perspective. The actual analog-to-digital conversions take place in the ADC clock domain, but system control takes place in the system clock domain.

A mechanism is provided to modify configuration of the ADC and control the moment at which the updated configuration is transferred to the ADC domain.

The ADC clock is limited to 4.5 MHz maximum frequency and should always be lower than or equal to the system clock frequency. To meet this constraint or to select the desired lower sampling frequency, the clock generation unit provides a programmable fractional system-clock divider dedicated to the ADC clock. Conversion rate is determined by the ADC clock frequency divided by the number of resolution bits plus one. Accessing ADC registers requires an enabled ADC clock, which is controllable via the clock generation unit, see Section 6.14.2.

Each ADC has four start inputs. Note that start 0 and start 2 are captured in the system clock domain while start 1 and start 3 are captured in the ADC domain. The start inputs are connected at MSCSS level, see Section 6.13 for details.



6.13.4.2 Pin description

The three ADC modules in the MSCSS have the pins described below. The ADCx input pins are combined with other functions on the port pins of the LPC2930. The VREFN and VREFP pins are common to all ADCs. <u>Table 22</u> shows the ADC pins.

Table 22. Analog to digital converter pins				
Symbol	Pin name	Direction	Description	
ADC0 IN[7:0]	IN0[7:0]	IN	analog input for 5.0 V ADC0, channel 7 to channel 0	
ADC1/2 IN[7:0]	IN1/2[7:0]	IN	analog input for 3.3 V ADC1/2, channel 7 to channel 0	
ADCn_EXTSTART	CAP1[n]	IN	ADC external start-trigger input (n is 0, 1, or 2)	
VREFN	VREFN	IN	ADC LOW reference level	
VREFP	VREFP	IN	ADC HIGH reference level	
V _{DDA} (ADC5V0)	V _{DDA(ADC5V0)} ^[1]	IN	5 V high-power supply and HIGH reference for ADC0. Connect to clean 5 V as HIGH reference. May also be connected to 3.3 V if 3.3 V measurement range for ADC0 is needed. ^{[2][3]}	
V _{DDA(ADC3V3)}	V _{DDA(ADC3V3)}	IN	ADC1 and ADC2 3.3 V supply (also used for ADC0). ^[3]	

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[1] VREFP, VREFN, V_{DDA(ADC3V3)} must be connected for the 5 V ADC0 to operate properly.

[2] The analog inputs of ADC0 are internally multiplied by a factor of 3.3 / 5. If V_{DDA(ADC5V0)} is connected to 3.3 V, the maximum digital result is $1024 \times 3.3 / 5$.

[3] $V_{DDA(ADC5V0)}$ and $V_{DDA(ADC3V3)}$ must be set as follows: $V_{DDA(ADC5V0)} = V_{DDA(ADC3V3)} \times 1.5$.

Remark: The following formula only applies to ADC0:

Voltage variations on VREFP (i.e. those that deviate from voltage variations on the V_{DDA(ADC5V5)} pin) are visible as variations in the measurement result. Equation 1 shows the formula used to determine the conversion result of an input voltage V_{IN} on ADC0:

$$\left(\frac{2}{3}\left(V_{IN} - \frac{1}{2}V_{DDA(ADC5V0)}\right) + \frac{1}{2}V_{DDA(ADC3V3)}\right) \times \frac{1024}{V_{VREFP} - V_{VREFN}}$$
(1)

Remark: Note that the ADC1 and ADC2 accept an input voltage up to of 3.6 V (see Table 33) on the ADC1/2 IN pins. If the ADC is not used, the pins are 5 V tolerant. The ADC0 pins are 5 V tolerant.

6.13.4.3 Clock description

The ADC modules are clocked from two different sources; CLK_MSCSS_ADCx_APB and CLK ADCx (x = 0, 1, or 2), see Section 6.6.2. Note that each ADC has its own CLK_ADCx and CLK_MSCSS_ADCx_APB branch clocks for power management. If an ADC is unused both its CLK MSCSS ADCx APB and CLK ADCx can be switched off.

The frequency of all the CLK MSCSS ADCx APB clocks is identical to CLK MSCSS APB since they are derived from the same base clock BASE MSCSS CLK. Likewise the frequency of all the CLK ADCx clocks is identical since they are derived from the same base clock BASE ADC CLK.

The register interface towards the system bus is clocked by CLK MSCSS ADCx APB. Control logic for the analog section of the ADC is clocked by CLK ADCx, see also Figure 9.

6.13.5 Pulse Width Modulator (PWM)

The MSCSS in the LPC2930 includes four PWM modules with the following features.

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- · Six pulse-width modulated output signals
- Double edge features (rising and falling edges programmed individually)
- Optional interrupt generation on match (each edge)
- Different operation modes: continuous or run-once
- 16-bit PWM counter and 16-bit prescale counter allow a large range of PWM periods
- A protective mode (TRAP) holding the output in a software-controllable state and with optional interrupt generation on a trap event
- Three capture registers and capture trigger pins with optional interrupt generation on a capture event
- Interrupt generation on match event, capture event, PWM counter overflow or trap event
- · A burst mode mixing the external carrier signal with internally generated PWM
- Programmable sync-delay output to trigger other PWM modules (master/slave behavior)

6.13.5.1 Functional description

The ability to provide flexible waveforms allows PWM blocks to be used in multiple applications; e.g. dimmer/lamp control and fan control. Pulse-width modulation is the preferred method for regulating power since no additional heat is generated, and it is energy-efficient when compared with linear-regulating voltage control networks.

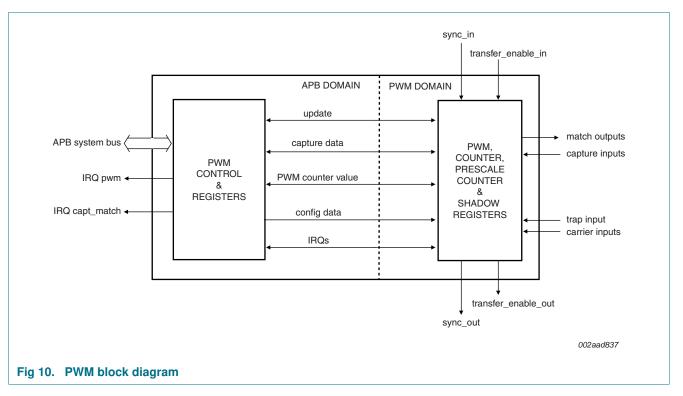
The PWM delivers the waveforms/pulses of the desired duty cycles and cycle periods. A very basic application of these pulses can be in controlling the amount of power transferred to a load. Since the duty cycle of the pulses can be controlled, the desired amount of power can be transferred for a controlled duration. Two examples of such applications are:

- Dimmer controller: The flexibility of providing waves of a desired duty cycle and cycle period allows the PWM to control the amount of power to be transferred to the load. The PWM functions as a dimmer controller in this application.
- Motor controller: The PWM provides multi-phase outputs, and these outputs can be controlled to have a certain pattern sequence. In this way the force/torque of the motor can be adjusted as desired. This makes the PWM function as a motor drive.

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The PWM block diagram in Figure 10 shows the basic architecture of each PWM. PWM functionality is split into two major parts, a APB domain and a PWM domain, both of which run on clocks derived from the BASE_MSCSS_CLK. This split into two domains affects behavior from a system-level perspective. The actual PWM and prescale counters are located in the PWM domain but system control takes place in the APB domain.

The actual PWM consists of two counters; a 16-bit prescale counter and a 16-bit PWM counter. The position of the rising and falling edges of the PWM outputs can be programmed individually. The prescale counter allows high system bus frequencies to be scaled down to lower PWM periods. Registers are available to capture the PWM counter values on external events.

Note that in the Modulation and Sampling SubSystem, each PWM has its individual clock source CLK_MSCSS_PWMx (x runs from 0 to 3). Both the prescale and the timer counters within each PWM run on this clock CLK_MSCSS_PWMx, and all time references are related to the period of this clock. See <u>Section 6.14</u> for information on generation of these clocks.

6.13.5.2 Synchronizing the PWM counters

A mechanism is included to synchronize the PWM period to other PWMs by providing a sync input and a sync output with programmable delay. Several PWMs can be synchronized using the trans_enable_in/trans_enable_out and sync_in/sync_out ports. See <u>Figure 8</u> for details of the connections of the PWM modules within the MSCSS in the LPC2930. PWM 0 can be master over PWM 1; PWM 1 can be master over PWM 2, etc.

6.13.5.3 Master and slave mode

A PWM module can provide synchronization signals to other modules (also called Master mode). The signal sync_out is a pulse of one clock cycle generated when the internal PWM counter (re)starts. The signal trans_enable_out is a pulse synchronous to sync_out, generated if a transfer from system registers to PWM shadow registers occurred when the PWM counter restarted. A delay may be inserted between the counter start and generation of trans_enable_out and sync_out.

A PWM module can use input signals trans_enable_in and sync_in to synchronize its internal PWM counter and the transfer of shadow registers (Slave mode).

6.13.5.4 Pin description

Each of the four PWM modules in the MSCSS has the following pins. These are combined with other functions on the port pins of the LPC2930. <u>Table 23</u> shows the PWM0 to PWM3 pins.

Symbol	Pin name	Direction	Description
PWMn CAP[0]	PCAPn[0]	IN	PWM n capture input 0
PWMn CAP[1]	PCAPn[1]	IN	PWM n capture input 1
PWMn CAP[2]	PCAPn[2]	IN	PWM n capture input 2
PWMn MAT[0]	PMATn[0]	OUT	PWM n match output 0
PWMn MAT[1]	PMATn[1]	OUT	PWM n match output 1
PWMn MAT[2]	PMATn[2]	OUT	PWM n match output 2
PWMn MAT[3]	PMATn[3]	OUT	PWM n match output 3
PWMn MAT[4]	PMATn[4]	OUT	PWM n match output 4
PWMn MAT[5]	PMATn[5]	OUT	PWM n match output 5
PWMn TRAP	TRAPn	IN	PWM n trap input

Table 23. PWM pins

6.13.5.5 Clock description

The PWM modules are clocked by CLK_MSCSS_PWMx (x = 0 to 3), see Section 6.6.2. Note that each PWM has its own CLK_MSCSS_PWMx branch clock for power management. The frequency of all these clocks is identical to CLK_MSCSS_APB since they are derived from the same base clock BASE_MSCSS_CLK.

Also note that unlike the timer modules in the Peripheral SubSystem, the actual timer counter registers of the PWM modules run at the same clock as the APB system interface CLK_MSCSS_APB. This clock is independent of the AHB system clock.

If a PWM module is not used its CLK_MSCSS_PWMx branch clock can be switched off.

6.13.6 Timers in the MSCSS

The two timers in the MSCSS are functionally identical to the timers in the peripheral subsystem, see <u>Section 6.11.3</u>. The features of the timers in the MSCSS are the same as the timers in the peripheral subsystem, but the capture inputs and match outputs are not available on the device pins. These signals are instead connected to the ADC and PWM modules as outlined in the description of the MSCSS, see <u>Section 6.13.1</u>.

See section <u>Section 6.11.3</u> for a functional description of the timers.

6.13.6.1 Pin description

MSCSS timer 0 has no external pins.

MSCSS timer 1 has a PAUSE pin available as external pin. The PAUSE pin is combined with other functions on the port pins of the LPC2930. <u>Table 24</u> shows the MSCSS timer 1 external pin.

Table 24.	MSCSS	timer 1	pin
			P

Symbol	Direction	Description
MSCSS PAUSE	IN	pause pin for MSCSS timer 1

6.13.6.2 Clock description

The Timer modules in the MSCSS are clocked by CLK_MSCSS_MTMRx (x = 0 to 1), see <u>Section 6.6.2</u>. Note that each timer has its own CLK_MSCSS_MTMRx branch clock for power management. The frequency of all these clocks is identical to CLK_MSCSS_APB since they are derived from the same base clock BASE_MSCSS_CLK.

Note that, unlike the timer modules in the Peripheral SubSystem, the actual timer counter registers run at the same clock as the APB system interface CLK_MSCSS_APB. This clock is independent of the AHB system clock.

If a timer module is not used its CLK_MSCSS_MTMRx branch clock can be switched off.

6.13.7 Quadrature Encoder Interface (QEI)

A quadrature encoder, also known as a 2-channel incremental encoder, converts angular displacement into two pulse signals. By monitoring both the number of pulses and the relative phase of the two signals, the user can track the position, direction of rotation, and velocity. In addition, a third channel, or index signal, can be used to reset the position counter. The quadrature encoder interface decodes the digital pulses from a quadrature encoder wheel to integrate position over time and determine direction of rotation. In addition, the QEI can capture the velocity of the encoder wheel.

The QEI has the following features:

- Tracks encoder position.
- Increments/ decrements depending on direction.
- Programmable for 2× or 4× position counting.
- Velocity capture using built-in timer.
- Velocity compare function with less than interrupt.
- · Uses 32-bit registers for position and velocity.
- Three position compare registers with interrupts.
- Index counter for revolution counting.
- Index compare register with interrupts.
- Can combine index and position interrupts to produce an interrupt for whole and partial revolution displacement.
- Digital filter with programmable delays for encoder input signals.
- Can accept decoded signal inputs (clk and direction).
- Connected to APB.

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6.13.7.1 Pin description

The QEI module in the MSCSS has the following pins. These are combined with other functions on the port pins of the LPC2930. <u>Table 25</u> shows the QEI pins.

Table 25. QEI pins			
Symbol	Pin name	Direction	Description
QEI0 IDX	IDX0	IN	Index signal. Can be used to reset the position.
QEI0 PHA	PHA0	IN	Sensor signal. Corresponds to PHA in quadrature mode and to direction in clock/direction mode.
QEI0 PHB	PHB0	IN	Sensor signal. Corresponds to PHB in quadrature mode and to clock signal in clock/direction mode.

6.13.7.2 Clock description

The QEI module is clocked by CLK_MSCSS_QEI, see <u>Section 6.6.2</u>. The frequency of this clock is identical to CLK_MSCSS_APB since they are derived from the same base clock BASE_MSCSS_CLK.

If the QEI is not used its CLK_MSCSS_QEI branch clock can be switched off.

6.14 Power, Clock and Reset Control SubSystem (PCRSS)

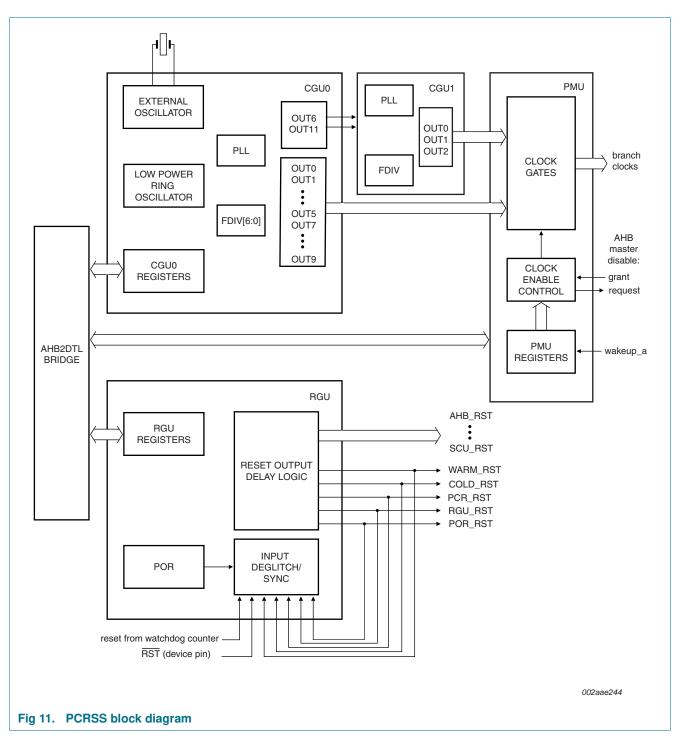
The Power, Clock and Reset Control Subsystem (PCRSS) in the LPC2930 includes a Clock Generator Unit (CGU), a Reset Generator Unit (RGU) and a Power Management Unit (PMU).

Figure 11 provides an overview of the PCRSS. An AHB-to-DTL bridge controls the communication with the AHB system bus.

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6.14.1 Clock description

The PCRSS is clocked by a number of different clocks. CLK_SYS_PCRSS clocks the AHB side of the AHB to DTL bus bridge and CLK_PCR_SLOW clocks the CGU, RGU and PMU internal logic, see <u>Section 6.6.2</u>. CLK_SYS_PCRSS is derived from BASE_SYS_CLK, which can be switched off in low-power modes. CLK_PCR_SLOW is derived from BASE_PCR_CLK and is always on in order to be able to wake up from low-power modes.

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6.14.2 Clock Generation Unit (CGU0)

The key features are:

- Generation of 9 base clocks, one test base clock, and two base clocks to drive CGU1, selectable from several embedded clock sources
- · Crystal oscillator with power-down
- Control PLL with power-down
- · Very low-power ring oscillator, always on to provide a safe clock
- Seven fractional clock dividers with L/D division
- · Individual source selector for each base clock, with glitch-free switching
- Autonomous clock-activity detection on every clock source
- · Protection against switching to invalid or inactive clock sources
- · Embedded frequency counter

Table 26. CGU0 base clocks

· Register write-protection mechanism to prevent unintentional alteration of clocks

Remark: Any clock-frequency adjustment has a direct impact on the timing of all on-board peripherals.

6.14.2.1 Functional description

The clock generation unit provides 10 internal clock sources as described in Table 26.

Number	Name	Frequency (MHz) [<u>1]</u>	Description
0	BASE_SAFE_CLK	0.4	base safe clock (always on)
1	BASE_SYS_CLK	125	base system clock
2	BASE_PCR_CLK	0.4 [2]	base PCR subsystem clock
3	BASE_IVNSS_CLK	125	base IVNSS subsystem clock
4	BASE_MSCSS_CLK	125	base MSCSS subsystem clock
5	BASE_ICLK0_CLK	125	base internal clock 0, for CGU1
6	BASE_UART_CLK	125	base UART clock
7	BASE_SPI_CLK	50	base SPI clock
8	BASE_TMR_CLK	125	base timers clock
9	BASE_ADC_CLK	4.5	base ADC clock
10	reserved	-	-
11	BASE_ICLK1_CLK	125	base internal clock 1, for CGU1

[1] Maximum frequency that guarantees stable operation of the LPC2930.

[2] Fixed to low-power oscillator.

For generation of these base clocks, the CGU consists of primary and secondary clock generators and one output generator for each base clock.

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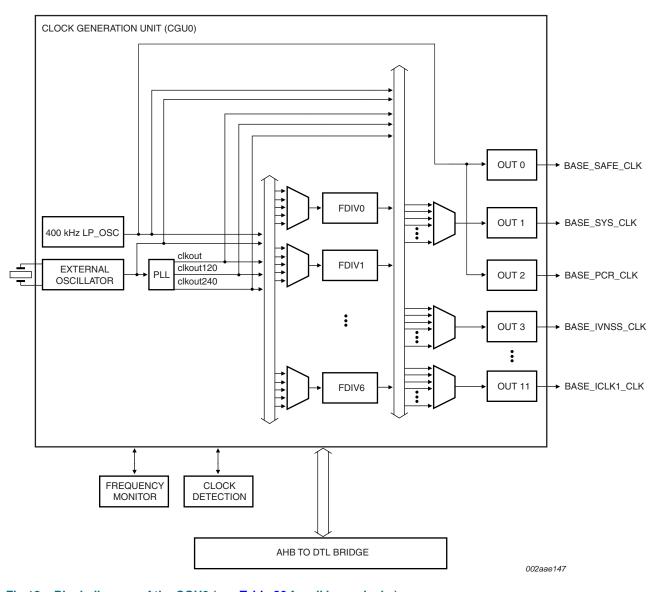


Fig 12. Block diagram of the CGU0 (see Table 26 for all base clocks)

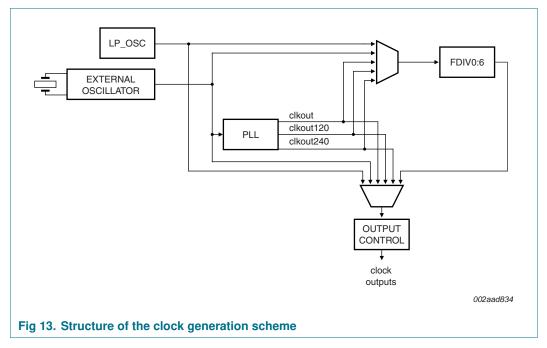
There are two primary clock generators: a low-power ring oscillator (LP_OSC) and a crystal oscillator. See Figure 12.

LP_OSC is the source for the BASE_PCR_CLK that clocks the CGU itself and for BASE_SAFE_CLK that clocks a minimum of other logic in the device (like the watchdog timer). To prevent the device from losing its clock source LP_OSC cannot be put into power-down. The crystal oscillator can be used as source for high-frequency clocks or as an external clock input if a crystal is not connected.

Secondary clock generators are a PLL and seven fractional dividers (FDIV0:6). The PLL has three clock outputs: normal, 120° phase-shifted and 240° phase-shifted.

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Configuration of the CGU0: For every output generator generating the base clocks a choice can be made from the primary and secondary clock generators according to Figure 13.



Any output generator (except for BASE_SAFE_CLK and BASE_PCR_CLK) can be connected to either a fractional divider (FDIV0:6) or to one of the outputs of the PLL or to LP_OSC/crystal oscillator directly. BASE_SAFE_CLK and BASE_PCR_CLK can use only LP_OSC as source.

The fractional dividers can be connected to one of the outputs of the PLL or directly to LP_OSC/crystal Oscillator.

The PLL is connected to the crystal oscillator.

In this way every output generating the base clocks can be configured to get the required clock. Multiple output generators can be connected to the same primary or secondary clock source, and multiple secondary clock sources can be connected to the same PLL output or primary clock source.

Invalid selections/programming - connecting the PLL to an FDIV or to one of the PLL outputs itself for example - will be blocked by hardware. The control register will not be written, the previous value will be kept, although all other fields will be written with new data. This prevents clocks being blocked by incorrect programming.

Default Clock Sources: Every secondary clock generator or output generator is connected to LP_OSC at reset. In this way the device runs at a low frequency after reset. It is recommended to switch BASE_SYS_CLK to a high-frequency clock generator as (one of) the first step(s) in the boot code after verifying that the high-frequency clock generator is running.

Clock Activity Detection: Clocks that are inactive are automatically regarded as invalid, and values of 'CLK_SEL' that would select those clocks are masked and not written to the control registers. This is accomplished by adding a clock detector to every clock

generator. The RDET register keeps track of which clocks are active and inactive, and the appropriate 'CLK SEL' values are masked and unmasked accordingly. Each clock detector can also generate interrupts at clock activation and deactivation so that the system can be notified of a change in internal clock status.

Clock detection is done using a counter running at the BASE PCR CLK frequency. If no positive clock edge occurs before the counter has 32 cycles of BASE PCR CLK the clock is assumed to be inactive. As BASE_PCR_CLK is slower than any of the clocks to be detected, normally only one BASE PCR CLK cycle is needed to detect activity. After reset all clocks are assumed to be 'non-present', so the RDET status register will be correct only after 32 BASE PCR CLK cycles.

Note that this mechanism cannot protect against a currently-selected clock going from active to inactive state. Therefore an inactive clock may still be sent to the system under special circumstances, although an interrupt can still be generated to notify the system.

Glitch-Free Switching: Provisions are included in the CGU to allow clocks to be switched glitch-free, both at the output generator stage and also at secondary source generators.

In the case of the PLL the clock will be stopped and held low for long enough to allow the PLL to stabilize and lock before being re-enabled. For all non-PLL Generators the switch will occur as quickly as possible, although there will always be a period when the clock is held low due to synchronization requirements.

If the current clock is high and does not go low within 32 cycles of BASE PCR CLK it is assumed to be inactive and is asynchronously forced low. This prevents deadlocks on the interface.

6.14.2.2 PLL functional description

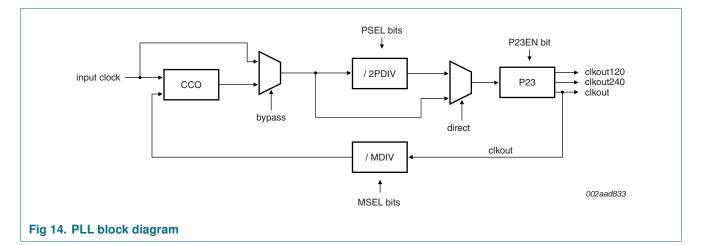
A block diagram of the PLL is shown in Figure 14. The input clock is fed directly to the analog section. This block compares the phase and frequency of the inputs and generates the main clock². These clocks are either divided by $2 \times P$ by the programmable post divider to create the output clock, or sent directly to the output. The main output clock is then divided by M by the programmable feedback divider to generate the feedback clock. The output signal of the analog section is also monitored by the lock detector to signal when the PLL has locked onto the input clock.

^{2.} Generation of the main clock is restricted by the frequency range of the PLL clock input. See Table 35, Dynamic characteristics.

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Triple output phases: For applications that require multiple clock phases two additional clock outputs can be enabled by setting register P23EN to logic 1, thus giving three clocks with a 120° phase difference. In this mode all three clocks generated by the analog section are sent to the output dividers. When the PLL has not yet achieved lock the second and third phase output dividers run unsynchronized, which means that the phase relation of the output clocks is unknown. When the PLL LOCK register is set the second and third phase of the output dividers are synchronized to the main output clock CLKOUT PLL, thus giving three clocks with a 120° phase difference.

Direct output mode: In normal operating mode (with DIRECT set to logic 0) the CCO clock is divided by 2, 4, 8 or 16 depending on the value on the PSEL[1:0] input, giving an output clock with a 50 % duty cycle. If a higher output frequency is needed the CCO clock can be sent directly to the output by setting DIRECT to logic 1. Since the CCO does not directly generate a 50 % duty cycle clock, the output clock duty cycle in this mode can deviate from 50 %.

Power-down control: A Power-down mode has been incorporated to reduce power consumption when the PLL clock is not needed. This is enabled by setting the PD control register bit. In this mode the analog section of the PLL is turned off, the oscillator and the phase-frequency detector are stopped and the dividers enter a reset state. While in Power-down mode the LOCK output is low, indicating that the PLL is not in lock. When Power-down mode is terminated by clearing the PD control-register bit the PLL resumes normal operation, and makes the LOCK signal high once it has regained lock on the input clock.

6.14.2.3 Pin description

The CGU0 module in the LPC2930 has the pins listed in Table 27 below.

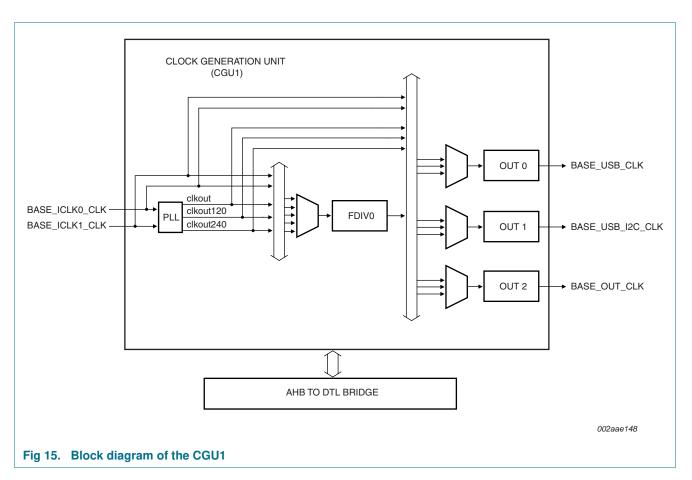
Table 27. CGU0 pins				
Symbol	Direction	Description		
XOUT_OSC	OUT	Oscillator crystal output		
XIN_OSC	IN	Oscillator crystal input or external clock input		

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6.14.3 Clock generation for USB (CGU1)

The CGU1 block is functionally identical to the CGU0 block and generates two clocks for the USB interface and a dedicated output clock. The CGU1 block uses its own PLL and fractional divider. The PLLs used in CGU0 and CGU1 are identical (see Section 6.14.2.2).

The clock input to the CGU1 PLL is provided by one of two base clocks generated in the CGU0: BASE_ICLK0_CLK or BASE_ICLK1_CLK. The base clock not used for the PLL can be configured to drive the output clock directly.



6.14.3.1 Pin description

The CGU1 module in the LPC2930 has the pins listed in Table 27 below.

Table 28. CGU1 pins			
Symbol	Direction	Description	
CLK_OUT	OUT	clock output	

6.14.4 Reset Generation Unit (RGU)

The RGU controls all internal resets.

The key features of the Reset Generation Unit (RGU) are:

· Reset controlled individually per subsystem

- · Automatic reset stretching and release
- · Monitor function to trace resets back to source
- Register write-protection mechanism to prevent unintentional resets

6.14.4.1 Functional description

Each reset output is defined as a combination of reset input sources including the external reset input pins and internal power-on reset, see <u>Table 29</u>. The first five resets listed in this table form a sort of cascade to provide the multiple levels of impact that a reset may have. The combined input sources are logically OR-ed together so that activating any of the listed reset sources causes the output to go active.

Reset output	Reset source	Parts of the device reset when activated		
POR_RST	power-on reset module	LP_OSC; source for RGU_RST		
RGU_RST	POR_RST, RST pin	RGU internal; source for PCR_RST		
PCR_RST	RGU_RST, WATCHDOG	PCR internal; source for COLD_RST		
COLD_RST	PCR_RST	parts with COLD_RST as reset source below		
WARM_RST	COLD_RST	parts with WARM_RST as reset source below		
SCU_RST	COLD_RST	SCU		
CFID_RST	COLD_RST	CFID		
EMC_RST	COLD_RST	embedded SRAM-Memory Controller		
SMC_RST	COLD_RST	external Static-Memory Controller (SMC)		
GESS_A2V_RST	WARM_RST	GeSS AHB-to-APB bridge		
PESS_A2V_RST	WARM_RST	PeSS AHB-to-APB bridge		
GPIO_RST	WARM_RST	all GPIO modules		
UART_RST	WARM_RST	all UART modules		
TMR_RST	WARM_RST	all Timer modules in PeSS		
SPI_RST	WARM_RST	all SPI modules		
IVNSS_A2V_RST	WARM_RST	IVNSS AHB-to-APB bridge		
IVNSS_CAN_RST	WARM_RST	all CAN modules including Acceptance filter		
IVNSS_LIN_RST	WARM_RST	all LIN modules		
MSCSS_A2V_RST	WARM_RST	MSCSS AHB to APB bridge		
MSCSS_PWM_RST	WARM_RST	all PWM modules		
MSCSS_ADC_RST	WARM_RST	all ADC modules		
MSCSS_TMR_RST	WARM_RST	all Timer modules in MSCSS		
I2C_RST	WARM_RST	all I ² C modules		
QEI_RST	WARM_RST	Quadrature encoder		
DMA_RST	WARM_RST	GPDMA controller		
USB_RST	WARM_RST	USB controller		
VIC_RST	WARM_RST	Vectored Interrupt Controller (VIC)		
AHB_RST	WARM_RST	CPU and AHB Bus infrastructure		

Table 29. Reset output configuration

6.14.4.2 Pin description

The RGU module in the LPC2930 has the following pins. <u>Table 30</u> shows the RGU pins.

Table 30.	RGU	pins
Table 50.	nau	pilla

Symbol	Direction	Description
RST	IN	external reset input, Active LOW; pulled up internally

6.14.5 Power Management Unit (PMU)

This module enables software to actively control the system's power consumption by disabling clocks not required in a particular operating mode.

Using the base clocks from the CGU as input, the PMU generates branch clocks to the rest of the LPC2930. Output clocks branched from the same base clock are phase- and frequency-related. These branch clocks can be individually controlled by software programming.

The key features are:

- Individual clock control for all LPC2930 sub-modules
- · Activates sleeping clocks when a wake-up event is detected
- · Clocks can be individually disabled by software
- · Supports AHB master-disable protocol when AUTO mode is set
- · Disables wake-up of enabled clocks when Power-down mode is set
- · Activates wake-up of enabled clocks when a wake-up event is received
- Status register is available to indicate if an input base clock can be safely switched off (i.e. all branch clocks are disabled)

6.14.5.1 Functional description

The PMU controls all internal clocks coming out of the CGU0 for power-mode management. With some exceptions, each branch clock can be switched on or off individually under control of software register bits located in its individual configuration register. Some branch clocks controlling vital parts of the device operate in a fixed mode. Table 31 shows which mode control bits are supported by each branch clock.

By programming the configuration register the user can control which clocks are switched on or off, and which clocks are switched off when entering Power-down mode.

Note that the standby-wait-for-interrupt instructions of the ARM968E-S processor (putting the ARM CPU into a low-power state) are not supported. Instead putting the ARM CPU into power-down should be controlled by disabling the branch clock for the CPU.

Remark: For any disabled branch clocks to be re-activated their corresponding base clocks must be running (controlled by the CGU0).

Table 31 shows the relation between branch and base clocks, see also <u>Section 6.6.1</u>. Every branch clock is related to one particular base clock: it is not possible to switch the source of a branch clock in the PMU.

Table 31. Branch clock overview

Legend:

'1' Indicates that the related register bit is tied off to logic HIGH, all writes are ignored '0' Indicates that the related register bit is tied off to logic LOW, all writes are ignored '+' Indicates that the related register bit is readable and writable

Branch clock name Base clock Implemented mechanism		switch on/off		
		WAKE-UP	AUTO	RUN
CLK_SAFE	BASE_SAFE_CLK	0	0	1
CLK_SYS_CPU	BASE_SYS_CLK	+	+	1
CLK_SYS	BASE_SYS_CLK	+	+	1
CLK_SYS_PCR	BASE_SYS_CLK	+	+	1
CLK_SYS_FMC	BASE_SYS_CLK	+	+	+
CLK_SYS_RAM0	BASE_SYS_CLK	+	+	+
CLK_SYS_RAM1	BASE_SYS_CLK	+	+	+
CLK_SYS_SMC	BASE_SYS_CLK	+	+	+
CLK_SYS_GESS	BASE_SYS_CLK	+	+	+
CLK_SYS_VIC	BASE_SYS_CLK	+	+	+
CLK_SYS_PESS	BASE_SYS_CLK	+	+	+
CLK_SYS_GPIO0	BASE_SYS_CLK	+	+	+
CLK_SYS_GPIO1	BASE_SYS_CLK	+	+	+
CLK_SYS_GPIO2	BASE_SYS_CLK	+	+	+
CLK_SYS_GPIO3	BASE_SYS_CLK	+	+	+
CLK_SYS_GPIO4	BASE_SYS_CLK	+	+	+
CLK_SYS_GPIO5	BASE_SYS_CLK	+	+	+
CLK_SYS_IVNSS_A	BASE_SYS_CLK	+	+	+
CLK_SYS_MSCSS_A	BASE_SYS_CLK	+	+	+
CLK_SYS_DMA	BASE_SYS_CLK	+	+	+
CLK_SYS_USB	BASE_SYS_CLK	+	+	+
CLK_PCR_SLOW	BASE_PCR_CLK	+	+	1
CLK_IVNSS_APB	BASE_IVNSS_CLK	+	+	+
CLK_IVNSS_CANC0	BASE_IVNSS_CLK	+	+	+
CLK_IVNSS_CANC1	BASE_IVNSS_CLK	+	+	+
CLK_IVNSS_I2C0	BASE_IVNSS_CLK	+	+	+
CLK_IVNSS_I2C1	BASE_IVNSS_CLK	+	+	+
CLK_IVNSS_LIN0	BASE_IVNSS_CLK	+	+	+
CLK_IVNSS_LIN1	BASE_IVNSS_CLK	+	+	+
CLK_MSCSS_APB	BASE_MSCSS_CLK	+	+	+
CLK_MSCSS_MTMR0	BASE_MSCSS_CLK	+	+	+
CLK_MSCSS_MTMR1	BASE_MSCSS_CLK	+	+	+
CLK_MSCSS_PWM0	BASE_MSCSS_CLK	+	+	+
CLK_MSCSS_PWM1	BASE_MSCSS_CLK	+	+	+
CLK_MSCSS_PWM2	BASE_MSCSS_CLK	+	+	+
CLK_MSCSS_PWM3	BASE_MSCSS_CLK	+	+	+

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Table 31. Branch clock overview ...continued

Legend:

'1' Indicates that the related register bit is tied off to logic HIGH, all writes are ignored '0' Indicates that the related register bit is tied off to logic LOW, all writes are ignored '+' Indicates that the related register bit is readable and writable

Branch clock name	Base clock	Implemented switch on/off mechanism		F
		WAKE-UP	AUTO	RUN
CLK_MSCSS_ADC0_APB	BASE_MSCSS_CLK	+	+	+
CLK_MSCSS_ADC1_APB	BASE_MSCSS_CLK	+	+	+
CLK_MSCSS_ADC2_APB	BASE_MSCSS_CLK	+	+	+
CLK_MSCSS_QEI	BASE_MSCSS_CLK	+	+	+
CLK_OUT_CLK	BASE_OUT_CLK	+	+	+
CLK_UART0	BASE_UART_CLK	+	+	+
CLK_UART1	BASE_UART_CLK	+	+	+
CLK_SPI0	BASE_SPI_CLK	+	+	+
CLK_SPI1	BASE_SPI_CLK	+	+	+
CLK_SPI2	BASE_SPI_CLK	+	+	+
CLK_TMR0	BASE_TMR_CLK	+	+	+
CLK_TMR1	BASE_TMR_CLK	+	+	+
CLK_TMR2	BASE_TMR_CLK	+	+	+
CLK_TMR3	BASE_TMR_CLK	+	+	+
CLK_ADC0	BASE_ADC_CLK	+	+	+
CLK_ADC1	BASE_ADC_CLK	+	+	+
CLK_ADC2	BASE_ADC_CLK	+	+	+
CLK_USB_I2C	BASE_USB_I2C_CLK	+	+	+
CLK_USB	BASE_USB_CLK	+	+	+

6.15 Vectored interrupt controller

The LPC2930 contains a very flexible and powerful Vectored Interrupt Controller (VIC) to interrupt the ARM processor on request.

The key features are:

- Level-active interrupt request with programmable polarity.
- 56 interrupt request inputs.
- · Software interrupt request capability associated with each request input.
- Interrupt request state can be observed before masking.
- Software-programmable priority assignments to interrupt requests up to 15 levels.
- Software-programmable routing of interrupt requests towards the ARM-processor inputs IRQ and FIQ.
- Fast identification of interrupt requests through vector.
- Support for nesting of interrupt service routines.

6.15.1 Functional description

The Vectored Interrupt Controller routes incoming interrupt requests to the ARM processor. The interrupt target is configured for each interrupt request input of the VIC. The targets are defined as follows:

- Target 0 is ARM processor FIQ (fast interrupt service).
- Target 1 is ARM processor IRQ (standard interrupt service).

Interrupt-request masking is performed individually per interrupt target by comparing the priority level assigned to a specific interrupt request with a target-specific priority threshold. The priority levels are defined as follows:

- Priority level 0 corresponds to 'masked' (i.e. interrupt requests with priority 0 never lead to an interrupt).
- Priority 1 corresponds to the lowest priority.
- Priority 15 corresponds to the highest priority.

Software interrupt support is provided and can be supplied for:

- Testing RTOS (Real-Time Operating System) interrupt handling without using device-specific interrupt service routines
- · Software emulation of an interrupt-requesting device, including interrupts

6.15.2 Clock description

The VIC is clocked by CLK_SYS_VIC, see Section 6.6.2.

7. Limiting values

Table 32. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
Supply pins						
P _{tot}	total power dissipation		[1]	-	1.5	W
V _{DD(CORE)}	core supply voltage			-0.5	+2.0	V
$V_{DD(OSC_PLL)}$	oscillator and PLL supply voltage			-0.5	+2.0	V
V _{DDA(ADC3V3)}	3.3 V ADC analog supply voltage			-0.5	+4.6	V
V _{DDA(ADC5V0)}	5.0 V ADC analog supply voltage			-0.5	+6.0	V
V _{DD(IO)}	input/output supply voltage			-0.5	+4.6	V
I _{DD}	supply current	average value per supply pin	[2]	-	98	mA
I _{SS}	ground current	average value per ground pin	[2]	-	98	mA
Input pins an	d I/O pins					
V _{XIN_OSC}	voltage on pin XIN_OSC			-0.5	+2.0	V
V _{I(IO)}	I/O input voltage		[3][4][6]	-0.5	$V_{DD(IO)} + 3.0$	V
V _{I(ADC)}	ADC input voltage	for ADC1/2: I/O port 0 pin 8 to pin 23.	<u>[4][6]</u>	-0.5	V _{DDA(ADC3V3)} + 0.5	V
		for ADC0: I/O port 0 pin 5 to pin 7; I/O port 2 pins 12 and 13; I/O port 3 pins 0 and 1.	[7][4][5][6]	-0.5	V _{DDA(ADC5V0)} + 0.5	V
V _{VREFP}	voltage on pin VREFP			-0.5	+3.6	V
V _{VREFN}	voltage on pin VREFN			-0.5	+3.6	V
I _(ADC)	ADC input current	average value per input pin	[2]	-	35	mA
Output pins a	nd I/O pins configured as ou	ıtput				
l _{онs}	HIGH-level short-circuit output current	drive HIGH, output shorted to $V_{SS(IO)}$	<u>[8]</u>	-	-33	mA
I _{OLS}	LOW-level short-circuit output current	drive LOW, output shorted to VDD(IO)	<u>[8]</u>	-	+38	mA
General						
T _{stg}	storage temperature			-65	+150	°C
T _{amb}	ambient temperature			-40	+85	°C

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Symbol Conditions Parameter Min Max Unit **ESD** electrostatic discharge on all pins VESD voltage human body model 9 -2000 +2000 ۷ charged device model -500 +500 V on corner pins charged device model -750 +750 ٧

Table 32. Limiting values ... continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

[1] Based on package heat transfer, not device power consumption.

[2] Peak current must be limited at 25 times average current.

For I/O Port 0, the maximum input voltage is defined by $V_{I(ADC)}$. [3]

[4] Only when $V_{DD(IO)}$ is present.

Not exceeding 6 V. [5]

[6] Note that pull-up should be off. With pull-up do not exceed 3.6 V.

For these input pins a fixed amplification of 2_3 is performed on the input voltage before feeding into the ADC0 itself. The maximum input [7] voltage on ADC0 is V_{VDDA(ADC5V0)}.

[8] 112 mA per V_{DD(IO)} or V_{SS(IO)} should not be exceeded.

Human-body model: discharging a 100 pF capacitor via a 10 k Ω series resistor. [9]

Static characteristics 8.

Table 33. Static characteristics

 $V_{DD(CORE)} = V_{DD(OSC_PLL)}$; $V_{DD(IO)} = 2.7$ V to 3.6 V; $V_{DDA(ADC3V3)} = 3.0$ V to 3.6 V; $V_{DDA(ADC5V0)} = 3.0$ V to 5.5 V; $T_{vj} = -40$ °C to +85 °C; all voltages are measured with respect to ground; positive currents flow into the IC; unless otherwise specified.^[1]

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Supplies							
Core supply							
V _{DD(CORE)}	core supply voltage			1.71	1.80	1.89	V
I _{DD(CORE)}	core supply current	Device state after reset; system clock at 125 MHz; T _{amb} = 85 °C; executing code while(1) {} from external memory.	[2]		75	-	mA
		all clocks off	[3]	-	30	475	μA
I/O supply							
V _{DD(IO)}	input/output supply voltage			2.7	-	3.6	V
I _{DD(IO)}	I/O supply current	Power-down mode		-	0.5	3.25	μA
Oscillator/PLL	supply						
V _{DD(OSC_PLL)}	oscillator and PLL supply voltage			1.71	1.80	1.89	V
IDD(OSC_PLL)	oscillator and PLL supply	Normal mode		-	-	1	mA
	current	Power-down mode		-	-	2	μA
Analog-to-digi	ital converter supply						
V _{DDA(ADC3V3)}	3.3 V ADC analog supply voltage			3.0	3.3	3.6	V
V _{DDA(ADC5V0)}	5.0 V ADC analog supply voltage.			3.0	5.0	5.5	V
IDDA(ADC3V3)	3.3 V ADC analog supply	Normal mode	[4]	-	-	1.9	mA
	current	Power-down mode		-	-	4	μA
IDDA(ADC5V0)	5.0 V ADC analog supply	Normal mode	[5]	-	-	1	mA
	current.	Power-down mode		-	-	1	μA
Input pins an	d I/O pins configured as i	nput					
VI	input voltage	all port pins and $V_{\text{DD}(\text{IO})}$ applied	<u>[6][7]</u>	-0.5	-	+ 5.5	V
		see Section 7					
		port 0 pins 8 to 23 when ADC1/2 is used	<u>[7]</u>	-	-	V_{VREFP}	
		all port pins and $V_{\text{DD}(\text{IO})}$ not applied		-0.5	-	+3.6	V
		all other I/O pins, RST , TRST, TDI, JTAGSEL, TMS, TCK		-0.5	-	V _{DD(IO)}	V

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Table 33. Static characteristics ...continued

 $V_{DD(CORE)} = V_{DD(OSC_PLL)}$; $V_{DD(IO)} = 2.7$ V to 3.6 V; $V_{DDA(ADC3V3)} = 3.0$ V to 3.6 V; $V_{DDA(ADC5V0)} = 3.0$ V to 5.5 V; $T_{vj} = -40$ °C to +85 °C; all voltages are measured with respect to ground; positive currents flow into the IC; unless otherwise specified.^[1]

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{IH}	HIGH-level input voltage	all port pins, RST , TRST, TDI, JTAGSEL, TMS, TCK	2.0	-	-	V
V _{IL}	LOW-level input voltage	all port pins, <u>RST, TRST,</u> TDI, JTAGSEL, TMS, TCK	-	-	0.8	V
V _{hys}	hysteresis voltage		0.4	-	-	V
I _{LIH}	HIGH-level input leakage current		-	-	1	μA
ILIL	LOW-level input leakage current		-	-	1	μA
I _{I(pd)}	pull-down input current	all port pins, $V_1 = 3.3 V$; $V_1 = 5.5 V$; see <u>Figure 23</u>	25	50	100	μA
I _{I(pu)}	pull-up input current	all port pins, \overline{RST} , \overline{TRST} , TDI, JTAGSEL, TMS: V ₁ = 0 V; V ₁ > 3.6 V is not allowed; see <u>Figure 24</u>	-25	-50	–115	μΑ
Ci	input capacitance		<u>[8]</u> _	3	8	pF
Output pin	s and I/O pins configured as	output				
Vo	output voltage		0	-	V _{DD(IO)}	V
V _{OH}	HIGH-level output voltage	I _{OH} = −4 mA; see <u>Figure 22</u>	$V_{DD(IO)}$ –0	.4 -	-	V
V _{OL}	LOW-level output voltage	I _{OL} = 4 mA; see <u>Figure 21</u>	-	-	0.4	V
CL	load capacitance		-	-	25	pF
USB pins L	JSB_D+ and USB_D-					
Input charac	cteristics					
V _{IH}	HIGH-level input voltage		1.5	-	-	V
V _{IL}	LOW-level input voltage		-	-	1.3	V
V _{hys}	hysteresis voltage		0.4	-	-	V
Output char	acteristics					
Zo	output impedance	with 33 Ω series resistor	36.0	-	44.1	Ω
V _{OH}	HIGH-level output voltage	(driven) for low-/full-speed; R_L of 15 k Ω to GND	2.9	-	3.5	V
V _{OL}	LOW-level output voltage	(driven) for low-/full-speed; with 1.5 k Ω resistor to 3.6 V external pull-up	-	-	0.18	V

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Table 33. Static characteristics ... continued

 $V_{DD(CORE)} = V_{DD(OSC_PLL)}$; $V_{DD(IO)} = 2.7 \text{ V to } 3.6 \text{ V}$; $V_{DDA(ADC3V3)} = 3.0 \text{ V to } 3.6 \text{ V}$; $V_{DDA(ADC5V0)} = 3.0 \text{ V to } 5.5 \text{ V}$; $T_{vj} = -40 \text{ °C to } +85 \text{ °C}$; all voltages are measured with respect to ground; positive currents flow into the IC; unless otherwise specified.^[1]

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{OH}	HIGH-level output current	at $V_{OH} = V_{DD(IO)} - 0.3 V$; without 33 Ω external series resistor		20.8	-	41.7	mA
		at $V_{OH} = V_{DD(IO)} - 0.3 V$; with 33 Ω external series resistor		4.8	-	5.3	mA
I _{OL}	LOW-level output current	at $V_{OL} = 0.3 V$; without 33 Ω external series resistor		26.7	-	57.2	mA
		at V _{OL} = 0.3 V; with 33 Ω external series resistor		5.0	-	5.5	mA
I _{OHS}	HIGH-level short-circuit output current	drive high; pad connected to ground		-	-	90.0	mA
I _{OLS}	LOW-level short-circuit output current	drive high; pad connected to $V_{\text{DD}(IO)}$		-	-	95.1	mA
Oscillator							
V _{XIN_OSC}	voltage on pin XIN_OSC			0	-	1.8	V
R _{s(xtal)}	crystal series resistance	$f_{osc} = 10 \text{ MHz} \text{ to } 15 \text{ MHz}$	[9]				
		$C_{xtal} = 10 \text{ pF};$ $C_{ext} = 18 \text{ pF}$		-	-	160	Ω
		$C_{xtal} = 20 \text{ pF};$ $C_{ext} = 39 \text{ pF}$		-	-	60	Ω
		$f_{osc} = 15 \text{ MHz} \text{ to } 20 \text{ MHz}$	<u>[9]</u>				
		$C_{xtal} = 10 \text{ pF};$ $C_{ext} = 18 \text{ pF}$		-	-	80	Ω
Ci	input capacitance	of XIN_OSC	[10]	-	-	2	pF
Power-up re	eset						
V _{trip(high)}	high trip level voltage		[11]	1.1	1.4	1.6	V
V _{trip(low)}	low trip level voltage		[11]	1.0	1.3	1.5	V
V _{trip(dif)}	difference between high and low trip level voltage		[11]	50	120	180	mV

[1] All parameters are guaranteed over the virtual junction temperature range by design. Pre-testing is performed at T_{amb} = 85 °C on wafer level. Cased products are tested at T_{amb} = 25 °C (final testing). Both pre-testing and final testing use correlated test conditions to cover the specified temperature and power-supply voltage range.

[2] The Boot ROM can be powered down by setting the FS_PD bit in the FCTR register for additional power savings in active mode (see *LPC29xx user manual UM10316*).

[3] Leakage current is exponential to temperature; worst-case value is at 85 °C T_{vj}. All clocks off. Analog modules powered down.

[4] $V_{DDA(ADC3V3)}$ must correlate with $V_{DDA(ADC5V0)}$: $V_{DDA(ADC3V3)} = V_{DDA(ADC5V0)} / 1.5$.

[5] $V_{DDA(ADC5V0)}$ must correlate with $V_{DDA(ADC3V3)}$: $V_{DDA(ADC5V0)} = V_{DDA(ADC3V3)} \times 1.5$.

[6] Not 5 V-tolerant when pull-up is on.

[7] For I/O Port 0, the maximum input voltage is defined by V_{I(ADC)}.

[8] For Port 0, pin 0 to pin 15 add maximum 1.5 pF for input capacitance to ADC. For Port 0, pin 16 to pin 31 add maximum 1.0 pF for input capacitance to ADC.

 $\label{eq:cxtal} [9] \quad C_{xtal} \text{ is crystal load capacitance and } C_{ext} \text{ are the two external load capacitors.}$

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- [10] This parameter is not part of production testing or final testing, hence only a typical value is stated. Maximum and minimum values are based on simulation results.
- [11] The power-up reset has a time filter: $V_{DD(CORE)}$ must be above $V_{trip(high)}$ for 2 μ s before reset is de-asserted; $V_{DD(CORE)}$ must be below $V_{trip(low)}$ for 11 μ s before internal reset is asserted.

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$V_{DDA(ADC3V3)} = 3.0$ V to 3.6 V; $T_{amb} = -40$ °C to +85 °C unless otherwise specified; ADC frequency 4.5 MHz.								
Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
V _{VREFN}	voltage on pin VREFN			0	-	$V_{VREFP}-2$	V	
V _{VREFP}	voltage on pin VREFP			$V_{VREFN} + 2$	-	V _{DDA(ADC3V3)}	V	
V _{IA}	analog input voltage	for 3.3 V ADC1/2		V _{VREFN}	-	V _{VREFP}	V	
Z _i	input impedance	between V _{VREFN} and V _{VREFP}		4.4	-	-	kΩ	
		between V_{VREFN} and $V_{DDA(ADC5V0)}$		13.7	-	23.6	kΩ	
C _{ia}	analog input capacitance	for ADC0/1/2		-	-	1	pF	
E _D	differential linearity error	for ADC0/1/2	<u>[1][2][3]</u>	-	-	±1	LSB	
E _{L(adj)}	integral non-linearity	for ADC0/1/2	<u>[1][4]</u>	-	-	±2	LSB	
E _O	offset error	for ADC0/1/2	[1][5]	-	-	±3	LSB	
E _G	gain error	for ADC0/1/2	[1][6]	-	-	±0.5	%	
E _T	absolute error	for ADC0/1/2	<u>[1][7]</u>	-	-	±4	LSB	
R _{vsi}	voltage source interface resistance	for ADC0/1/2	<u>[8]</u>	-	-	40	kΩ	
FSR	full scale range	for ADC0/1/2		2	-	10	bit	

Table 34. ADC static characteristics

[1] Conditions: $V_{SS(IO)} = 0 V$, $V_{DDA(ADC3V3)} = 3.3 V$.

The ADC is monotonic, there are no missing codes. [2]

[3] The differential linearity error (E_D) is the difference between the actual step width and the ideal step width. See Figure 17.

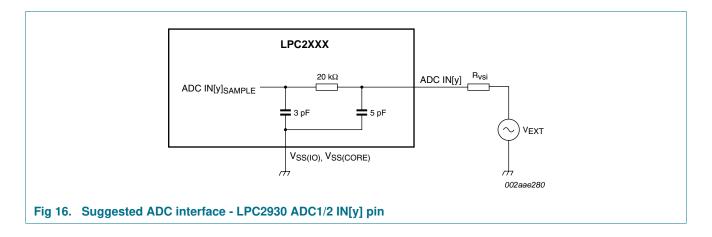
[4] The integral non-linearity (E_{L(adj)}) is the peak difference between the center of the steps of the actual and the ideal transfer curve after appropriate adjustment of gain and offset errors. See Figure 17.

The offset error (E_O) is the absolute difference between the straight line which fits the actual curve and the straight line which fits the [5] ideal curve. See Figure 17.

The gain error (E_G) is the relative difference in percent between the straight line fitting the actual transfer curve after removing offset [6] error, and the straight line which fits the ideal transfer curve. See Figure 17.

[7] The absolute error (E_T) is the maximum difference between the center of the steps of the actual transfer curve of the non-calibrated ADC and the ideal transfer curve. See Figure 17.

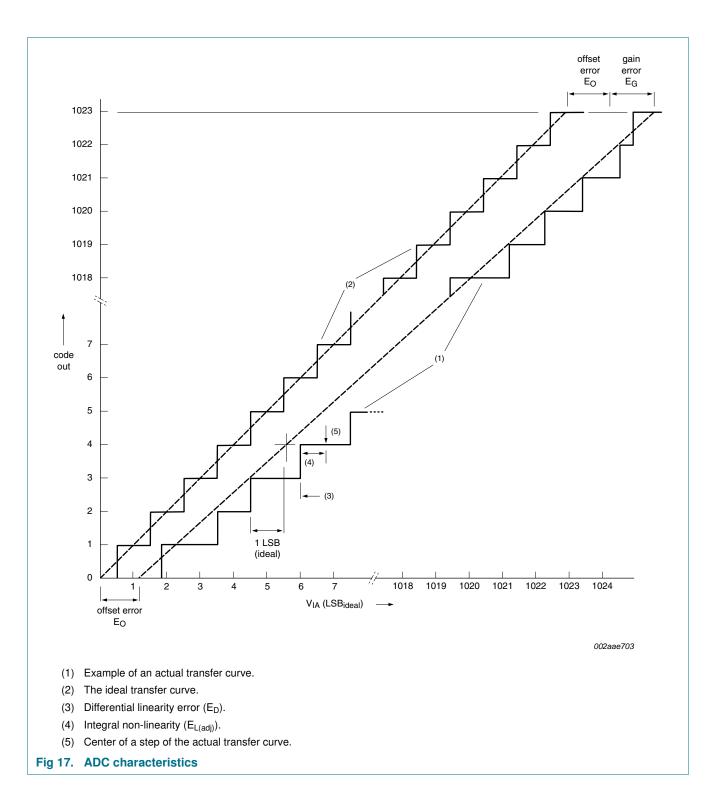
See Figure 16. [8]



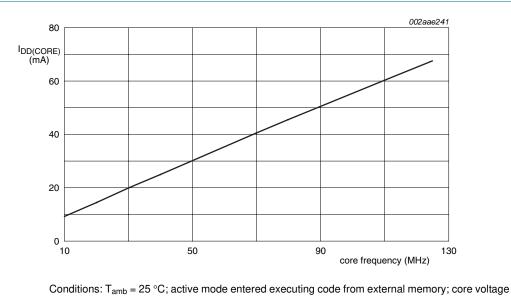
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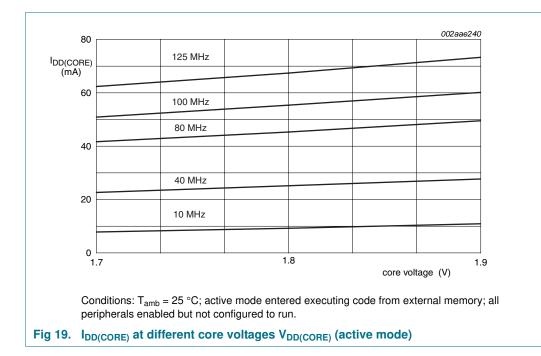
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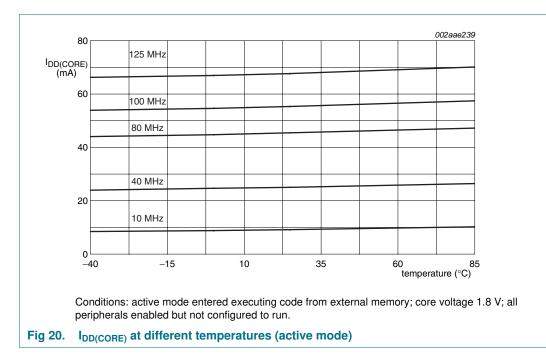
8.1 Power consumption

1.8 V; all peripherals enabled but not configured to run.

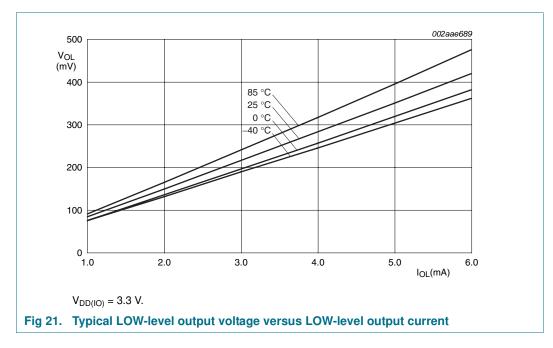




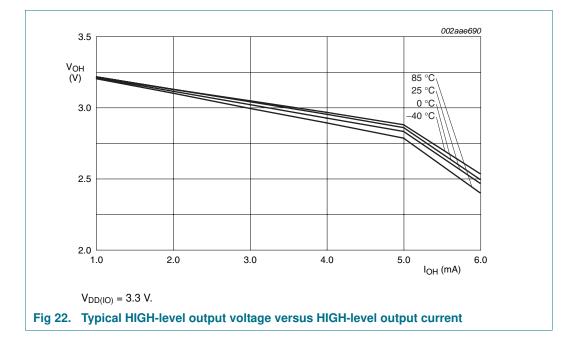
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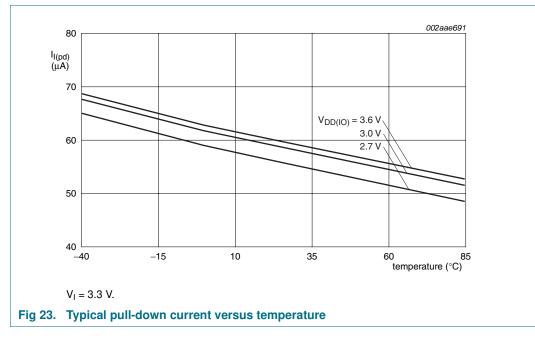


8.2 Electrical pin characteristics

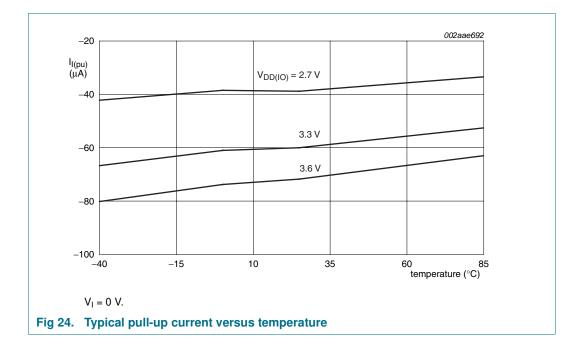


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9. Dynamic characteristics

9.1 Dynamic characteristics: I/O and CLK_OUT pins, internal clock, oscillators, PLL, and CAN

Table 35. Dynamic characteristics

 $V_{DD(CORE)} = V_{DD(OSC_PLL)}$; $V_{DD(IO)} = 2.7$ V to 3.6 V; $V_{DDA(ADC3V3)} = 3.0$ V to 3.6 V; all voltages are measured with respect to ground; positive currents flow into the IC; unless otherwise specified.^[1]

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I/O pins							
t _{THL}	HIGH to LOW transition time	C _L = 30 pF		4	-	13.8	ns
t _{TLH}	LOW to HIGH transition time	C _L = 30 pF		4	-	13.8	ns
CLK_OUT pin							
f _{clk}	clock frequency	on pin CLK_OUT		-	-	40	MHz
Internal clock							
f _{clk(sys)}	system clock frequency		[2]	10	-	125	MHz
T _{clk(sys)}	system clock period		[2]	8	-	100	ns
Low-power ring of	oscillator						
f _{ref(RO)}	RO reference frequency			0.4	0.5	0.6	MHz
t _{startup}	start-up time	at maximum frequency	[3]	-	6	-	μS
Oscillator							
f _{i(osc)}	oscillator input frequency	maximum frequency is the clock input of an external clock source applied to the XIN_OSC pin		10	-	100	MHz
t _{startup}	start-up time	at maximum frequency	<u>[3]</u> [4]	-	500	-	μS
PLL							
f _{i(PLL)}	PLL input frequency			10	-	25	MHz
f _{o(PLL)}	PLL output frequency			10	-	160	MHz
		CCO; direct mode		156	-	320	MHz
t _{a(clk)}	clock access time			-	-	63.4	ns
t _{a(A)}	address access time			-	-	60.3	ns
Jitter specificatio	on for CAN						
t _{jit(cc)(p-p)}	cycle to cycle jitter (peak-to-peak value)	on CAN TXDCn pin	[3]	-	0.4	1	ns

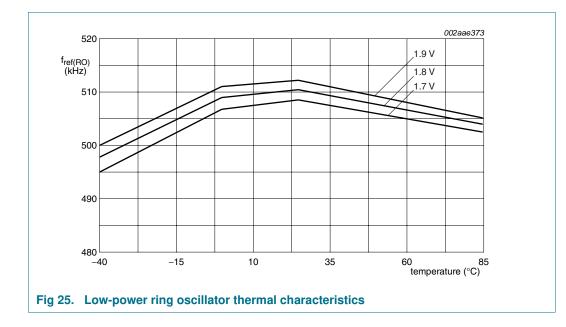
[1] All parameters are guaranteed over the virtual junction temperature range by design. Pre-testing is performed at T_{amb} = 85 °C ambient temperature on wafer level. Cased products are tested at T_{amb} = 25 °C (final testing). Both pre-testing and final testing use correlated test conditions to cover the specified temperature and power supply voltage range.

[2] See <u>Table 26</u>.

[3] This parameter is not part of production testing or final testing, hence only a typical value is stated.

[4] Oscillator start-up time depends on the quality of the crystal. For most crystals it takes about 1000 clock pulses until the clock is fully stable.

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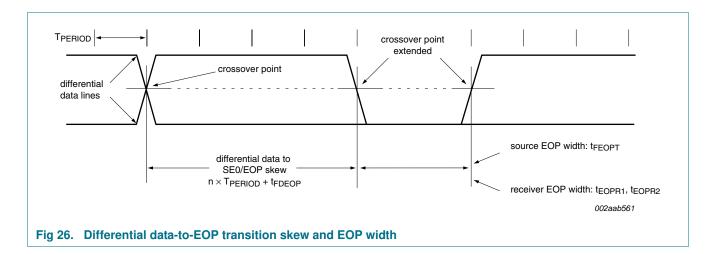
9.2 USB interface

Table 36. Dynamic characteristics: USB pins (full-speed)

 $C_L = 50 \text{ pF}; R_{pu} = 1.5 \text{ k}\Omega \text{ on } D+ \text{ to } V_{DD(3V3)}$, unless otherwise specified.

e_ eep:,pu		inter operation					
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
t _r	rise time	10 % to 90 %		8.5	-	13.8	ns
t _f	fall time	10 % to 90 %		7.7	-	13.7	ns
t _{FRFM}	differential rise and fall time matching	t _r / t _f		-	-	109	%
V _{CRS}	output signal crossover voltage			1.3	-	2.0	V
t _{FEOPT}	source SE0 interval of EOP	see Figure 26		160	-	175	ns
t _{FDEOP}	source jitter for differential transition to SE0 transition	see Figure 26		-2	-	+5	ns
t _{JR1}	receiver jitter to next transition			-18.5	-	+18.5	ns
t _{JR2}	receiver jitter for paired transitions	10 % to 90 %		-9	-	+9	ns
t _{EOPR1}	EOP width at receiver	must reject as EOP; see <u>Figure 26</u>	[1]	40	-	-	ns
t _{EOPR2}	EOP width at receiver	must accept as EOP; see Figure 26	[1]	82	-	-	ns

[1] Characterized but not implemented as production test. Guaranteed by design.



9.3 Dynamic characteristics: I²C-bus interface

Table 37. Dynamic characteristic: I²C-bus pins

 $V_{DD(CORE)} = V_{DD(OSC_PLL)}$; $V_{DD(IO)} = 2.7 \text{ V to } 3.6 \text{ V}$; $V_{DDA(ADC3V3)} = 3.0 \text{ V to } 3.6 \text{ V}$; all voltages are measured with respect to ground; positive currents flow into the IC; unless otherwise specified^[1]

Symbol	Parameter	Conditions	Min	Typ <mark>[2]</mark>	Max	Unit
t _{f(0)}	output fall time	V_{IH} to V_{IL}	$20 + 0.1 \times C_b$	-	-	ns

[1] All parameters are guaranteed over the virtual junction temperature range by design. Pre-testing is performed at T_{amb} = 85 °C ambient temperature on wafer level. Cased products are tested at T_{amb} = 25 °C (final testing). Both pre-testing and final testing use correlated test conditions to cover the specified temperature and power supply voltage range.

[2] Typical ratings are not guaranteed. The values listed are at room temperature (25 °C), nominal supply voltages.

[3] Bus capacitance C_b in pF, from 10 pF to 400 pF.

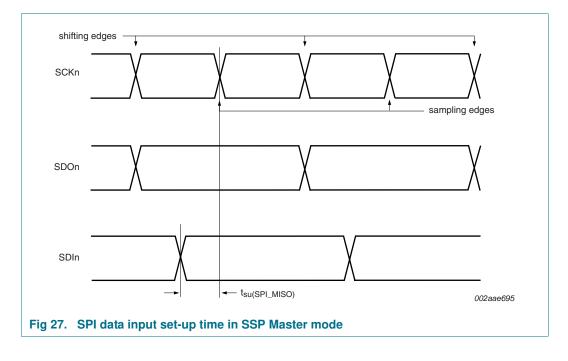
9.4 Dynamic characteristics: SPI

Table 38. Dynamic characteristics of SPI pins

 $V_{DD(CORE)} = V_{DD(OSC_PLL)}$; $V_{DD(IO)} = 2.7$ V to 3.6 V; $V_{DDA(ADC3V3)} = 3.0$ V to 3.6 V; $V_{DDA(ADC5V0)} = 3.0$ V to 5.5 V; $T_{vj} = -40$ °C to +85 °C; all voltages are measured with respect to ground; positive currents flow into the IC; unless otherwise specified.^[1]

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
f _{SPI}	SPI operating frequency	master operation	¹ /65024f _{clk(SPI)}	-	$1/2 f_{clk(SPI)}$	MHz
		slave operation	¹ /65024fclk(SPI)	-	$^{1/_{4}}f_{clk(SPI)}$	MHz
$t_{\text{SU}(\text{SPI}_{\text{MISO}})}$	SPI_MISO set-up time	T _{amb} = 25 °C; measured in SPI Master mode; see <u>Figure 27</u>	-	11	-	ns

[1] All parameters are guaranteed over the virtual junction temperature range by design. Pre-testing is performed at T_{amb} = 85 °C ambient temperature on wafer level. Cased products are tested at T_{amb} = 25 °C (final testing). Both pre-testing and final testing use correlated test conditions to cover the specified temperature and power supply voltage range.



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9.5 Dynamic characteristics: external static memory

Table 39. External static memory interface dynamic characteristics

 $V_{DD(CORE)} = V_{DD(OSC_PLL)}$; $V_{DD(IO)} = 2.7 V$ to 3.6 V; $V_{DDA(ADC3V3)} = 3.0 V$ to 3.6 V; all voltages are measured with respect to ground.^[1]

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
T _{CLCL}	clock cycle time		8	-	100	ns
t _{a(R)int}	internal read access time		-	-	20.5	ns
t _{a(W)int}	internal write access time		-	-	24.9	ns
Read cyc	le parameters					
t _{CSLAV}	CS LOW to address valid time		-5	-2.5	-	ns
t _{OELAV}	OE LOW to address valid time		$-5 - WSTOEN \times T_{CLCL}$	$-2.5-WSTOEN\times T_{CLCL}$	-	ns
t _{CSLOEL}	$\overline{\text{CS}}$ LOW to $\overline{\text{OE}}$ LOW time		-	$0 + WSTOEN \times T_{CLCL}$	-	ns
$t_{su(DQ)}$	data input /output set-up time		11	16	22	ns
t _{h(D)}	data input hold time		0	2.5	5	ns
t _{CSHOEH}	CS HIGH to OE HIGH time		-	0	-	ns
t _{BLSLBLSH}	BLS LOW to BLS HIGH time		-	$\begin{array}{l} (\text{WST1} - \text{WST0EN +1}) \times \\ \text{T}_{\text{CLCL}} \end{array}$	-	ns
t _{OELOEH}	OE LOW to OE HIGH time		-	$\begin{array}{l} (\text{WST1} - \text{WST0EN +1}) \times \\ \text{T}_{\text{CLCL}} \end{array}$	-	ns
t _{BLSLAV}	BLS LOW to address valid time		-	$0 + WSTOEN \times T_{CLCL}$	-	ns
Write cyc	le parameters					
t _{CSHBLSH}	CS HIGH to BLS HIGH time	[2	l -	0	-	ns
t _{CSLWEL}	CS LOW to WE LOW time		-	(WSTWEN + 0.5) \times T _{CLCL}	-	ns
t _{CSLBLSL}	CS LOW to BLS LOW time	[3	l -	$\textbf{WSTWEN} \times \textbf{T}_{\textbf{CLCL}}$	-	ns
t _{WELDV}	WE LOW to data valid time		-	(WSTWEN + 0.5) \times T _{CLCL}	-	ns
t _{CSLDV}	CS LOW to data valid time		-0.5	-0.1	0.3	ns
t _{WELWEH}	WE LOW to WE HIGH time		-	(WST2 – WSTWEN +1) \times T _{CLCL}	-	ns
t _{BLSLBLSH}	BLS LOW to BLS HIGH time	<u>[4</u>	1 -	$\begin{array}{l} (WST2-WSTWEN \ \texttt{+2})\times\\ T_{CLCL} \end{array}$	-	ns

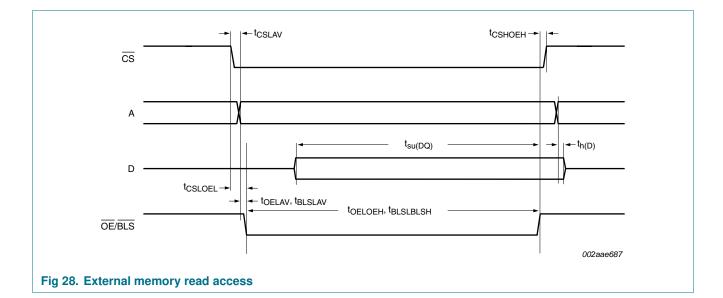
[1] All parameters are guaranteed over the virtual junction temperature range by design. Pre-testing is performed at T_{amb} = 85 °C ambient temperature on wafer level. Cased products are tested at T_{amb} = 25 °C (final testing). Both pre-testing and final testing use correlated test conditions to cover the specified temperature and power supply voltage range.

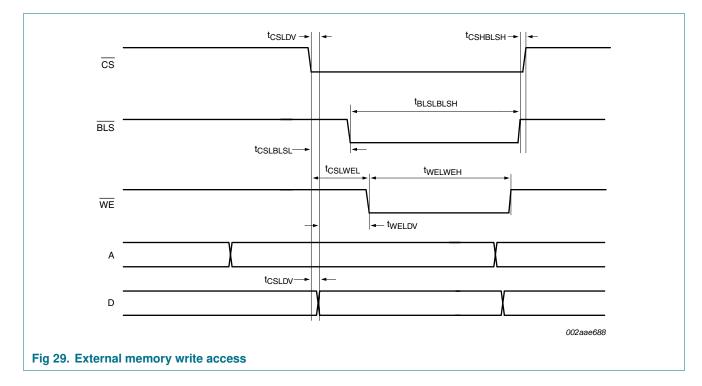
[2] When the byte lane select signals are used to connect the write enable input (8 bit devices), $t_{CSHBLSH} = -0.5 \times T_{CLCL}$.

[3] When the byte lane select signals are used to connect the write enable input (8 bit devices), $t_{CSLBLSL} = t_{CSLWEL}$.

[4] For 16 and 32 bit devices.

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9.6 Dynamic characteristics: ADC

Table 40. ADC dynamic characteristics

 $V_{DD(CORE)} = V_{DD(OSC_PLL)}$; $V_{DD(IO)} = 2.7 \text{ V to } 3.6 \text{ V}$; $V_{DDA(ADC3V3)} = 3.0 \text{ V to } 3.6 \text{ V}$; all voltages are measured with respect to ground.^[1]

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
5.0 V ADC0						
f _{i(ADC)}	ADC input frequency		2 4	-	4.5	MHz
f _{s(max)}	maximum sampling rate	$\begin{array}{l} f_{i(ADC)} = 4.5 \; MHz; \\ f_s = f_{i(ADC)} / (n+1) \; \text{with} \\ n = resolution \end{array}$				
		resolution 2 bit	-	-	1500	ksample/s
		resolution 10 bit	-	-	400	ksample/s
t _{conv}	conversion time	In number of ADC clock cycles	3	-	11	cycles
		In number of bits	2	-	10	bits
3.3 V ADC1	/2					
f _{i(ADC)}	ADC input frequency		[2] 4	-	4.5	MHz
f _{s(max)}	maximum sampling rate	$\begin{array}{l} f_{i(ADC)} = 4.5 \mbox{ MHz}; \\ f_s = f_{i(ADC)}/(n+1) \mbox{ with } \\ n = resolution \end{array}$				
		resolution 2 bit	-	-	1 500	ksample/s
		resolution 10 bit	-	-	400	ksample/s
t _{conv}	conversion time	In number of ADC clock cycles	3	-	11	cycles
		In number of bits	2	-	10	bits

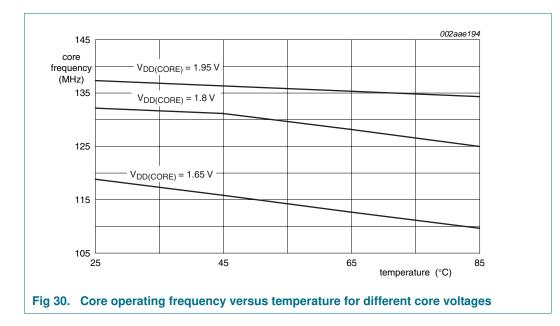
[1] All parameters are guaranteed over the virtual junction temperature range by design. Pre-testing is performed at $T_{amb} = 85$ °C ambient temperature on wafer level. Cased products are tested at $T_{amb} = 25$ °C (final testing). Both pre-testing and final testing use correlated test conditions to cover the specified temperature and power supply voltage range.

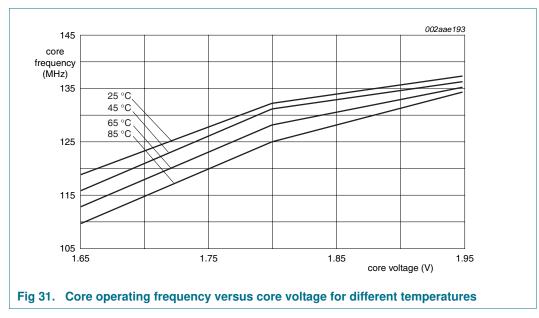
[2] Duty cycle clock should be as close as possible to 50 %.

10. Application information

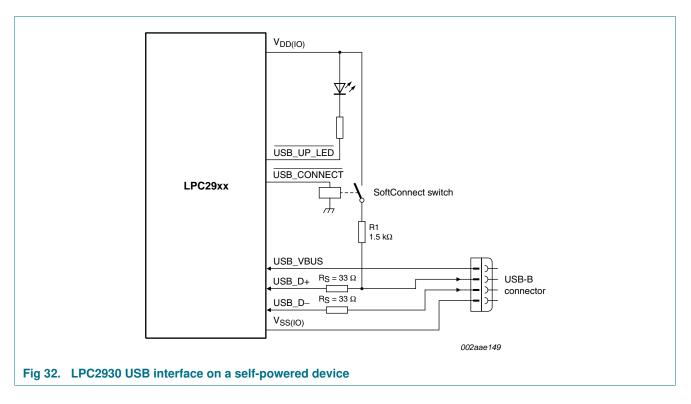
10.1 Operating frequency selection

The LPC2930 is specified to operate at a maximum frequency of 125 MHz, maximum temperature of 85 °C, and maximum core voltage of 1.89 V. Figure 30 and Figure 31 show that the user can achieve higher operating frequencies for the LPC2930 by controlling the temperature and the core voltage accordingly.

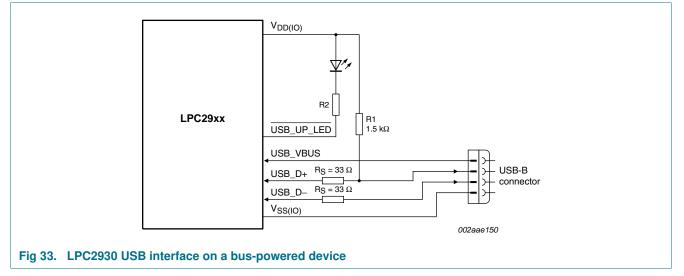




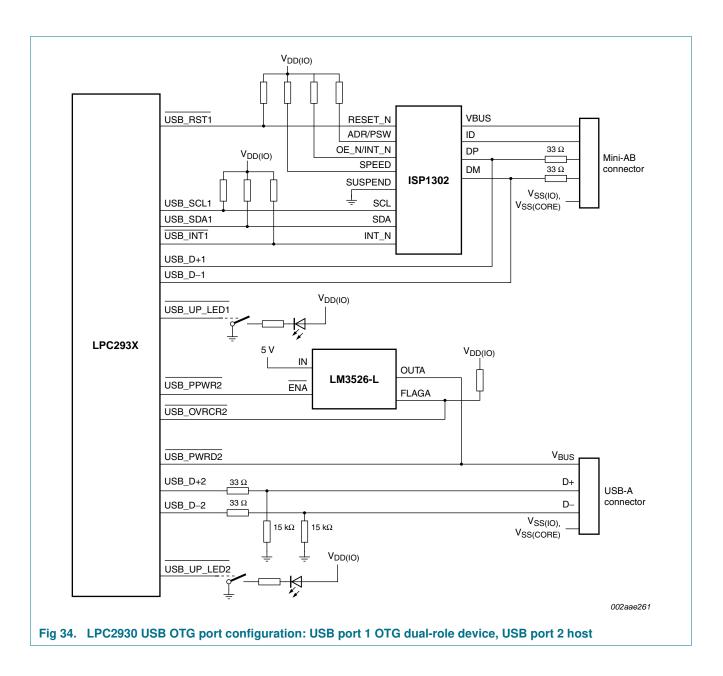




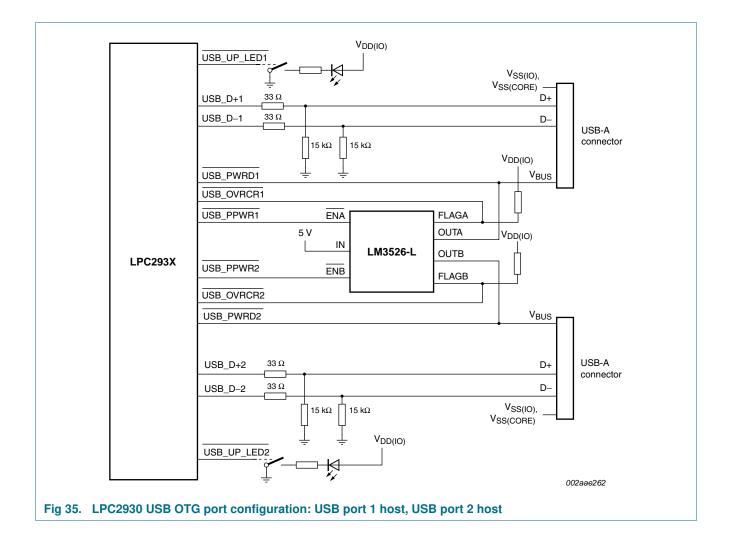
10.2 Suggested USB interface solutions



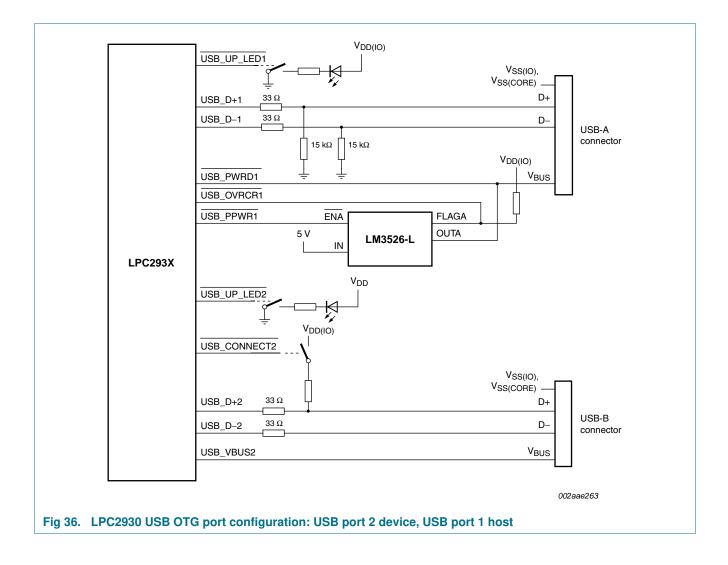
LPC2930



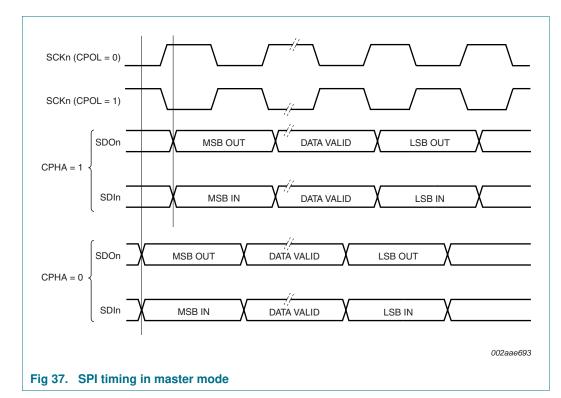
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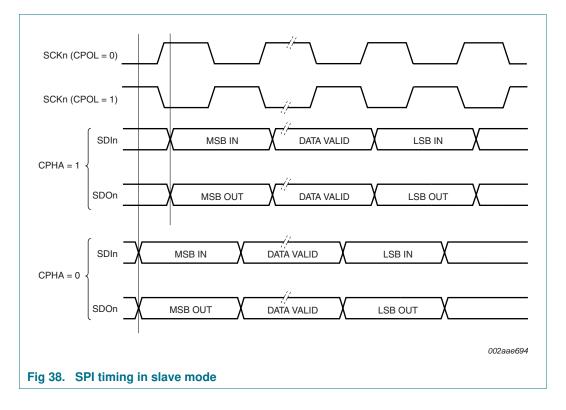
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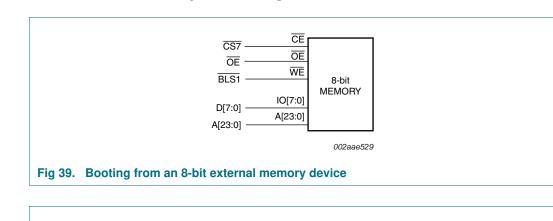
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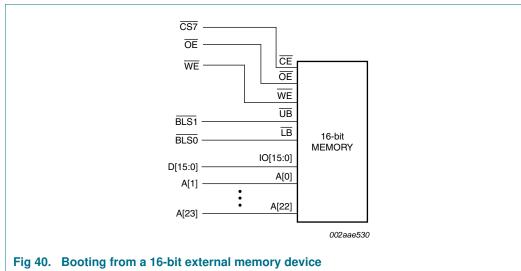
10.3 SPI signal forms

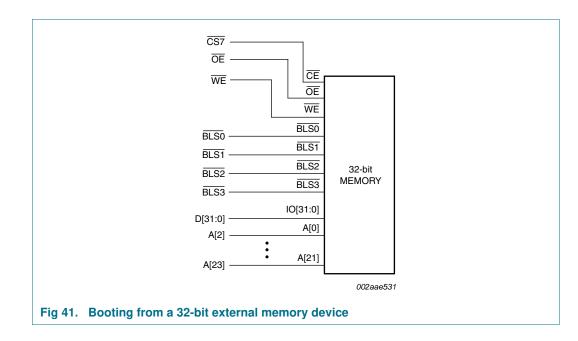


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10.4 External boot memory interfacing





For booting from external memory, connect the pins as shown in <u>Table 41</u> to the external memory device.

Table 41. LPC2930 boot configuration

LPC2930	connections		External n	nemory connect	ions
Pin	Port	Function	8-bit	16-bit	32- bit
137	P4[10]	OE	OE	ŌĒ	OE
177	P4[11]	WE	-	WE	WE
74	P4[17]	CS7	CS	CS	CS
64	P4[12]	BLS0	WE	BLS0	BLS0
127	P4[13]	BLS1	-	BLS1	BLS1
149	P4[14]	BLS2	-	-	BLS2
187	P4[15]	BLS3	-	-	BLS3
122	P1[0]	A0	A0	-	-
119	P1[1]	A1	A1	A0	-
118	P1[2]	A2	A2	A1	A0
117	P1[3]	A3	A3	A2	A1
103	P1[4]	A4	A4	A3	A2
102	P1[5]	A5	A5	A4	A3
100	P1[6]	A6	A6	A5	A4
99	P1[7]	A7	A7	A6	A5
28	P4[0]	A8	A8	A7	A6
68	P4[1]	A9	A9	A8	A7
131	P4[2]	A10	A10	A9	A8
170	P4[3]	A11	A11	A10	A9
60	P4[4]	A12	A12	A11	A10
82	P4[5]	A13	A13	A12	A11
194	P0[18]	A14	A14	A13	A12
195	P0[19]	A15	A15	A14	A13
200	P0[20]	A16	A16	A15	A14
201	P0[21]	A17	A17	A16	A15
202	P0[22]	A18	A18	A17	A16
204	P0[23]	A19	A19	A18	A17
146	P4[6]	A20	A20	A19	A18
183	P4[7]	A21	A21	A20	A19
38	P4[8]	A22	A22	A21	A20
76	P4[9]	A23	A23	A22	A21
79	P1[14]	D0	D0	D0	D0
75	P1[15]	D1	D1	D1	D1
61	P1[16]	D2	D2	D2	D2
58	P1[17]	D3	D3	D3	D3
57	P1[18]	D4	D4	D4	D4
56	P1[19]	D5	D5	D5	D5
55	P1[20]	D6	D6	D6	D6
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Product data sheet

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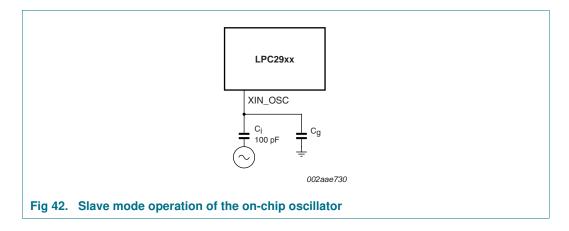
LPC2930	connections		External r	memory connect	ions
Pin	Port	Function	8-bit	16-bit	32- bit
54	P1[21]	D7	D7	D7	D7
30	P5[0]	D8	D8	D8	D8
72	P5[1]	D9	-	D9	D9
133	P5[2]	D10	-	D10	D10
172	P5[3]	D11	-	D11	D11
94	P2[4]	D12	-	D12	D12
95	P2[5]	D13	-	D13	D13
101	P2[6]	D14[1]	-	D14	D14
111	P2[7]	D15 <mark>11</mark>	-	D15	D15
62	P5[4]	D16	-	-	D16
84	P5[5]	D17	-	-	D17
148	P5[6	D18	-	-	D18
185	P5[7]	D19	-	-	D19
41	P5[8]	D20	-	-	D20
78	P5[9]	D21	-	-	D21
139	P5[10]	D22	-	-	D22
179	P5[11]	D23	-	-	D23
66	P5[12]	D24	-	-	D24
129	P5[13]	D25	-	-	D25
130	P0[2]	D26	-	-	D26
134	P0[3]	D27	-	-	D27
147	P0[4]	D28	-	-	D28
150	P0[5]	D29	-	-	D29
153	P0[6]	D30	-	-	D30
154	P0[7]	D31	-	-	D31
-			-		

Table 41. LPC2930 boot configuration

[1] Boot control pins. See <u>Table 11</u> for configuration of the boot control pins.

10.5 XIN_OSC input

The input voltage to the on-chip oscillators is limited to 1.8 V. If the oscillator is driven by a clock in slave mode, it is recommended that the input be coupled through a capacitor with $C_i = 100 \text{ pF}$. To limit the input voltage to the specified range, choose an additional capacitor to ground C_g which attenuates the input voltage by a factor $C_i/(C_i + C_g)$. In slave mode, a minimum of 200 mV_{rms} is needed. For more details see the *LPC29xx User manual UM10316*.



10.6 XIN_OSC Printed Circuit Board (PCB) layout guidelines

The crystal should be connected on the PCB as close as possible to the oscillator input and output pins of the chip. Take care that the load capacitors C_{x1} and C_{x2} , and C_{x3} in case of third overtone crystal usage, have a common ground plane. The external components must also be connected to the ground plain. Loops must be made as small as possible, in order to keep the noise coupled in via the PCB as small as possible. Also parasitics should stay as small as possible. Values of C_{x1} and C_{x2} should be chosen smaller accordingly to the increase in parasitics of the PCB layout.

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11. Package outline

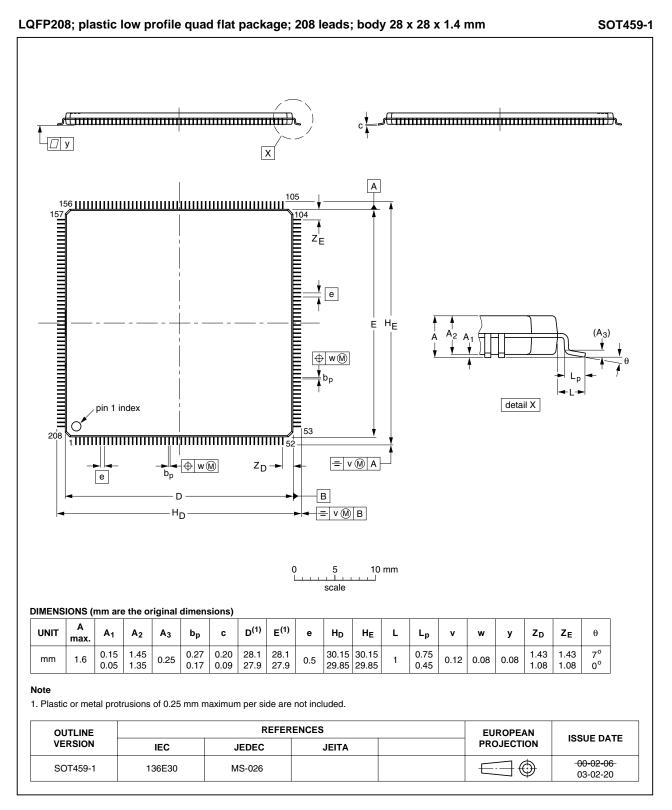


Fig 43. Package outline SOT459-1 (LQFP208)

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12. Soldering of SMD packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365 "Surface mount reflow soldering description"*.

12.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

12.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- · Board specifications, including the board finish, solder masks and vias
- · Package footprints, including solder thieves and orientation
- · The moisture sensitivity level of the packages
- Package placement
- Inspection and repair
- Lead-free soldering versus SnPb soldering

12.3 Wave soldering

Key characteristics in wave soldering are:

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- · Solder bath specifications, including temperature and impurities

12.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see <u>Figure 44</u>) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with Table 42 and 43

Table 42. SnPb eutectic process (from J-STD-020C)

	Package reflow temperature (°C)		
	Volume (mm ³)		
	< 350	≥ 350	
< 2.5	235	220	
≥ 2.5	220	220	

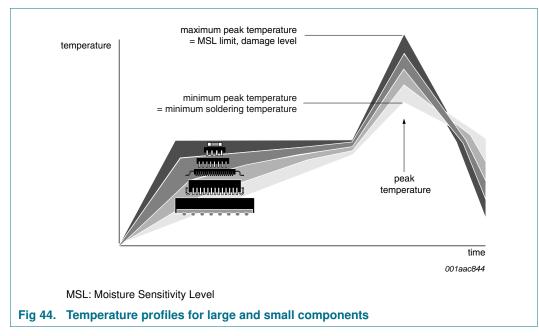
Table 43. Lead-free process (from J-STD-020C)

Package thickness (mm)	n) Package reflow temperature (°C) Volume (mm ³)		
	< 350	350 to 2000	> 2000
< 1.6	260	260	260
1.6 to 2.5	260	250	245
> 2.5	250	245	245

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see Figure 44.

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For further information on temperature profiles, refer to Application Note *AN10365 "Surface mount reflow soldering description"*.

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13. Abbreviations

	reviations list
Abbreviation	Description
ADC	Analog-to-Digital Converter
AF	Acceptance Filter
AHB	Advanced High-performance Bus
AMBA	Advanced Microcontroller Bus Architecture
APB	ARM Peripheral Bus
CAN	Controller Area Network
CCO	Current Controlled Oscillator
CISC	Complex Instruction Set Computers
DMA	Direct Memory Access
DSP	Digital Signal Processing
DTL	Device Transaction Level
EMI	ElectroMagnetic Interference
EOP	End Of Packet
ETB	Embedded Trace Buffer
ETM	Embedded Trace Macrocell
FDIV	Fractional Divider
FIQ	Fast Interrupt reQuest
GPDMA	General Purpose DMA
GPIO	General Purpose Input/Output
LIN	Local Interconnect Network
LSB	Least Significant Bit
LUT	Look-Up Table
MAC	Media Access Control
MSB	Most Significant Bit
MSCSS	Modulation and Sampling Control SubSystem
MSC	Modulation and Sampling Control
MTMR	MSCSS Timer
OHCI	Open Host Controller Interface
OTG	On-The-Go
PCR	Power Control and Reset system
POR	Power-On Reset
PWM	Pulse Width Modulator
PHY	PHYsical layer
PLL	Phase-Locked Loop
QEI	Quadrature Encoder Interface
Q-SPI	Queued-SPI
RISC	Reduced Instruction Set Computer
SCU	System Control Unit
SFSP	SCU Function Select Port

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AbbreviationDescriptionSPISerial Peripheral InterfaceSSPSynchronous Serial PortTAPTest Access PortTCMTightly Coupled MemoriesTTLTransistor-Transistor LogicUARTUniversal Asynchronous Receiver TransmitterUSBUniversal Serial Bus	Table 44. Abbr	reviations list continued
SSPSynchronous Serial PortTAPTest Access PortTCMTightly Coupled MemoriesTTLTransistor-Transistor LogicUARTUniversal Asynchronous Receiver Transmitter	Abbreviation	Description
TAPTest Access PortTCMTightly Coupled MemoriesTTLTransistor-Transistor LogicUARTUniversal Asynchronous Receiver Transmitter	SPI	Serial Peripheral Interface
TCMTightly Coupled MemoriesTTLTransistor-Transistor LogicUARTUniversal Asynchronous Receiver Transmitter	SSP	Synchronous Serial Port
TTLTransistor-Transistor LogicUARTUniversal Asynchronous Receiver Transmitter	TAP	Test Access Port
UART Universal Asynchronous Receiver Transmitter	ТСМ	Tightly Coupled Memories
	TTL	Transistor-Transistor Logic
USB Universal Serial Bus	UART	Universal Asynchronous Receiver Transmitter
	USB	Universal Serial Bus

14. References

- [1] UM10316 LPC29xx user manual
- [2] ARM ARM web site
- [3] ARM-SSP ARM primecell synchronous serial port (PL022) technical reference manual
- [4] CAN ISO 11898-1: 2002 road vehicles Controller Area Network (CAN) part 1: data link layer and physical signalling
- [5] LIN LIN specification package, revision 2.0

15. Revision history

Table 45.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
LPC2930_3	20100416	Product data sheet		LPC2930_2		
Modification:	Pin descrip	tion for pins 187 (GPIO 4, pin	n 15) and 188 (GPIO 5	, pin 15) corrected.		
	Table 41 "LPC2930 boot configuration" added.					
	 USB logo a 	dded.				
	 Document 1 	emplate updated.				
LPC2930_2	20100108	Product data sheet	-	LPC2930_1		
Modifications	 Product sta 	tus changed from Preliminary	y to Product			
	Table 3: col	rrection made (Pin 29)				
LPC2930_1	20090615	Preliminary data sheet	-	-		

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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